26-3806/3807

Radio Shaek

Service Manual

TRS-80® DISK/VIDEO INTERFACE

(AND EXPANSION FLOPPY DISK DRIVE UNIT)

Catalog Numbers: 26-3806/3807



CUSTOM MANUFACTURED FOR RADIO SHACK, A DIVISION OF TANDY CORPORATION

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1/Introduction

This manual is prepared for the TRS-80 Disk/Video Interface technicians working in the field or repair centers. The user of this manual should be acquainted with Z-80 CPU, 8255 PPI (Programmable Peripheral Interface), HD6845S CRTC (CRT Controller) and M5W1793-02P FDC (Floppy Disk Controller).

This manual consists of seven sections and three appendices:

- The Introduction gives general information on the TRS-80 Disk/Video Interface such as specifications, switch functions, etc.
- Section 1 describes disassembly procedures.
- Section 2 describes preventive maintenance and adjustment.
- Section 3 describes general theory of the TRS-80 Disk/Video Interface operation.
- Section 4 describes how to troubleshoot the TRS-80 Disk/Video Interface.
- Section 5 provides a parts list and an exploded view of the TRS-80 Disk/Video Interface.
- Section 6 provides schematics, P.C. board diagrams and silk screen view of the P.C. boards of the TRS-80 Disk/Video Interface.
- Appendix A provides instructions for installing an additional disk drive unit.
- Appendix B provides technical information for connector signals.
- · Appendix C provides service information on the built-in FDD unit.

General

By utilizing the TRS-80 Disk/Video Interface with the TRS-80 Portable Computer, the user can fully realize the capabilities of the TRS-80 Portable Computer.

The TRS-80 Disk/Video Interface consists of:

- Interface circuit: Transfers data and commands to the TRS-80 Portable Computer.
- Floppy disk drive unit: Drives 5-1/4 inch single-sided, double density floppy disk.
- Floppy disk controller (FDC): Controls driving of the floppy disk drive unit.
- Central processing unit (CPU) and memory: Controls interface circuit, floppy disk controller and CRT controller.

To connect the TRS-80 Disk/Video Interface to the Portable Computer, use the connector cable supplied as an accessory. Install the adapter socket provided with the Disk/Video Interface on the System Bus Connector located on the bottom side of the TRS-80 Portable Computer. Connect one side of the cable to the adapter socket and the other side to the same connector located on the bottom side of the Disk/Video Interface.

System Overview

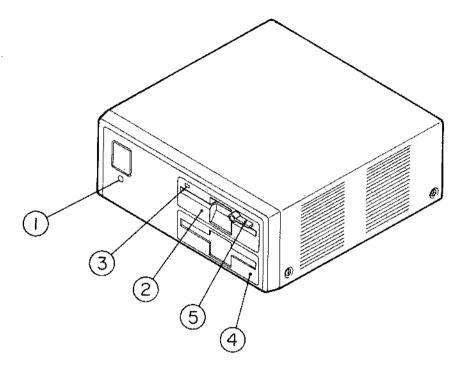


Figure 1-1. Disk/Video Interface (Front view)

- 1 LED Power Indicator: Lights up when the Power Switch is on,
- (2) Drive 0: This is the disk drive unit used for the BASIC SYSTEM diskette.
- (3) Drive Select LED: LED lights during access of the diskette.
- (4) Optional Disk Cover: Remove this cover to install the expansion drive unit. See Appendix A.
- (5) Clamp Lever: Turning this lever downward locks the disk drive unit into the operating position.

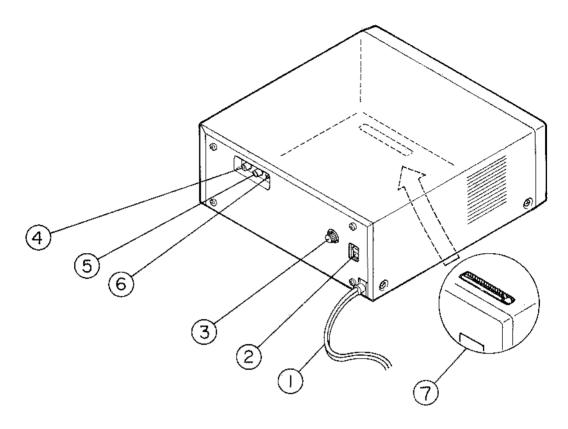


Figure 1-2. Disk/Video Interface (Rear view)

- (1) AC Power Cord: Supplies AC power source to the Disk/Video Interface.
- (2) Power Switch: Turn this switch on to supply AC power to the Disk/Video Interface.
- (3) Fuse Holder: Contains a fuse. Remove the AC cord from the AC receptacle while inspecting/replacing the fuse.
- (4) Video Monitor Terminal: Connect your video monitor for a 80 x 25 or 40 x 25 line display.
- (5) Home TV Terminal: Provides RF output modulated to Channel 3 or Channel 4* of the TV frequency. Connect your home TV set to this terminal using the TV cable and switch box supplied.
- (6) Channel 3/Channel 4 Exchange Switch**: Select either Channel 3 or Channel 4 RF output (Channel 1 or Channel 2 for Australia), whichever is not used in your area.
- (7) System Bus Connector: Connect the system bus connector of the Portable Computer using the attached cable.
 - * Channel 1 or Channel 2 for Australia version.
 Channel 36 UHF signal for UK/Belgium version.
 - ** Deleted for UK/Belgium version.

Specifications

Operating Voltage:

Power Consumption:

Operating Temperature Range:

Operating Humidity Range:

Dimensions (W \times H \times D):

Weight:

Disk Drive:

Spindle Rotation Speed

Seek Time

Average Access Time Motor Starting Time

Data Density Track Density Number of Tracks Number of Sectors

Bytes/Sector

CRT Interface:

Display Mode Display attribution

RF Output Channel

Modulation Ratio Output Impedance

RF Output Level Horizontal Scanning Frequency

Vertical Scanning Frequency

120 Volts AC for USA and Canada

220 Volts AC for Belgium

240 Volts AC for UK and Australia

66 Watts

5°C ~ 40°C

20 to 80%

430 x 125 x 300 mm (16-15/16" x 4-15/16" x 11-10/12")

8 kg (17.7 lbs)

Single-sided, double density

300 R.P.M. 6 msec. 88 msec, 500 msec. 5536 B.P.I. 48 T.P.I.

40 18

256 Bytes

40 columns x 25 lines or 80 column x 25 lines Normal, Blink, Reverse or Reverse and Blink

VHF 3 or 4 channel for USA/Canada VHF 1 or 2 channel for Australia UHF 36 channel for UK/Belgium

75% Typ. 75 ohms

62.5 dBµ (67.3 dBf) Typ.

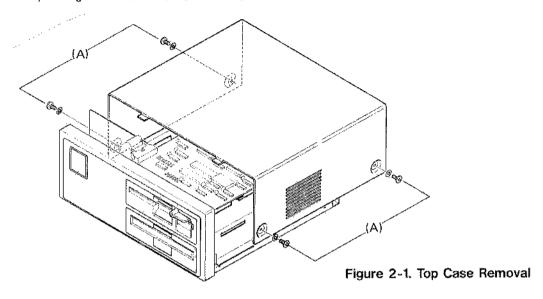
15.625 kHz 60.1 Hz

1-4

2/Disassembly Instructions

Top Case

- Disconnect the cables from the unit.
- 2. Remove the four screws (A) on the left and right of the unit.
- 3. Remove the top case by sliding it toward the rear of the unit.

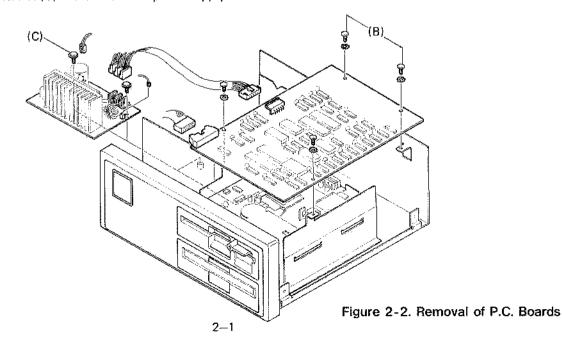


Main P.C. Board

- Disconnect the two connectors marked CN1 and CN4 on the main P.C. Board.
- Remove the four screws (B).
- 3. Take out the main P.C. Board. Be careful not to damage the connectors and switch inside on the rear panel.
- 4. Disconnect the connector marked CN2 and ground lead.

Power Supply P.C. Board

- 1. Disconnect all the connectors from the power supply P.C. Board,
- 2. Remove the two screws (C) and take out the power supply P.C. Board.



Disk Drive Unit

- 1. Disconnect the two connectors marked CN-2 and CN-4 on the floppy disk control P.C. Board.
- 2. Remove the four screws (D) tightening the floppy disk supporting bracket.
- 3. Remove the floppy disk drive unit together with the floppy disk supporting bracket by sliding them toward the rear of the unit.
- 4. Remove the screws (E), two each on the left and right supporting brackets securing the floppy disk drive unit.

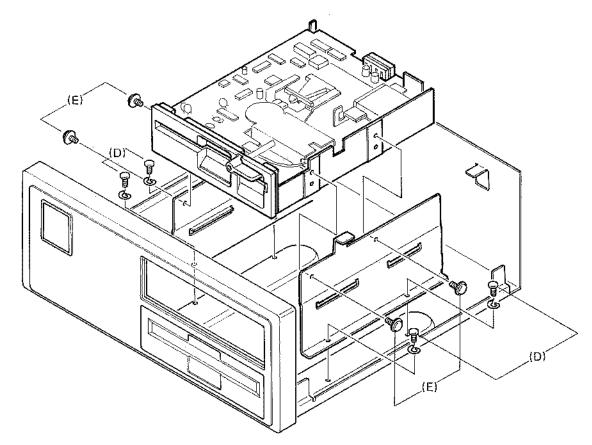


Figure 2-3. Disk Drive Removal

Front Panel Assembly

- 1. Remove the two screws securing the front panel assembly to the chassis.
- 2. Take out the front panel assembly by moving it toward the front of the unit. Be careful not to damage the three snaps securing the front panel assembly to the chassis.

3/Preventive Maintenance

To ensure the proper operation of the Disk/Video Interface, the only scheduled preventive maintenance required is periodic cleaning of the magnetic recording head.

Radio Shack's Universal Disk Drive head cleaning kit for 5-1/4-inch disks works well for this purpose. The kit includes two special cleaning disks and one bottle of cleaning solution.

Cleaning the Head

To clean the magnetic head, use a lint-free cloth or cotton swab moistened with 91% Isopropyl alcohol. Wipe the head carefully to remove all accumulated oxide and dirt.

CAUTION: Rough or abrasive cloth should not be used to clean the magnetic recording head. Use of cleaning solvents other than 91% isopropyl alcohol may damage the head.

Extreme care must be exercised to prevent the head from being damaged (do not scratch or strike the head).

Adjustment

This section describes adjustment of the System Clock and Power Supply. When you are going to adjust the floppy disk drive, refer to Appendix C. Before adjustment, turn the power switch of the Disk/Video Interface on and load the DOS from the system diskette.

System Clock Adjustment

- 1. Connect the frequency counter to pin 3 of M11 on the Main PCB.
- 2. Adjust the C44 trimmer capacitor to read 16 MHz +0%, -0.3% (16 MHz to 15.952 MHz) on the frequency counter.

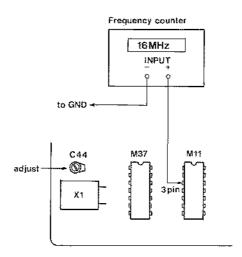


Figure 3-1. System Clock Adjustment

+5V Adjustment

- 1. Connect a DC voltmeter across pin 2 of CN4 (Ground) and pin 3 of CN4 (+5V) on the Main PCB.
- 2. Adjust VR101 on the Power Supply PCB to read +5V +0.1V, -0.1V on the DC voltmeter.

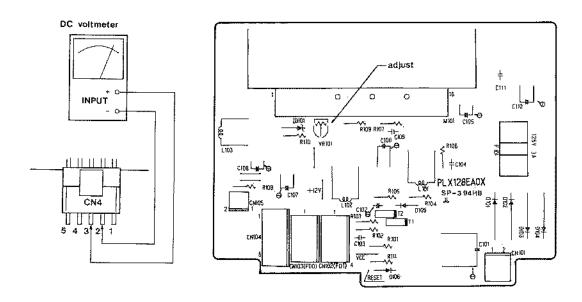


Figure 3-2. +5V Adjustment

4/Theory of Operation

The TRS-80 Disk/Video Interface uses a μ PD780C (compatible with Z-80A) as the CPU.

The CPU controls the transaction of data or commands between the Portable Computer and the Disk/Video Interface by the PPI (8255), control of the CRT by the CRTC (HD46505) and control of the FDD by the FDC (M5W1793-02).

The memory consists of four sections:

- 4K bytes of P-ROM which store a program that reads the control program from track 1 of the system diskette (actual memory size used is 1K bytes).
- 4K bytes of RAM to store the control program read.
- 4K bytes of VRAM (Video RAM) to display characters on the CRT.
- 4K bytes of P-ROM to store the dot pattern of the characters (actual memory size used is 2 K bytes).

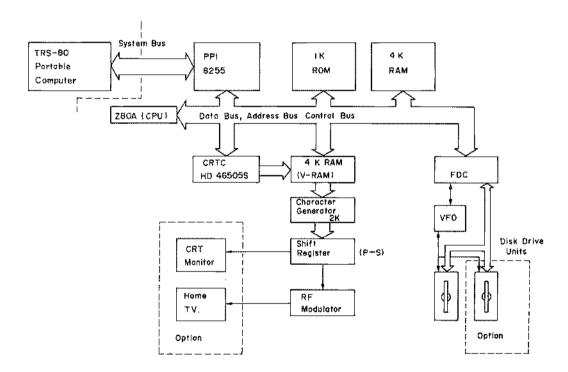


Figure 4-1. Block Diagram

This section provides circuit descriptions of the Disk/Video Interface, dividing it into the following eleven parts:

- e CPU
- · Address Decoding and Bank Selection Circuit
- Memory Map
- I/O Map
- Clock Generator Circuit
- System Bus Interface Circuit
- CRT Interface and Control Circuit
- Flicker Suppressing Circuit
- FDD Interface Signals
- FDD Control Circuit
- Power Supply and Reset Circuit

CPU

The CPU is a μ PD780C compatible with the Z-80A.

System Clock: Uses 4-MHz clock. The clock generator circuit generates a 16-MHz clock and it is divided by four by M27 (SED9421C).

Data BUS and Address BUS: Connected to each memory and also used as the select signal and data BUS for the PPI, CRTC and FDC.

Interrupt: Two terminals, INT (Interrupt Request) and NMI (Non Maskable Interrupt), accept interrupts. By writing data into the PPI via the Portable Computer, INT is generated. The CPU receives the data from PPI by jumping to the Interrupt Handling Routine. NMI is used for accepting the completion of disk commands.

BUSRQ: BUSRQ is input from the Flicker Suppressing circuit. BUSRQ prohibits the CPU from accessing VRAM while the CRT is displaying characters and prevents flicker of the CRT.

RESET: RESET is generated in the power supply circuit and is used as a RESET signal for the CPU, ICs and LSIs.

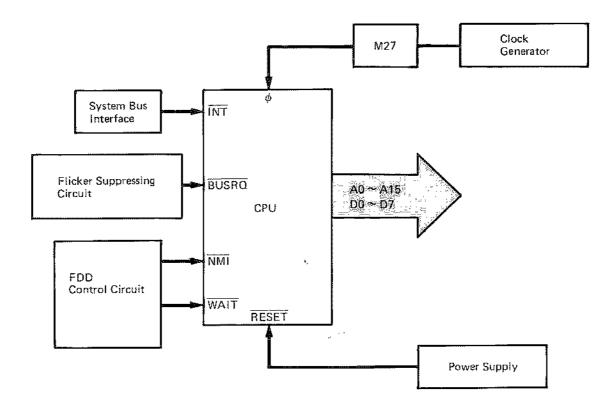


Figure 4-2. CPU Control Diagram

Address Decoding and Bank Selection Circuit

M31 and M38 determine memory address decoding. M31 decodes A15, A14 and A13, and selects ROM (M40), RAM (M28 and M36), ARAM (M23) and CRAM (M9).

The output of 2Q in M16 selects BANK switching. At power-on, M16 receives the RESET signal and BANKO is assigned so that the program starts from address 0000H in the ROM. After that, the CPU assigns STS as the I/O Port and sets bit D1 of the data bus to "H", and the BANK1 is selected.

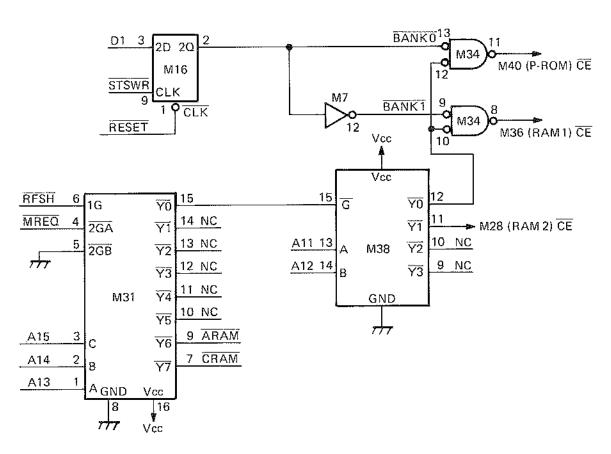


Figure 4-3, Address Decoding and BANK Selection Circuit

Memory Map

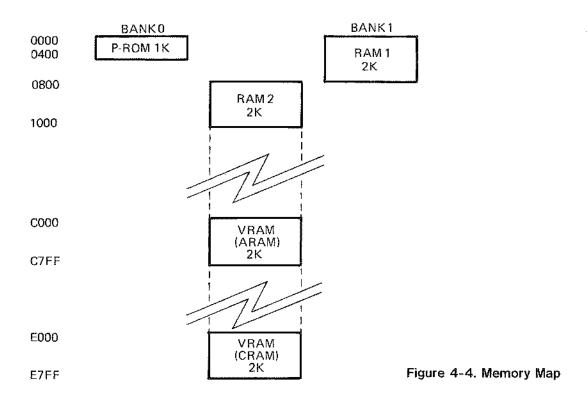
The Disk/Video Interface uses two 4K-byte P-ROMs and four 2K-byte Static RAMs.

At power-on, the P-ROM program is used to load the control program from the system diskette, but as the address codes A10 and A11 are connected to ground through R25 and R28, memory is 1024 bytes.

Another P-ROM is used as a character generator and accessed by the CRTC. Two 2K-byte RAMs, RAM1 and RAM2, are assigned for the control program.

Two other RAMs are CRAM (Character RAM), which stores data to display on the CRT, and ARAM (Attribute RAM), which stores data to reverse and blink characters.

A P-ROM for the program and RAM1 are switched by the BANK selection circuit. At power-on and while track 1 of the system diskette is being read, the combination of RAM2 and BANK0 P-ROM is selected. After the system has been read, the combination is switched to RAM2 and BANK1 RAM1.



I/O Map

Selection of an I/O Port is determined by M38 by decoding the address of A5, A6 and A7. There are four I/O ports:

Address	Signal	Description				
00H 1FH	CRTC	00H: Address Register of CRTC 02H: Command Register of CRTC (for Write) 03H: Status Register of CRTC (for Read)				
20H	STS	20H Bit	Read	Write		
ў н		0 1 2 3 4 5 6 7	PPI PB0 PB1 PB2 PB3 PB4 VSRET IBF MOTOR ON	Select 80 characters mode Select Bank 1 Not Used Not Used Select Drive 0 Select Drive 1 Half CPU if VSRET is High Enable head		
40H 	FDC	50H: Status Register of FDC (for Read) 50H: Command Register of FDC (for Write) 51H: Track Register of FDC 52H: Select Register of FDC 53H: Data Register of FDC				
60H ↓ 7FH	8255	60H: Input from 8255 70H: Output to 8255				

Table 4-1, I/O Port Description

Clock Generator Circuit

The clock generator circuit generates a 16-MHz clock and is used as the fundamental element for the system clock in the CPU, the timing clock for the FDD to read/write data and the timing clock for the CRT.

The 16-MHz clock, generated by M37 (NAND gate) and the 16-MHz crystal oscillator, is transferred to the FDD interface circuit and also transferred to M27 (SED9421C). This 16-MHz clock is divided by four by M27 and, passing through M14, it is transferred to the CPU as a 4-MHz clock. The CPU uses this clock as the system clock.

Also in M27, the 16-MHz clock is used as the timing clock to read/write data between the FDD. This 16-MHz clock is divided by two by M47 and the divided 8-MHz clock is supplied to the pre-compensation circuit in the FDD interface. The timing clock of the CRT is also generated by this circuit.

The fundamental factor of character display is DCLK. DCLK is a timing signal which shows 1 dot on the CRT. Every eight DCLK outputs one LOAD signal. LOAD is a timing signal which displays one character on the CRT.

There are two modes of character display; one is 40 characters per one line and the other is 80 characters per one line.

For the 80 characters mode, 10 in M16 is set by the CPU and 80C becomes "L". Then M11 becomes preset so that the 16-MHz clock passes through M34 and M37, and is input into the CLK terminal of M33 directly.

For the 40 characters mode, at the gate of M34, 80C becomes "H" so that the 16-MHz clock is inhibited and divided by two in M11, and input into the CLK terminal of M33.

Because of this logic, display time of one character in 80 characters mode becomes half of that in 40 characters mode.

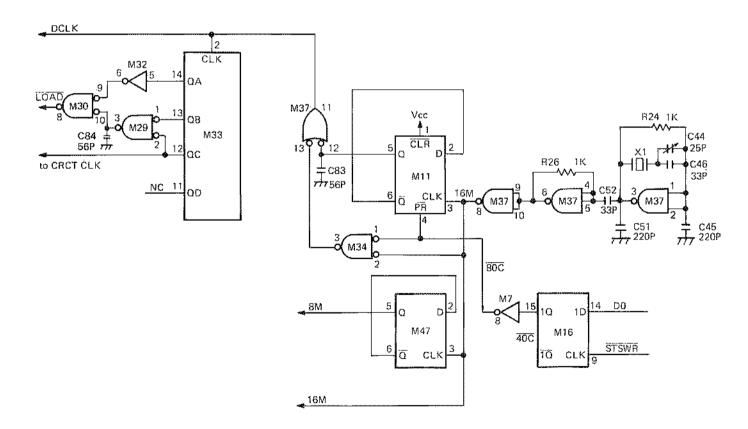


Figure 4-5. Clock Generator Circuit

System Bus Interface Circuit

Transaction of data or commands between the Portable Computer and the Disk/Video Interface is executed by M45, M41 and M44 under the control of the CPU,

The signals from the Portable Computer are as follows:

Signal name Input or Output		Description
<u> 70</u>	Input	Chip select signal for PPI
A0	Input	Port select signal for PPI
Α1	Input	Port select signal for PPI
RD Input		Allows the Portable Computer to read data from the PPI
WR Input		Allows the Portable Computer to write data and commands in the PPI ds in the PPI
D0 — D7 Input/Output		Data lines

Table 4-2. Signals from the Portable Computer

As soon as the DC voltage of the Disk/Video Interface reaches a proper level, RES signal becomes "L" and PC0, PC1 and PC2 terminals in the PPI also become low level. By checking the level of these 3 bits (whether they are "L" or not), the Portable Computer decides if the Disk/Video Interface is in an operable or inoperable mode.

1. Transmission of signals from the TRS-80 Portable Computer to the Disk/Video Interface

If you are going to transmit data from TRS-80 Portable Computer to the Disk/Video Interface, the Portable Computer checks \overline{OBF} (Output Buffer Full) first. If this signal is "L", the Portable Computer waits until it becomes "H". As soon as the output buffer becomes empty (\overline{OBF} = "H"), the Portable Computer writes data mode on the least significant 4 bits of Port B in the PPI.

This data mode is the data which define the going data whether they are commands or data, and to be transferred to the CRT or FDD and then, the data are written on the Port A in the PPI. Then, OBF becomes "L".

The OBF signal generates interruption in the CPU of the Disk/Video Interface. Through this interruption, the CPU acknowledges that the data is ready to be transmitted in the PPI, and then receives the data through PAO — PA7 terminals in the PPI by switching the ACK (Acknowledge input) signal to "L".

Receiving the ACK signal from the CPU, the PPI switches \overline{OBF} to "H", and reading \overline{OBF} from Port C, the Portable Computer transfers the next data to Port A in the PPI.

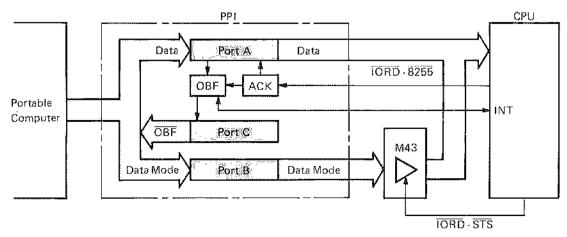


Figure 4-6. System BUS Interface Block Diagram (Receive Mode)

2. Transaction from the Disk/Video Interface to the Portable Computer

When the data is going to be transferred to the Portable Computer, the CPU waits until the IBF (Input buffer full) becomes empty (IBF = "L"). As soon as the IBF becomes "L", the CPU transfers the data to the Portable Computer to Port A and switches STB to "L".

Then, the IBF is switched to "H" and the data is latched in Port A in the PPI. The Portable Computer confirms IBF being "H" through Port C and accepts the data stored in Port A.

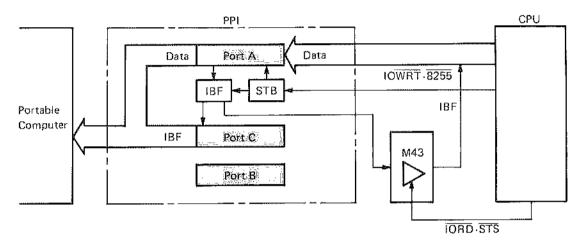


Figure 4-7. System BUS Interface Block Diagram (Transmit Mode)

3. Data Modes

There are four types of data transaction modes to transfer data between the Portable Computer and the Disk/Video Interface. The mode of data transaction is settled by the least significant four bits which the Portable Computer delivers to Port B in the PPI.

PB3	PB2	PB1	PB0	Data Mode	Remarks
0	0	0	0	CRT data	Data to be displayed on the CRT.
0	0	0	1	CRT screen copy	Transfers the contents of the VRAM to the Portable Computer.
0	0	1	0	Disk data	Read/write data to the disk.
0	0	1	1	Disk command	Commands or parameters to the disk.
1	1	0	0	I/O break	Stop of data transaction.

Table 4-3. PPI Function Table

CRT Interface and Control Circuit

The data to be displayed on the CRT is stored in the CRAM and the attribute data to show character reverse and blinking is stored in the ARAM. M20, M24 and M25 are the selectors of the address lines. When the CPU assigns VRAM, VRAM becomes "L" and, except for this case, CRTC assigns VRAM.

M9 is the ARAM data line selector and M22 is the CRAM data line selector. They connect the data BUS to the CPU only when ARAM or CRAM are assigned by the memory address of the CPU. Since ARAM uses only 2 bits of memory, D2-D7 terminals of M23 are pulled up on VCC.

When the VRAM is accessed by the CRTC, the data stored in the CRAM is latched on the rising edge of the LOAD signal in M18 and assigns A3-A10, which are address lines of P-ROM for the character generator.

On the other hand, to A0-A2 terminals of the P-ROM, RA0-RA2 signals are assigned from the CRTC. Through these address lines of the P-ROM, the character data varies with the raster address and is output from D0-D7 terminals of the P-ROM. M15 converts this parallel data to the serial data by one dot. M4 delays ARAM data by two pulses of the LOAD signal. When the character display is in reverse mode, M5 EX-ORs the ARAM data with the serial data and, in blinking mode, M2 ANDs the serial data with 1 Hz of signal which is generated by dividing VSYNC signal (about 60 Hz) from the CRTC by 64 in M8.

M2 ANDs the serial data with the DISPTMG signal from the CRTC and the ANDed signal is input onto the base of T1. At the same time, onto the base of T1, synchronous idle which M5 composes VSYNC (vertical sync) signal and HSYNC (horizontal sync) signal generated in CRTC is also input then, T1 generates composite video signal for CRT composing these two input signals.

When using a CRT monitor, this composite video signal is used directly; but for home TV sets, it is used after it is modulated to 61.25 MHz (channel-3) or 67.25 MHz (channel-4) through the RF modulator. The switch installed in the RF modulator controls switching of the modulation frequencies.

Table 4-4 shows the functions of the principal signals from CRTC.

Figure 4-8 shows block diagram of the CRT interface circuit.

Figure 4-9 shows the display timing chart at 40 characters mode and Figure 4-10 shows that at 80 characters mode.

Figure 4-11 shows the waveforms of video signal.

Symbol	Name of terminal	Description
HSYNC	Horizontal Sync	HSYNC is an active "H" level signal which provides horizontal synchronization for the displaying device.
VSYNC	Vertical Sync	VSYNC is an active ''H'' level signal which provides vertical synchronization for the display device.
DISPTMG	Display timing	DISPTMG is an active "H" level signal which defines the display period in horizontal and vertical raster scanning. The video signal should be "enable" only when DISPTMG is at "H" level.
CUDISP	Cursor display	CUDISP is an active "H" level video signal which is used to display the cursor on the CRT screen. This output is inhibited as long as DISPTMG is at "H" level.
RA0-RA4	Raster address	RAO-RA4 are raster address signals which are used to select the raster of the character generator.
MA0-MA13	Refresh memory address	MAO-MA13 are refresh memory address signals which are used to refresh the CRT screen periodically.

Table 4-4. Function of the Principal Signals

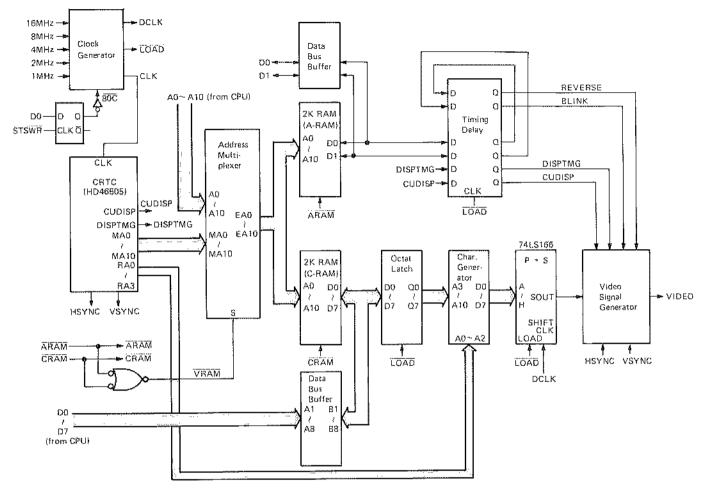


Figure 4-8. CRT Interface Block Diagram

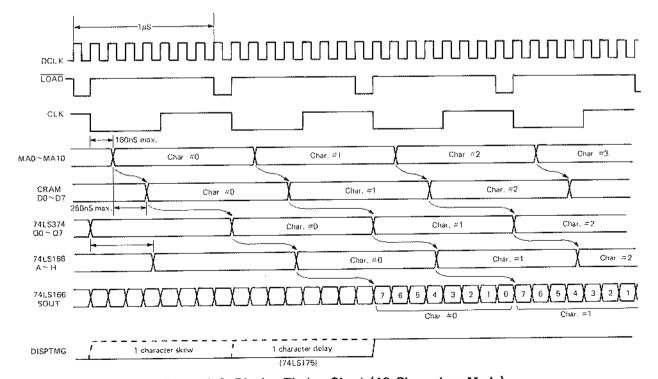


Figure 4-9. Display Timing Chart (40 Characters Mode)

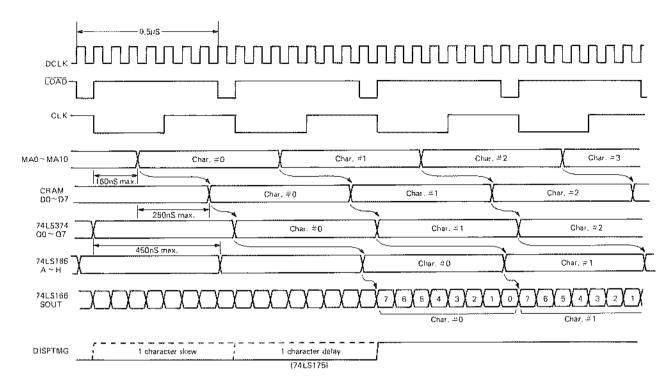
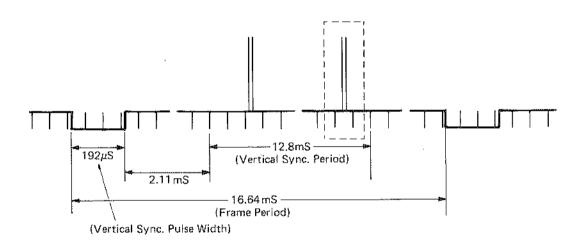


Figure 4-10. Display Timing Chart (80 Characters Mode)



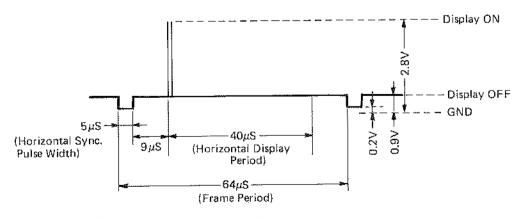


Figure 4-11. Waveform of Video Signal

Flicker Suppressing Circuit

As shown in Figure 4-12, during vertical retrace (during display), Q-output of M11 becomes "L"; otherwise, it becomes "H". For example, if the HLDEN signal is "H", BUSRQ becomes "L" so that the CPU is set in "wait condition" while displaying characters. This condition prevents the CPU from accessing VRAM during the vertical displaying period.

VSRET signal is read out of the gate of M29 into the CPU and, through this signal, the CPU can detect the condition of the display.

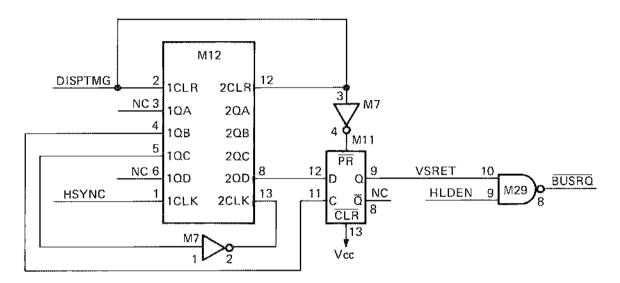


Figure 4-12. Flicker Suppression Circuit

FDD Interface Signals

Figure 4-13 shows the FDD (Floppy Disk Drive) interface block diagram. Each signal has a specified function for FDD.

1. DRIVEO and DRIVE1 (to FDD)

When either of the two input lines becomes "L", only the "L" signal drive can respond to the input lines, gate the output lines and turn the drive select LED on. DRIVE SELECT (0 or 1) is determined by plugging in the shorting plug.

2. DIR (to FDD)

DIR is a control signal which defines the direction of motion of the R/W head. If the input signal is "L", the R/W head moves toward the center of the disk (STEP IN). If the input signal is "H", the R/W head moves towards the outside edge of the disk (STEP OUT). Direction change of the head motion must be made before the FDD receives a STEP pulse.

3. STEP (to FDD)

STEP moves the R/W head by one track per one pulse. After receiving the final STEP pulse, the drive must wait at least "seek + settling" time to assure secure read/write.

4. WG (to FDD)

"L" level signal allows the FDD to write data on the diskette. This signal becomes ineffective when WRITE PROTECT signal is "L" or the drive is not selected. "H" level signal allows the FDD to read the data stored on the diskette.

5. WD (to FDD)

WD provides the FDD the data on the diskette. Each transition "H" to "L" or "L" to "H" of MFM signal reverses the direction of the current through R/W head and writes a bit of data. This line becomes "enable" when WRITE GATE is "L", WRITE PROTECT is "H" and DRIVE SELECT is "L".

6. MOTOR ON (to FDD)

When this signal is "L", the spindle motor rotates and, when "H", it stops. The spindle motor reaches to the rated speed within 0.5 second. This line responds to the input signal regardless of the DRIVE SELECT signal.

7. IP (from FDD)

The "L" signal is provided by the drive every one rotation of the diskette indicating the beginning of the track.

8. RDATA (from FDD)

This line provides a "clock + data" pulse which is converted from analog data detected by the R/W head.

9. TR00 (from FDD)

Low state of this signal indicates that the R/W head is positioned at track 00.

10. WPRT (from FDD)

"L" signal indicates that a write protected diskette is installed in the FDD.

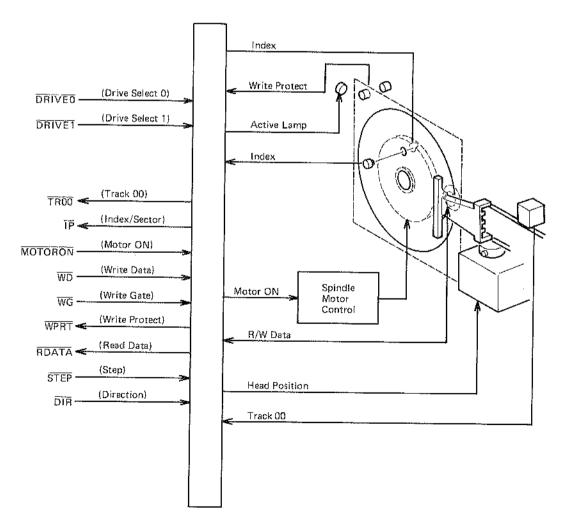


Figure 4-13. FDD Interface Block Diagram

FDD Control Circuit

FDD control circuit consists of FDC (M26), data separator (M27), pre-compensation circuit, and wait control circuit.

1. FDC (Floppy Disk Controller)

FDC consists of one LSI (M26) and, using D BUS, transfers commands and data corresponding to the FDD from the CPU. To detect the selection by the CPU, Y2 output signal (FDC) by I/O port decoder M38 and A0/A1 signal are used. Combining these signals with \overline{IORD} and \overline{IORW} signals, FDC identifies the signals from the CPU as to whether they are the command, read/write data or request of status.

Table 4-5 shows the combination of the signals:

Α0	A1	IORD	IOWR	Description
0	0	0	0	Reading of the status register
0	0	1	0	Writing onto the command register
0	1	0	1	Reading of track register
0	1	1	0	Writing onto the track register
1	0	0	1	Reading of the sector register
1	0	ī	0	Writing onto the sector register
1	1	0	1	Transfer of read data
1	1	1	0	Transfer of write data

Table 4-5. FDC Function Table

The table below shows the functional description of the principal terminals. If you want to have additional information about this LSI, refer to the TRS-80 Model II Technical Reference Manual since this LSI is functionally identical to the 1791 used in the FDC Printer Interface Board of the Model II, except that the data BUS is true as opposed to inverted.

Symbol	Name	Input/Output	Description
DRQ	Data request	Output	In disk read mode, DRQ indicates that the data is assembled in the data register. In disk write mode, it indicates that the data register is empty. DRQ is reset by the read or write data operation.
IRQ	Interrupt	Output	IRQ becomes active at the completion request of command and is reset when the CPU reads the status or writes the command.
STEP	Step	Output	Step pulse output (Active high).
DIR	Direction	Output	High level means that the head is stepping in and low level means that the head is stepping out.
EARLY	Early	Output	This signal is used for write pre-compensation. It indicates that the write data pulse should be shifted early.
LATE	Late	Output	This signal is also used for write pre-compensation. It indicates that the write data pulse should be shifted late.
HLD	Head load	Output	This output signal controls the rotation of the motor of the FDD. The motor must be rotated by this high level output.
₽P	Index pulse	Input	This input indicates that an index hole of the diskette is encountered.
TR00	Track 00	Input	This signal tells the device that the head is located on track 00. Active low.

Symbol	Name	Input/Output	Description
WPRT	Write protect	Input	Low level signal of this input informs the device that the drive is in write protect state. Before disk write operation starts, this signal is sampled and an active low signal terminates the current command, and sets IRQ. Write protect status bit in the status register is also set.
DDEN	Double density mode select	Input	This input determines the operation mode of the device. DDEN=0 selects double density mode.
RCLK	Read clock	Input	This signal is used internally for the data window. Phasing relation to the raw read data is specified, but the polarity (RCLK high or low) is not important.
RG	Read gate	Output	This signal shows the external data separation that the syncfield is detected.
RAWRD	Raw read	Input	This input signal from the drive shall be low for each recorded flux transition.
WG	Write gate	Output	This signal becomes active before disk write operation occurs.
WD	Write data	Output	This signal consists of data bits and clock bits. It becomes active for every flux transition.
RESET	Reset	Input	Active low. The device is reset by this signal and automatically loads "03" into the command register. The not-ready-status bit is also reset by this signal. When reset input is made high, the device executes restore command unless ready is active and the device loads "01" to the sector register.

Table 4-6. Description of the Principal Terminals

2. Data Separator (SED9421C)

SED9421C is an IC which generates a data window signal that separates clock bits and data bits among the data (RDATA) read out of the FDD. Figure 4-14 shows the functions of this IC.

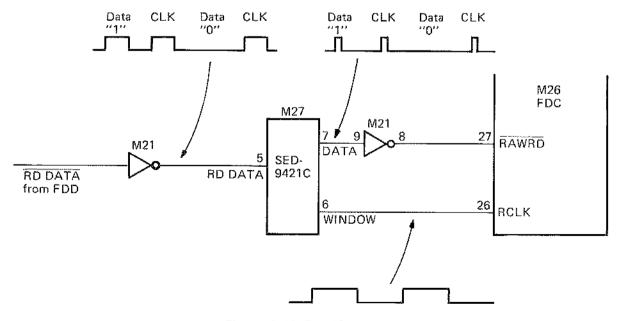


Figure 4-14. Data Separator

3. Pre-Compensation Circuit

This circuit adjusts timing of the write data delivered from FDC to the FDD. This circuit compensates data which will be shifted in writing since peak of the data may shift during data reading, depending on their data pattern.

The time available to compensate is 125 nanoseconds, i.e., one pulse width of 8 MHz.

In Figure 4-15, FDC outputs an EARLY or LATE signal, depending on the writing data pattern; then, D0, D1 or D2 terminals of M46 becomes "H" so that the number of flip-flops through which WD (write data) passes is determined.

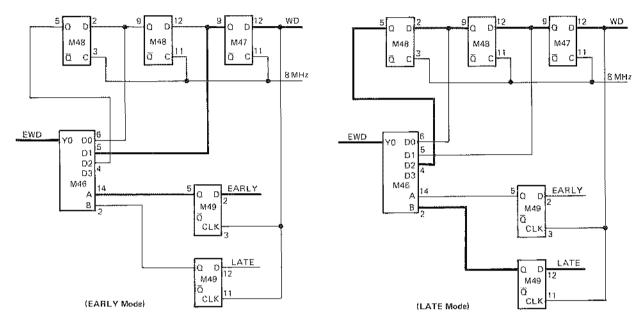


Figure 4-15. Pre-Compensation Circuit

4. Wait Control Circuit

As shown in the figure below, this circuit controls read/write data transaction between the CPU and the FDC.

During read operation, the CPU transfers a read command to the FDC setting A4="H" and FDC="L". Then, the CPU executes a dummy read operation once setting A4="L" and FDC="L".

At this time, Pin-9 of M1 becomes "L" and the CPU enters "wait condition". In this condition, as soon as the FDC reads the data from FDD and the buffer is filled by 8 bits of data, DRQ becomes "H", Q terminal of M1 becomes "L" and WAIT becomes "H". Then, the CPU releases "wait condition" and reads the data stored in the FDC.

The CPU repeats the above procedures and reads the data from the FDC continuously.

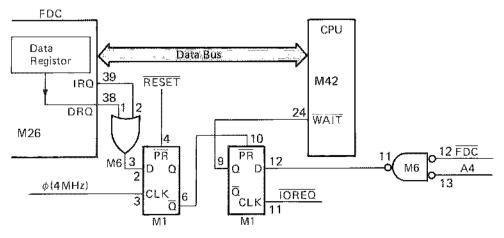


Figure 4-16. Wait Control Circuit

Power Supply and Reset Circuit

The power supply circuit consists of a regulator IC, capacitors, resistors, coils, and a diode (ZD101) determined for the reference voltage of VCC. This circuit generates +5-volt and +12-volt power -+12 volt is supplied to the FDD and RF modulator, and +5 volt is supplied to all of the ICs except M41 and M44 in the system BUS interface circuit.

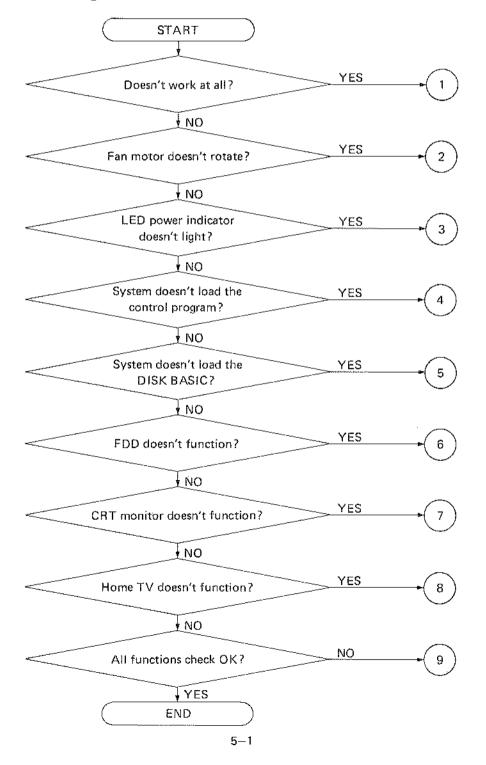
The RESET circuit consists of T101, T102, and the other components. T102 detects when the DC voltage reaches the proper level; R101 and T101 provide hysteresis to the RESET signal.

5/Troubleshooting

This section shows you how to go about solving a problem or malfunction that has been identified. All you have to do, is find the problem in the Troubleshooting Flowchart and refer to the section indicated by the number. Each section then identifies the components associated with the circuit in question and provides remedial instructions.

After completing any repairs, you should re-check each functional item according to the CHECK LIST. You can make use of the CHECK LIST even if the location and condition of the malfunction are not readily clear.

Troubleshooting Flowchart



Checking Procedure

1. Doesn't work at all.



Check the power.

- 1. Is the plug of AC cord plugged into the AC outlet?
- 2. Is the power switch ON?
- 3. Isn't the fuse blown? (It is in the fuse holder located on the rear side.)
 - If blown, check the power transformer and D101 D104 and C101 on the Power Supply PCB unit.
 Then replace the fuse. (AC250V 1A)

Check the power supply circuit,

- 1. Isn't the fuse F101 blown?
 - If blown, check the resistance between pin 15 and pin 6 of M101. Then replace the fuse.
 (AC125V 3A)
- 2. Is 15 25V applied to the cathode of D101?
 - If not, check power transformer and D101 D104.
- 3. Check output voltages.
 - a) VCC . . , \pm 5V \pm 0.25V If not, check ZD101, VR101, R107, R109, R110, C105, C107, C108, C109, L102, L103 and M101.
 - b) +12V . . . +12V ±0.6V If not, check R106, C104, C105, C106, L101 and M101.

Check the RESET signal.

- 1. Is it high level (2.5 5.25V) at pin 10 of M21?
 - If not, check below.
- 2. Is the voltage at the collector of T102 low level (0 0.5V)?
 - If not, check R103, R104, R105 and T102.
- 3. Is the voltage at the cathode of D106 high level (4.5 5.25 V)?
 - If not, check R102, R111, D106 and T101.
 If OK, check the cable from Power Supply PCB to Main PCB, C77 and M21.

Check the connection of all connectors,

(to next page)

Check the Main PCB.

1. Check all clock signals.

a) Pin 8 of M37 . . . 16 MHz

If not, check M37, R24, R26, C44, C45, C46, C51, C52 and X1.

b) Pin 11 of M47 . . . 8 MHz

If not, check M47.

c) Pin 6 of M42 . . . 4 MHz

If not, check M14 and M27.

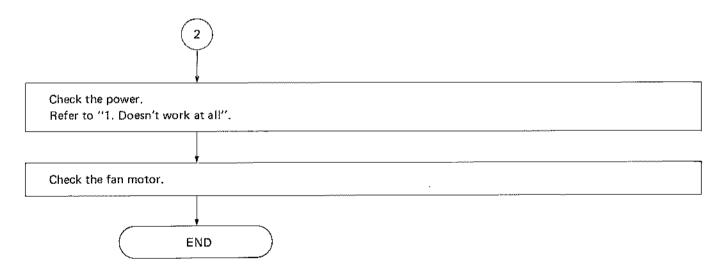
d) Pin 24 of M26 . . . 1 MHz

If not, check M27 and M32.

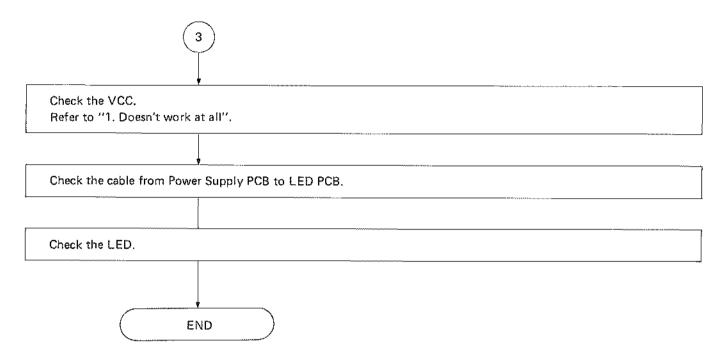
2. Check all ICs.

Try to replace the FDD unit,

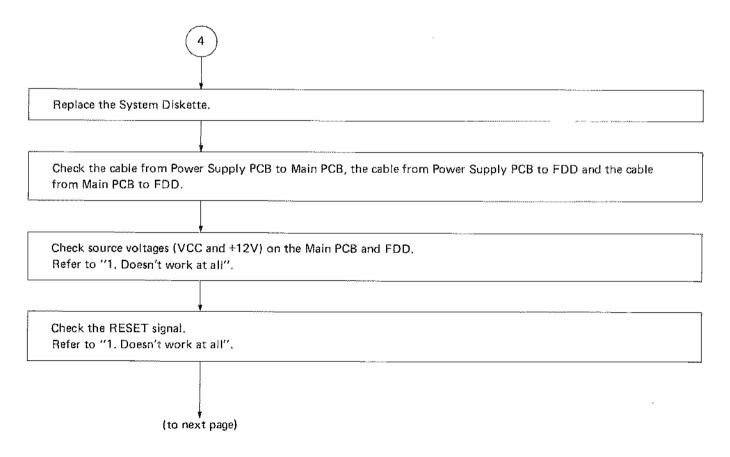
2. Fan motor doesn't rotate.

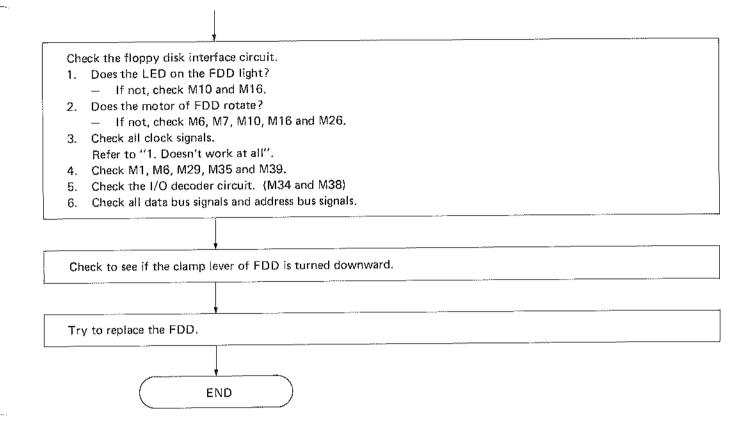


3. LED power indicator doesn't light.

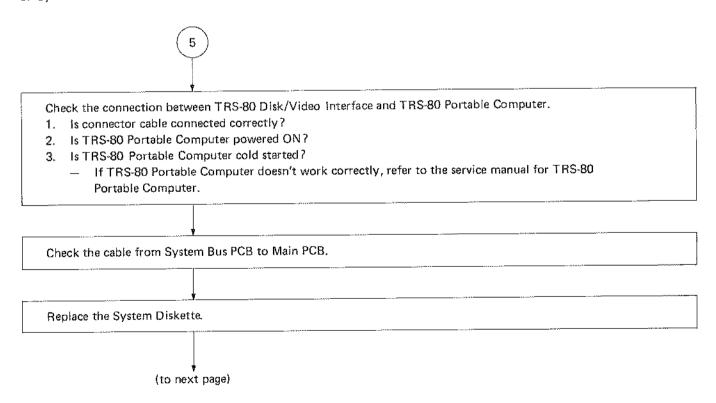


4. System doesn't load the control program.





5. System doesn't load the DISK BASIC.



Check system bus interface circuit.

- 1. Is RST signal at pin 35 of M45 low level (0 0.5V)?
 - If not, check M21.
- 2. Check voltages of pin 14, pin 15 and pin 16 of M45 if they are low level (0 0.5V).
 - If not, check R47, R48 and R49.
- 3. Is RESET signal at pin 1 of M41 low level (0 0.5V)?
 - If not, check RESET signal output of TRS-80 Portable Computer.
 (Refer to the service manual for TRS-80 Portable Computer.)
- 4. Check all parts in this circuit. (M30, M35, M41, M43, M44, M45 and R29 through R43)

Check System Bus PCB. (L301, LF301, LF310, LF312, LF313, LF314 and C301)

END

6. FDD doesn't function.

If system doesn't read the contents of the diskette, refer to "4. System doesn't load the control program" or "5. System doesn't load the DISK BASIC".

If system doesn't save data or program to diskette, check below.

6

Check the diskette.

- 1. Is it formatted?
 - If not, it must be formatted with "FORMAT" program.
- 2. Isn't the write protect seal attached?
 - If it is attached, take it off and try again.

Check the FDD control circuit.

Are high level pulses output at pin 30, pin 31, pin 17 and pin 18 of M26?

If not, check M26, M35 and M39.

Check the pre-compensation circuit.

- 1. Check the shift clock (8 MHz) at pin 11 of M47.
 - If not, check M47.
- 2. Check M14, M46, M47, M48 and M49.

(to next page)



7. CRT monitor doesn't function.



Check the CRT monitor set.

- 1. Is it powered ON?
- 2. Check adjustments of horizontal sync, vertical sync, brightness and contrast.
- 3. Is the cable from TRS-80 Disk/Video Interface to CRT monitor connected correctly.

Check the timing generator circuit.

1. Check dot clock signal (DCLK) at pin 2 of M33.

8 MHz at 40 characters mode

16 MHz at 80 characters mode

- If not, check M7, M11, M16, M34 and M37.
- 2. Check the frequency and waveform of LOAD signal.

1 MHz at 40 characters mode

- 2 MHz at 80 characters mode
- If not, check M29, M30, M32, M33 and C78.

Check the CRT interface and control circuit.

1. Check the frequency and waveform of HSYNC and VSYNC.

HSYNC signal . . . 15.625 kHz VSYNC signal . . . 60.1 Hz

- If not, check M13.
- 2. Check if refresh memory address (MA0 MA13) and raster address (RA0 RA4) appear on M13.
 - If not, check M13.
- 3. Does the serial data signal appear at pin 13 of M15?
 - If not, check M20, M24, M25, M19, M22, M18, M17 and M15.
- 4. Does the composite video signal appear on VIDEO terminal of RF modulator?
 - If not, check M2, M3, M5, M6, R2, R3, R4, R6, D1, L1 and T1.
 - If it appears but CRT monitor doesn't function, check the RF modulator.

(to next page)

Display function check.

1. Display is flicking.

Check M7, M11, M12 and M29.

2. Blink or reverse mode can't be set.

Check M3, M4, M9, M23 and M32.

Blinking frequency isn't 2 Hz.

Check M8.

4. Display character is not same as the one which is set from TRS-80 Portable Computer.

Check M17, M19 and M22.

END

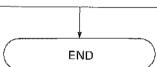
8. Home TV doesn't function



Check the home TV set.

- 1. Is it powered ON?
- 2. Check adjustments of horizontal sync, vertical sync, brightness and contrast.
- 3. Is the connection from TRS-80 Disk/Video Interface to home TV set correct?
- 4. Is RF output channel the same as the channel of TV set?
- 5. Is the switch on the Switch box unit positioned to "COMPUTER" side?

Check the timing generator circuit, and CRT interface and control circuit refering to "7. Monitor TV doesn't function".



9. Check system again, as described in the "Troubleshooting Flowchart".

Check List

After completing all repairs and adjustments, check all functions according to the TEST program shown below. Before beginning the checking, TRS-80 Portable Computer must be cold started and the DISK BASIC is loaded to it.

1. Checking the floppy disk control

(1) Put the System Disk into Drive 0 FDD.

(2) Execute the format program.

Type RUN "O: FORMAT" (ENTER).

(3) When the following message appears, press 0 (ENTER).

message . . . This utility formats diskettes.

- All data will be lost -

Which drive will be used (0 or 1)?

(4) The next message appears. Place the blank diskette into Drive 0 FDD and press (ENTER).

message . . . Put the diskette to be formatted in DriveO.

Press (ENTER) when ready.

Then the diskette is being formatted.

- (5) If the message "FORMAT COMPLETE" appears on the display, the diskette is correctly formatted.
- (6) Then type NEW (ENTER) for clearing the format program and execute the TEST program listed below.

```
... TEST program ...
```

- 10 CLEAR 1000:A\$=" ":B\$=" "
- 20 FOR I=32 TO 159
- 30 A\$=A\$+CHR\$(I)
- 40 NEXTI
- 50 T=0:S=0:GOSUB 500
- 60 S=1:GOSUB 500
- 70 T=39:S=0:GOSUB 500
- 80 S=1:GOSUB 500
- 90 T=0:S=0:GOSUB 1000
- 100 S=1:GOSUB 1000
- 110 T=39:S=0:GOSUB 1000
- 120 S=1:GOSUB 1000
- 130 BEEP:PRINT"FLOPPY TEST ... OK!!"
- 140 GOTO 1540
- 500 FOR I=1 TO 18
- 510 DSKO\$0, T, I, S, A\$
- 520 NEXT 1
- 530 RETURN
- 1000 FOR I=1 TO 18
- 1010 B\$=DSKI\$ (0, T, I, S)
- 1020 B\$=LEFT\$ (B\$, 128)
- 1030 IF A\$<>B\$ THEN GOTO 1500
- 1040 NEXT I
- 1050 RETURN
- 1500 CLS:BEEP:PRINT"FLOPPY TEST...NG!!"
- 1510 PRINT"TRACK=";T,"SECTOR="; I
- 1520 PRINT "WRITE DATA": PRINT A\$
- 1530 PRINT"READ DATA": PRINT B\$
- 1540 PRINT:INPUT"TRY AGAIN (y or n)";C\$
- 1550 IF C\$="y" THEN GOTO 10
- 1560 IF C\$="n" THEN END
- 1570 GOTO 1540

After executing this program, if the message "FLOPPY TEST...OK!!" appears, checking of floppy disk control is completed correctly.

2. Checking the display

- (1) Connect either monitor, CRT monitor or home TV set.
- (2) Clear the previous program by typing NEW (ENTER).
- (3) Then input the following TEST program and execute it.
 - ...TEST program . . .
 - 10 SCREEN1:A=40
 - 20 WIDTH A
 - 30 FOR I=32 TO 255
 - 35 IF I=127 THEN50
 - 40 PRINT CHR\$ (I);
 - 50 NEXTI
 - 60 PRINT:PRINT"IF THE DISPLAY IS OK, PRESS ENTER"
 - 70 A\$=INKEY\$:IF A\$<>""THEN GOTO 70
 - 80 IF A=40 THEN A=80: GOTO 20
 - 90 A=40:GOTO 20
- (4) After executing this program, all characters will appear on the screen. Then check all characters with both display mode (40 characters mode and 80 characters mode).

6/Exploded View and Parts List

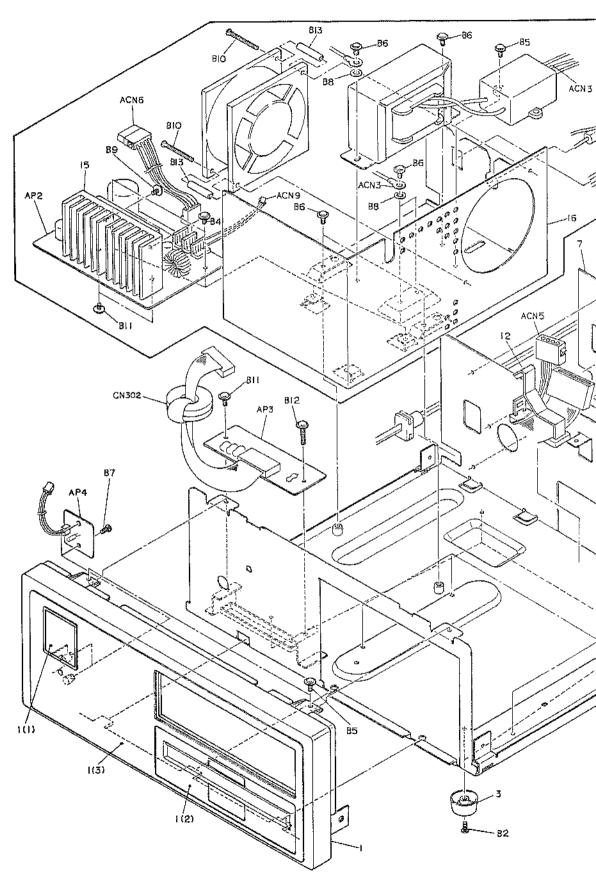
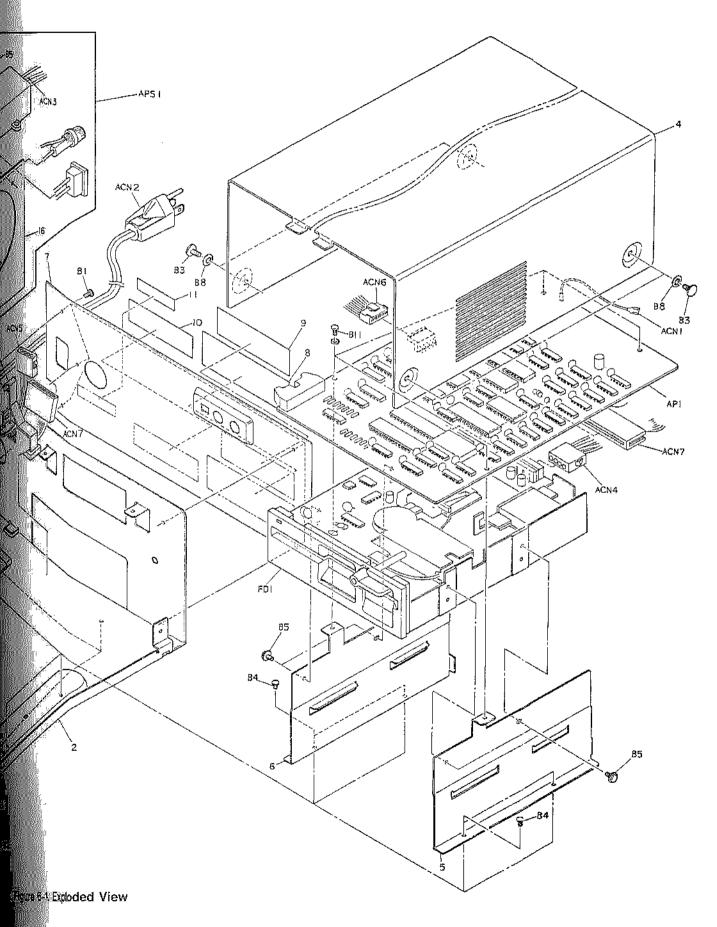


Figure 6-1. Ex



MAIN P.C.B. ASSEMBLY

Ref. No.	De	scription	RS Part No.	Mfr's Part No.
CAPACITO	PRS			
C1	Not used			
C2	Capacitor, Ceramic	0.1μF/25V/+80 −20%		CBF1E104ZT
C3	Capacitor, Electrolytic	100μF/16V/±20%		CEVD101A3N
C4	Capacitor, Ceramic	0.047μF/25V/±10%		CBF1E473KY
C5	Capacitor, Tantalum	22μF/16V/±20%		CSKD220MDC
C6	Capacitor, Ceramic	0.1μF/12V/±20%		CBF1B104MY
C7	Capacitor, Ceramic	0.047μF/25V/±10%		CBF1E473KY
C8	Capacitor, Ceramic	0.047μF/25V/±10%		CBF1E473KY
C9	Capacitor, Ceramic	0.1µF/12V/±20%		CBF1B104MY
C10	Capacitor, Ceramic	0.047μF/25V/±10%		CBF1E473KY
C11	1.000			
C12				
C13	₩	+		*
C14	Capacitor, Ceramic	0.047μF/25V/±10%		CBF1E473KY
C15	Capacitor, Ceramic	0.1μF/12V/±20%		CBF1B104MY
C16	Capacitor, Ceramic	0.1μF/12V/±20%		CBF1B104MY
C17	Capacitor, Ceramic	0.047μF/25V/±10%		CBF1E473KY
C18	Capacitor, Tantalum	1μF/10V/±20%		CSKC010MDC
C19	Capacitor, Ceramic	0.1μF/12V/±2 0 %		CBF1B104MY
C20	Capacitor, Ceramic	0.047µF/25V/±10%		CBF1E473KY
C21	Capacitor, Ceramic	0.1μF/12V/±20%		CBF1B104MY
C22	Capacitor, Electrolytic	100μF/10V/+75 10%		CEVC101ALN
C23	Capacitor, Ceramic	0.1μF/12V/±20%		CBF1B104MY
C24	Capacitor, Tantalum	1μF/10V/±20%		CSKC010MDC
C25	Capacitor, Ceramic	0.1μF/12V/± 20 %		CBF1B104MY
C26	Capacitor, Tantalum	1μF/10V/±20%		CSKC010MDC
C27	Capacitor, Ceramic	0.047μF/25V/±10%		CBF1E473KY
C28	Capacitor, Ceramic	0.047μF/25V/±10%		CBF1E473KY
C29	Capacitor, Ceramic	0.1μF/12V/±20%		CBF1B104MY
C30	Capacitor, Tantalum	1μF/10V/±20%		CSKC010MDC
C31	Capacitor, Ceramic	0.047μF/25V/±10%		CBF1E473KY
C32	Capacitor, Ceramic	0.047μF/25V/±1 0 %		CBF1E473KY
C33-34	Not used			
C35	Capacitor, Mylar*	0.047μF/50V/±5%		CQMB473JTH
C36	Capacitor, Tantalum	1μF/10V/±20%		CSKC010MDC
C37	Capacitor, Tantalum	1μF/10V/±20%		CSKC010MDC
C38	Capacitor, Ceramic	0.047μF/25V/±10%		CBF1E473KY
C39	Capacitor, Ceramic	0.047μF/25V/±10%		CBF1E473KY
C40	Capacitor, Mylar	0.047μF/50V/±5%		CQMB473JTH
C41	Capacitor, Ceramic	0.047μF/25V/±10%		CBF1E473KY
C42	Capacitor, Ceramic	0.047μF/25V/±10%		CBF1E473KY
C43	Capacitor, Tantalum	1μF/10V/±20%		CSKC010MDC
C44	Capacitor, Trimmer	25pF	AC-0986	CTZ7250H01
C45	Capacitor, Ceramic	220pF/50V/±10%		CCFB221K0T
C46	Capacitor, Ceramic	33pF/50V/±10%		CCFB330K0T
C47	Capacitor, Ceramic	0.1μF/12V/±20%		CBF1B104MY
C48	Capacitor, Ceramic	0.047μF/25V/±10%		CBF1E473KY
C49	Capacitor, Ceramic	0.047μF/25V/±10%		CBF1E473KY
C50	Capacitor, Tantalum	1μF/10V/±20%		CSKC010MDC
C51	Capacitor, Ceramic	220pF/50V/±10%		CCFB221K0T
C52	Capacitor, Ceramic	33pF/50V/±10%		CCFB330K0T
C53	Capacitor, Ceramic	0.047μF/25V/±10%		CBF1E473KY

^{*} Mylar is a registered trademark of E.I. Du Pont de Nemours and Company.

Ref. No.	De	escription	RS Part No.	Mfr's Part No.
C54	Capacitor, Ceramic	0.047μF/25V/±10%	1010	CBF1E473KY
C55	Capacitor, Ceramic	0.047µF/25V/±10%		CBF1E473KY
C56	Capacitor, Tantalum	1μF/10V/±20%		CSKC010MDC
C57	Capacitor, Caramic	0.047μF/25V/±10%		CBF1E473KY
C58	Capacitor, Ceramic	0,047μF/25V/±10%		CBF1E473KY
C59	Capacitor, Tantalum	1μF/1 0 V/±20%		CSKC010MDC
C60	Capacitor, Ceramic	0.047μF/25V/±10%		CBF1E473KY
C61	Capacitor, Ceramic	470pF/50V/±10%		CKFB471KBM
C62				
C63	· •	₩		#
C64	Capacítor, Ceramic	470pF/50V/±10%		CKFB471KBM
C65	Capacitor, Tantalum	1μF/10V/±20%	-	CSKC010MDC
C66	Capacitor, Ceramic	100pF/50V/±10%		CCFB101K0T
C67	Capacitor, Electrolytic	22μF/16V/±20%		CEVD220A3N
C68	Capacitor, Ceramic	470pF/50V/±10%		CKFB471KBM
C69	Capacitor, Ceramic	1000pF/50V/±10%		CKFB102KBT
C70				
C71	# -	*		†
C72	Capacitor, Ceramic	1000pF/50V/±10%	***************************************	CKFB102KBT
C73	Capacitor, Ceramic	470pF/50V/±10%		CKFB471KBM
C74-75	Not used	450 - 100 - 11 - 100		Apren de const
C76	Capacitor, Ceramic	470pF/50V/±10%		CKFB471KBN
C77	Capacitor, Electrolytic	4.7μF/25V/+7510%		CEVE4R7ALN
C78	Capacitor, Ceramic	33pF/50V/±10%		CCFB330KOT
C79	Capacitor, Ceramic	0.1μF/12V/±20%		CBF1B104MY
C80				
C81	Caracitan Canacia	7		ODE40404WV
C82	Capacitor, Ceramic	0.1μF/12V/±20%		CBF1B104MY CCFB560K0T
C83 C84	Capacitor, Ceramic Capacitor, Ceramic	56pF/50V/±10% 56pF/50V/±10%		CCFB560K0T
Cu-1	Capacitor, Coranne	30pt /30 V/±10/6	77.74	05/ 5505/(01
CONNECT	ORS			
CN1	Jack, Junction to Syst	em Bus	AJ-7527	YJF20S022U
CN2	Jack, Junction to Flop	ppy Dîsk	AJ-7528	YJF34S013U
CN4	Jack, Junction to Pow	er Supply	AJ-7526	YJF05S023Z
DIODE				
D1	Diode, Silicon 1S2076			QDSS2076#B
	YYAAA		711700000	
COIL	3	***************************************	1	
L1	Coil, Choke 4.7µH/50	0mA	ACB-2551	LF4R7KE04Y
	, ,			

Ref. No.	Des	eription	RS Part No.	Mfr's Part No.
INTEGRA	TED CIRCUITS			
M1	I.C., TTL, Flip-Flop	HD74LS74AP or		QQT07474CB
		SN74LS74AN or		QQT07474AU
		M74LS74AP or		QQT07474DE
		MB74LS74A		QQT07474GF
M2	I.C., TTL, AND Gate	HD74LS08P or		QQT07408FB
		SN74LS08N or		QQT07408BU
		M74LS08P or		QQT07408EE
		MB74LS08		QQT07408GF
MЗ	I.C., TTL, OR Gate	HD74LS32P or	MX-5964	QQT07432CB
	*	SN74LS32N or		QQT07432BU
		M74LS32P or		QQT07432EE
		MB74LS32		QQT07432FF
M4	I.C., TTL, Flip-Flop	HD74LS174P or		QQT74174BB
		M74LS174P or		QQT74174AE
		SN74LS174N or		QQT74174DU
		MB74LS174		QQT74174CF
M5	I.C., TTL, EX-OR Gate	HD74LS86P or		QQT07486CB
		SN74LS86N or		QQT07486AU
		M74LS86P or		QQT07486GE
		MB74LS86		QQT07486HF
M6	I.C., TTL, OR Gate	HD74LS32P or	MX-5964	QQT07432CB
		SN74LS32N or		QQT07432BU
	vooroo	M74LS32P or		QQT07432EE
		MB74LS32		QQT07432FF
M7	I.C., TTL, Inverter	HD74LS04P or		QQT07404HB
		SN74LS04P or		QQT07404AU
		M74LS04P or		QQT07404FE
MO	LC TTL Country	MB74LS04	14V F000	QQT07404JF
M8	I.C., TTL, Counter	HD74LS393P or	MX-5969	QQT74393BB
		SN74LS393N or		QQT74393AU
м9	1.C., TTL, Buffer	M74LS393P HD74LS125AP or	MAY COOF	QQT74393CE
1019	i.C., i i L, builei	M74LS125AP or	MX-5965	QQT74125CB
		SN74LS125AN or		QQT74125AE QQT74125EU
		MB74LS125A		QQT74125E0
M10	I.C., TTL, Driver	HD7416P or	MX5963	QQT07416BB
141.10	1.0., 112, 511001	SN7416N	WINDSOS	QQT074168U
M11	I.C., TTL, Flip-Flop	HD74LS74AP or		QQT07470A0
	, , , , , , , , , , , , , , , , , , ,	SN74LS74AN or		QQT07474AU
I.		M74LS74AP or	İ	QQT07474DE
Î		MB74LS74A		QQT07474GF
M12	I.C., TTL, Counter	HD74LS393P or	MX-5969	QQT74393BB
	,,	SN74LS393N or	11177 33 33	QQT74393AU
		M74LS393P		QQT74393CE
M13	I.C., N-MOS, CRTC	HD46505SP	MX-5959	QQN46505AB
M14	I.C., TTL, Driver	HD7416P or		QQT07416BB
	-	SN7416N		and the second section in
M15	I.C., TTL, Shift Register	SN74LS166AN or		QQT74166CU
	_	M74LS166AP		QQT74166DE
M16	I.C., TTL, Flip-Flop	HD74LS174P or		QQT74174BB
		M74LS174P or		QQT74174AE
		SN74LS174N or		QQT74174DU
Ì		MB74LS174		QQT74174CF

Ref. No.	Desc	cription	RS Part No.	Mfr's Part No.
M17	I.C., N-MOS, P-ROM for Char. Gen.	HN462732G (For USA and Canada) (For UK, Belgium and Australia)	MX-5961	QQ0C1027AB QQ0C1027BB
M18	I.C., TTL, Flip Flop	HD74LS374P or SN74LS374N or M74LS374P or MB74LS374	MX-5968	QQT74374BB QQT74374CU QQT74374AE QQT74374DF
M19	I.C., C-MOS, RAM	HM6116LP-4 or HM6116P-4	MX-5970	QQ006116BB QQ006116AB
M20	I.C., TTL, Selector	HD74LS157P or SN74LS157N or M74LS157P or MB74LS157		QQT74157BB QQT74157AU QQT74157DE QQT74157FF
M21	I.C., TTL, Inverter	HD74LS14P or SN74LS14N or M74LS14P or MB74LS14	MX-5962	QQT07414CB QQT07414AU QQT07414EE QQT07414FF
M22	I.C., TTL, Transceiver	HD74LS245WP or SN74LS245N or M74LS245P or MB74LS245	MX-5967	QQT74245DB QQT74245AU QQT74245BE QQT74245EF
M23	I.C., C-MOS, RAM	HM6116LP-4 or HM6116P-4	MX-5970	QQ006116BB QQ006116AB
M24	I.C., TTL, Selector	HD74LS157P or SN74LS157N or M74LS157P or M874LS157		QQT74157BB QQT74157AL QQT74157DE QQT74157FF
M25	I.C., TTL, Selector	HD74LS157P or SN74LS157N or M74LS157P or MB74LS157		QQT74157BB QQT74157AL QQT74157DE QQT74157FF
M26	I.C., N-MOS, FDC	M5W1793-02P or MB8877A	MX-5957	QQN01793AE QQN08877AE
M27	I.C., C-MOS, FD Data Separator	SED9421C0B	MX-5973	QQ09421CB6
M28	I.C., C-MOS, RAM	HM6116LP-4 or HM6116P-4	MX-5970	QQ0061168B QQ006116AB
M29 M30	I.C., TTL, NAND Gate I.C., TTL, OR Gate	HD74LS00P HD74LS32P or SN74LS32N or M74LS32P or MB74LS32	MX-5964	QQT07400GE QQT07432CB QQT07432BU QQT07432EE QQT07432FF
M31	I.C., TTL, Decoder	HD74LS138P or SN74LS138N or M74LS138P or MB74LS138		QQT74138BB QQT74138AL QQT74138DE QQT74138FF
M32	I.C., TTL, Inverter	HD74LS04P or SN74LS04N or M74LS32P or MB74LS04		QQT07404HE QQT07404AL QQT07404FE QQT07404JF
M33 M34	I.C., TTL, Counter I.C., TTL, OR Gate	HD74LS163P HD74LS32P or SN74LS32N or M74LS32P or MB74LS32	MX-5966 MX-5964	QQT7416388 QQT07432C8 QQT07432BU QQT07432EE QQT07432FF

Ref. No.	Desc	ription	RS Part No.	Mfr's Part No.
M35	I.C., TTL, OR Gate	HD74LS32P or	MX-5964	QQT07432CB
17100	, , , , , , , , , , , , , , , , , ,	SN74LS32N or		QQT07432BU
		M74LS32P or		QQT07432EE
		MB74LS32		QQT07432FF
M36	I.C., C-MOS, RAM	HM6116LP-4 or	MX-5970	QQ006116BB
.,,,,,	1.0., 2 2,	HM6116P-4		QQ006116AB
M37	I.C., TTL, NAND Gate	HD74LS00P or		QQT07400GB
711-0-2	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	SN74LS00N or		QQT07400BU
		M74LS00P or		QQT07400KE
		MB74LS00		QQT07400MF
M38	I.C., TTL, Decoder	HD74LS139P or		QQT74139AB
11.00	,, 5 70000	SN74LS139N or		QQT74139BU
		M74LS139P or		QQT07400MF
		MB74LS139		QQT74139DF
M39	I.C., TTL, AND Gate	HD74LS08P or		QQT07408FB
10100	1.0.7 1 2,73142 0020	SN74LS08N or		QQT07408BU
		M74LS08P or		QQT07408EE
		MB74LS08		QQT07408GF
M40	I.C. N-MOS P-ROM for	HN462732G (For USA and Canada)	MX-5960	OQ0C1026AB
WITO	Program	(For UK, Belgium and Australia)	WW 0000	QQ0C1026BB
M41	I.C., C-MOS, Buffer	TC40H365P	MX-5972	QQ040365AT
M42	I.C., N-MOS, CPU	μPD780C-1 or	MX-5956	QQN00780AA
		LH0080A or		QQN0080AA3
		MK3880-4 or		QQN03880BZ
		Z-80A		QQN80ACPU
M43	I.C., TTL, DRVR/DCVR	HD74LS244P or		QQT74244CB
		SN74LS244N or		QQT74244AL
		M74LS244P or		QQT74244BE
		MB74LS244		QQT74244DF
M44	I.C., C-MOS, Buffer	TC40H245P	AMX-5818	QQ040245AT
M45	I.C., N-MOS, PPI	M5L8255AP-5 or	MX-5958	QQN08255AE
		μPD8255AC-5		QQN08255BA
M46	I.C., TTL, Selector	HD74LS153P or		QQT74153EB
		M74LS153P or		QQT74153AE
		MB74LS153P or		QQT74153FF
		SN74LS153N		QQT74153DL
M47	I.C., TTL, Flip-Flop	HD74LS74AP or		QQT07474CB
	1350, 100, 100, 100, 100, 100, 100, 100, 1	SN74LS74AN or		ΩΩΤ07474ΑU
		M74LS74AP or		QQT07474DE
		MB74LS74A		QQT07474GF
M48	I.C., TTL, Flip-Flop	HD74LS74AP or		QQT07474CB
WITE	1.0,, 112, 7 19 1 10 2	SN74LS74AN or		QQT07474AL
		M74LS74AP or		QQT07474DE
		MB74LS74A		QQT07474GF
M 4 9	I.C., TTL, Flip-Flop	HD74LS74AP or		QQT07474CB
	week the tube tob	SN74LS74AN or		QQT07474AU
	¥	M74LS74AP or		QQT07474DE
		MB74LS74A		QQT07474GF
				3

Ref. No.	I	Description	RS Part No.	Mfr's Part No.
RESISTOR	ARRAYS			
MR1	Resistor Array,	10K × 6, 1/8W/±10%	ARX-0384	RAB103K06D
MR2	Resistor Array,	100K × 6, 1/8W/±20%	ARX-0385	RAB104M06X
MR3	Resistor Array,	100K x 8, 1/8W/±20%		RAB104M08X
MR4	Resistor Array,	33K x 8, 1/8W/±20%		RAB333M08X
RESISTORS	s			AHIIIA 2000000000 14000 14000 14000 14000 14000 14000 14000 14000 14000 14000 14000
R1	Resistor, Carbon	10 ohm/1/4W/±5%		RD25PJ100X
R2	Resistor, Carbon	75 ohm/1/4W/±5%		RD25PJ750X
R3	Resistor, Carbon	33 ohm/1/4W/±5%		RD25PJ330X
R4	Resistor, Carbon	1.5K ohm/1/4W/±5%		RD25PJ152X
R5	Resistor, Carbon	240 ohm/1/4W/±5%		RD25PJ241X
R6	Resistor, Carbon	470 ohm/1/4W/±5%		RD25PJ471X
R7	Resistor, Carbon	330 ohm/1/4W/±5%		RD25PJ331X
R8				
R9	₩	*		*
R10	Resistor, Carbon	330 ohm/1/4W/±5%		RD25PJ331X
R11	Resistor, Carbon	10K ohm/1/4W/±5%		RD25PJ103X
R12				
R13				
R14	4	♥		*
R15	Resistor, Carbon	10K ohm/1/4W/±5%		RD25PJ103X
R16-17	Not used			
R18	Resistor, Carbon	10K ohm/1/4W/±5%		RD25PJ103X
R19	Resistor, Carbon	470 ohm/1/4W/±5%		RD25PJ471X
R20	Resistor, Carbon	1.2K ohm/1/4W/±5%		RD25PJ122X
R21	Resistor, Carbon	4,7K ohm/1/4W/±5%		RD25PJ472X
R22	Resistor, Carbon	330 ohm/1/4W/±5%		RD25PJ331X
R23	Resistor, Carbon	4.7K ohm/1/4W/±5%		RD25PJ472X
R24	Resistor, Carbon	1K ohm/1/4W/±5%		RD25PJ102X
R25	Resistor, Carbon	1K ohm/1/4W/±5%		RD25PJ102X
R26	Resistor, Carbon	1K ohm/1/4W/±5% 330 ohm/1/4W/±5%		RD25PJ102X
R27	Resistor, Carbon Resistor, Carbon			RD25PJ331X RD25PJ102X
R28	Resistor, Carbon	1K ohm/1/4W/±5% 33K ohm/1/4W/±5%		RD25PJ3333X
R29 R30	Resistor, Carbon	1K ohm/1/4W/±5%		RD25PJ102X
R31	rresistot, Carbun	71C Oring 1790072570		11020131027
R32				
R33	Resistor, Carbon	1K ohm/1/4W/±5%		RD25PJ102X
R34	Resistor, Carbon	33K ohm/1/4W/±5%		RD25PJ333X
R35	Resistor, Carbon	1K ohm/1/4W/±5%	***************************************	RD25PJ102X
R36			1	
R38				
R39				
R40				
R41				
R42	ļ V	₩		\
R43	Resistor, Carbon	1K ohm/1/4W/±5%		RD25PJ102X
	, =======			

Ref. No.		Description	RS Part No.	Mfr's Part No.
R44	Resistor, Carbon	1K ohm/1/4W/±5%	-	RD25PJ102X
R45-46	Not used			
R47	Resistor, Carbon	1K ohm/1/4W/±5%		RD25PJ102X
R48	¥	\		*
R49	Resistor, Carbon	1K ohm/1/4W/±5%		RD25PJ102X
R50	Resistor, Carbon	4.7K ahm/1/4W/±5%		RD25PJ472X
R51	Resistor, Carbon	4.7K ohm/1/4W/±5%		RD25PJ472X
R53	Resistor, Carbon	33K ohm/1/4W/±5%		
R54	Resistor, Carbon	33K ohm/1/4W/±5%		RD25PJ333X
1134	resistor, Carbon	35K ((((())) ()4W) ±5%		RD25PJ333X
RF MODUL	.ATOR			
RF1	RF Modulator	(For USA and Canada)	AX-9440	ZUV0000203
		(For UK and Belgium)		ZUV0003601
		(For Australia)		ZUV0000101
TRANSIST	OR	• — \AA		,
†1	Transistor, NPN, 2S0	C2002, Silicon, NO-Rank		QTC2002XCA
X1	Crystal Oscillator 1	6.0 MHz	MX-1102	XBR1A1010)
MISCELLAN	NEOUS	-///^		
ACN-1		erminals, for MAIN PCB		ACZZ157ULA
M17, M40	Socket, for I.C., DIC	CF-24CS	AJ-7529	YSC24S001Z
4				

POWER SUPPLY P.C.B. ASSEMBLY

l "		
CAPACITOR		,
C101 Capacitor, Electrolytic 6800µF/35V/±20%	CC-688MGAP	CEAF682AQR
C102 Capacitor, Electrolytic 1µF/50V/±20%		CEVG010A3N
C103 Capacitor, Ceramic 0.047µF/25V/±10%		CBF1E473KY
C104 Capacitor, Ceramic 0.01µF/25V/±10%		CBF1E103KT
C105 Capacitor, Electrolytic 22µF/16V/±20%	***************************************	CEVD220A3N
C106 Capacitor, Electrolytic 1000µF/16V/±20%		CEAD102A3N
C107 Capacitor, Electrolytic 1000µF/10V/±20%		CEAC102A3N
C108 Capacitor, Electrolytic 220µF/10V/±20%	***************************************	CEVC221A3N
C109 Capacitor, Ceramic 0.01µF/25V/±10%	200	CBF1E103KT
C110 Capacitor, Electrolytic 220µF/35V/±20%		CEAF221A3N
C111 Capacitor, Ceramic 0.1 µF/50V/+80 -20%		CBF1H104ZT
CONNECTORS		
	AJ-7530	YJF02S039Z
	AJ-7531	YJF04S038Z
	AJ-7531 AJ-7531	YJF04S038Z
	AJ-7531 AJ-7532	YJF0480382 YJF058017Z
CN104 Jack, Junction to Main PCB CN105 Jack, Junction to LED	AJ-7332 AJ-7322	YJF02S041Z
CN 105 Sack, Juliction to LED	A3-7322	1310230412
DIODES		
D101 Diode, Silicon S2V-10		QDS2V10XXK
D102		
D103 ¥		+
D104 Diode, Silicon S2V-10		QDS2V10XXK
D105 Diode, Silicon 1S2076		QDSS2076#B
D106 Diode, Silicon 1S2076		QDSS2076#8
FUSE and FUSE HOLDER		40
F101 Fuse, 125V 3A	AHF-1293	ZFBP30202U
F101 Fuse Holder 85PN0819	AF-1249	YHF0P0008Z
COILS		
L301 Coil, Troidal SK11-3-150	ACA-8333	LWS151A01B
L102 Coil, Troidal PI-14	ACA-8334	LWS151A02C
L103 Coil, Troidal SF-T10-30	ACA-8335	LWS400301T
İ		

Ref. No.	Description	RS Part No.	Mfr's Part No.
INTEGRA	TED CIRCUIT		<u>L</u>
M101	I.C., Regulator STK7551	MX-5974	QQH07551A0
RESISTOF	as		
R101 R102 R103 R104 R105 R106 R107 R108 R109 R110 R111	Resistor, Carbon 56K ohm/1/4W/±2% Resistor, Carbon 1K ohm/1/4W/±5% Resistor, Carbon 10K ohm/1/4W/±5% Resistor, Carbon 51K ohm/1/4W/±2% Resistor, Carbon 47 ohm/1/4W/±5% Resistor, Carbon 47 ohm/1/4W/±5% Resistor, Carbon 270 ohm/1/4W/±5% Resistor, Carbon 1K ohm/1/4W/±5% Resistor, Carbon 56 ohm/1/4W/±5% Resistor, Carbon 1K ohm/1/4W/±5% Resistor, Metal Oxide 10 ohm/1W/±5%	N-0344CEC	RD25PG560Z RD25PJ102X RD25PJ103X RD25PG5102 RD25PG3302 RD25PJ470X RD25PJ470X RD25PJ271X RD25PJ102X RD25PJ560X RD25PJ102X
TRANSIST	•		RX1BNJ100B
⊤101 T102	Transistor, PNP, 2SA1115, Silicon, NO-Rank Transistor, PNP, 2SA1115, Silicon, NO-Rank		QTA1115XUE QTA1115XUE
POTENTIO	METER		
VR101	Potentiometer, 2K ohm B for +5V	AP-7385	RPSNB20205
ZENER DI	ODE		4.1-20
ZD101	Díode, Silicon, Zener HZ2CLL		QDZHZ2CLXB
MISCELLA	NEOUS		
ACN-9 15 B-9 B-11	Connector with Cords and Resistor Heat Sink, for Regulator I.C. Screw, Sems, Machine M3 x 16, S-ZnCr Screw, Bind Head with Outside Toothed Washer, Machine M3 x 6, S-ZnCr	AHD-2753 AHD-2754	ACCNG15GEA MU663AX001 BSPJ3016NZ BSP#3006NZ
nome.		71110-27 34	U31 #30001102

SYSTEM BUS P.C.B. ASSEMBLY

Ref. No.	Descript	ion	RS Part No.	Mfr's Part No.
CAPACITOR	S			
C301	Capacitor, Tantalum 22	/μF/16V/±20%		CSKD220MDC
LF301	Noise Suppress Capacitor 27	•	ACF-7367	CZEC271M01
LF302-309	Not used			
LF310	Noise Suppress Capacitor 27	'OpF	ACF-7367	CZEC271M01
LF311	Not used	· ·		
LF312	Noise Suppress Capacitor 27	'0pF	ACF-7367	CZEC271M01
LF313	Noise Suppress Capacitor 27	0pF	ACF-7367	CZEC271M01
LF314	Noise Suppress Capacitor 27	TOpF	ACF-7367	CZEC271M01
CONNECTO	R\$			
CN301	Jack, Junction to Portable Co	nmouter	AJ-7533	YJF40S009U
CN301 CN302	Connector With Cords and Fe		AW-3182	ACCNG16GE
COIL				
L301	Coil, Choke 22	2,μH/55mA		LF220KE04Y
LED P.C.B. A	ASSEMBLY Connector with Cords, to Po	wer Supply		ACCND59GE
D201	L.E.D., RED, SLP-135B			QL1SP135BC
POWER SUP	PLY ASSEMBLY			
ACN-2	Cord, AC Power	(For USA and Canada)	AW-3181	ACAC196UL
		(For UK)		ACAC202BSA
		(For Belgium)		ACAC203EE
		(For Australia)		ACAC204ASA
ACN-3	Ground Wire With Terminal,	for Noise Filter		ACZZ156ULA
AP-2	P.C.B. Assembly, Power Supp	ply	AX-9441	APLX128BA
NF1	Noise Filter, ZCBW203-11		AC-0987	FJ0060N03D
SW1	Switch, See-Saw, WK2A-44,		AS-2891	SC010203VQ
	Power	(For UK, Belgium and Australia)		SC020212AZ
PT1	Transformer, Power	(For USA and Canada)	ATA-1053	TPF66V002P
		(For UK, Belgium and Australia)	A T 46T6	TPG66E004P
F1	Fuse Holder, S-N1301 #51	(For USA and Canada)	AF-1250	YHF1S3009U
F-3	E 0001/ 14	(For UK, Belgium and Australia)	A DE 1004	YHF1S2005Z
F1	Fuse, 250V, 1A Fuse, 250V, 315mA	(For USA and Canada) (For UK, Belgium and Australia)	AHF-1294	ZFBQ10207C ZFBQ32103S

Ref. No.	Descrip	tion	RS Part No.	Mfr's Part No.
FM1	Fan Motor With Connector a	and Cords, C12V, 0.16A, FBP-08A12M	AM-4732	ZNF0122701
10		0124, 0.10A, FBP-08A12W		
16	Chassis, Power Supply			MB877SZ001
B-4	Screw, Sems, Machine,	M3 x 6, S-ZnCr	AHD-2759	BSPN3006NZ
B-5	Screw, Cup Head, Machine,			BSP43006NZ
B-6	Screw, Cup Head, Machine,		AHD-2756	BSP44006NZ
B-10	Screw, Sems, Machine,	M4 x 30, S-ZnCr	AHD-2755	BSPJ4030NZ
B-13	Spacer,	M4 x 17		MM265SZ001
B-8	Washer, Inside Toothed,	4mm, S-Zn	AHD-8834	BWU40855SW
				4 4
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MECHANICAL AND ASSEMBLY PARTS

AP-1 AP-3 AP-4		Description		Mfr's Part No.
	P.C.B. Assembly, Main	(For USA and Canada)	AX-9439	APLX133AAG
		(For UK and Belgium)		APLX133ABG
		(For Australia)		APLX133ACG
AP-4	P.C.B. Assembly, System Bus		AX-9442	APLX134AAG
	P.C.B. Assembly, LED	**************************************	AX-9443	APLX135AAG
APS-1	Power Supply Assembly	(For USA and Canada)		AELX11*101
		(For UK)		AELX11*102
		(For Belgium)		AELX11*103
		(For Australia)		AELX11*104
ACN-4	Cords with Connectors, for F		AW-3183	ACCND55GEA
ACN-5	Cords with Connectors, for F	1	AW-3184	ACCND94GEA
ACN-6	Cords with Connectors,	(For USA and Canada)	AW-3185	ACCND57GEA
		(For UK, Belgium and Australia)		ACCNG99GEA
ACN-7	Cords with Connectors, for F		AW-3186	ACCND58GEA
FD-1	Floppy Disk Assembly, FB-5	01-ST	AXX-5042	AXFP004GEA
1	Front Panel Assembly, Ivory		AZ-7100	AMX11*1001
1-(1)	Plate, Model		AHC-2395	MVMX11*102
1-(2)	Board, Blind, Black			VB751SB001
1-(3)	Panel, Front, Ivory			VB873SH003
2	Plate, Bottom			AMX11*1002
3	Foot, Rubber		AF-0369	VM283SB001
4	Case, Top, Ivory		AZ-7101	MB887SM008
5	Support, Floppy Disk-Right			ML772\$Z001
6	Support, Floppy Disk-Left	/= \\ \	. = =	ML772SZ002
7	Panel, Back, Ivory	(For USA and Canada)	AZ-7102	MS872SM002
		(For UK and Belgium)		MS872SM003
0	Dieta Carial Niverbay	(For Australia)		MS872SM004
8	Plate, Serial, Number	(For USA and Canada)		MVSX11*102
		(For UK)		MVSX11*104
		(For Belgium) (For Australia)		MVSX11+105
9	Label, FCC	(USA Version Only)		MVSX11*106
10	Label, Caution	(USA Version Only)		KLX11*1001
11	Label, Warning			##E4388*** KLX11*1003
12	Cable Clamper, for Drive #1 S	Signal Cable	V FIC 3308	!
B-1	!	M3 x 6, S-Ni	AHC-2396	VX662NB001
B-2		M3 x 10, S-ZnCr	AHD-2757	BSPB3006NN
B-3	Screw, Truss Head, Machine,		AHD-2758	BSPN3010NZ BSPT4008NN
B-4		M3 x 6, S-ZnCr	AHD-2758 AHD-2759	BSPN3006NZ
B-5		M3 x 6, S-ZnCr	MHD-2755	BSP43006NZ
		M4 x 6, S-ZnCr	AHD-2756	BSP44006NZ
B-6		M3 x 6, S-ZnCr	AHD-2760	BTPP3006AZ
B-6 B-7	Screw, Bind Head with Outsid	· · · · · · · · · · · · · · · · · · ·	AHD-2754	BSP#3006NZ
B-7	i	M3 x 6, S-ZnCr	7.110 2704	DG: #300GIVZ
	İ			BSP43012NZ
B-7		M3 x 12, S-ZnCr		: BSP43HTZMZ

Ref. No.	Descript	Description		Mfr's Part No.
ACCESSO	RIES			
	Cords with Connectors, for S I.C. Socket, for System Bus, System Diskette, for Model 100 Cover, ROM, for Model 100 CRT Cable Switch Box		AW-3187 AJ-7534	ACCND53GEA YSC40S005Z ZVDM001302 ZVDM001303 VS667SB005 ACPP018GEA ACPP020GEA AXSW012GEA
HARDWA	RE KIT			
	Screw, Bind Head, Machine Screw, Truss Head, Machine Screw, Sems, Machine		AHW-2603806	AYX11*1001
				·

7/P.C.Board Views and Schematic Diagra

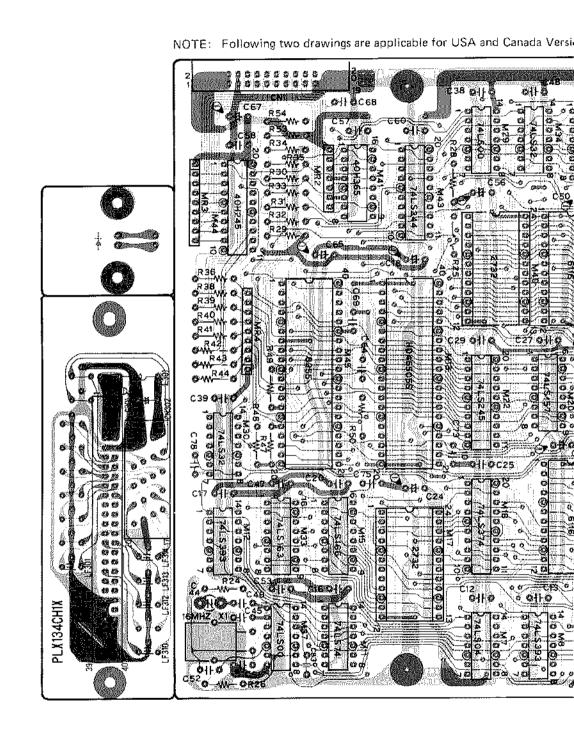
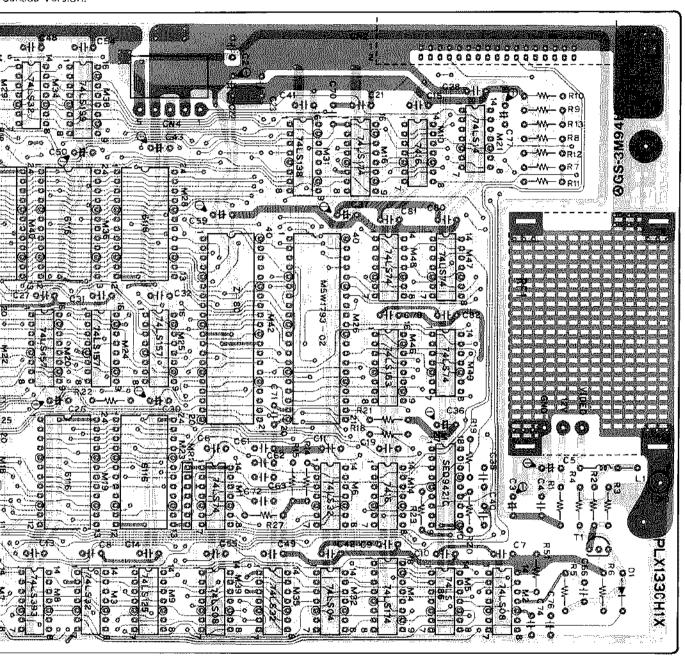


Figure 7-1. Main

agram

Canada Version.



re 7-1. Main P.C. Board (Top View)

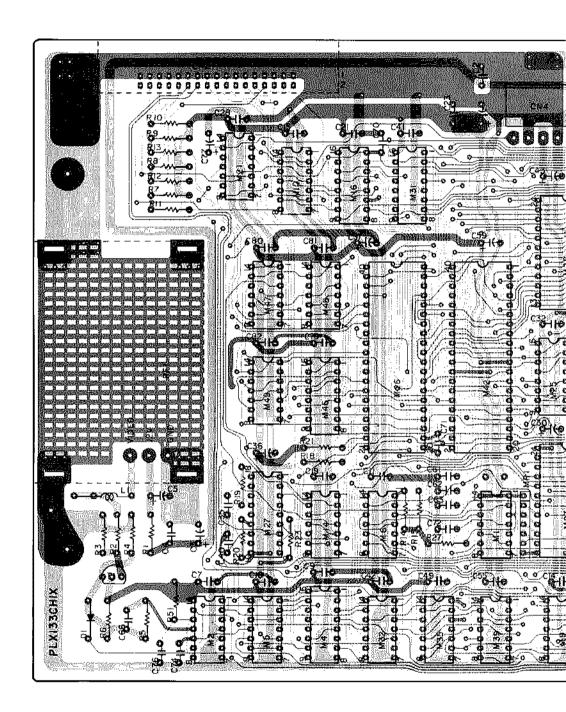
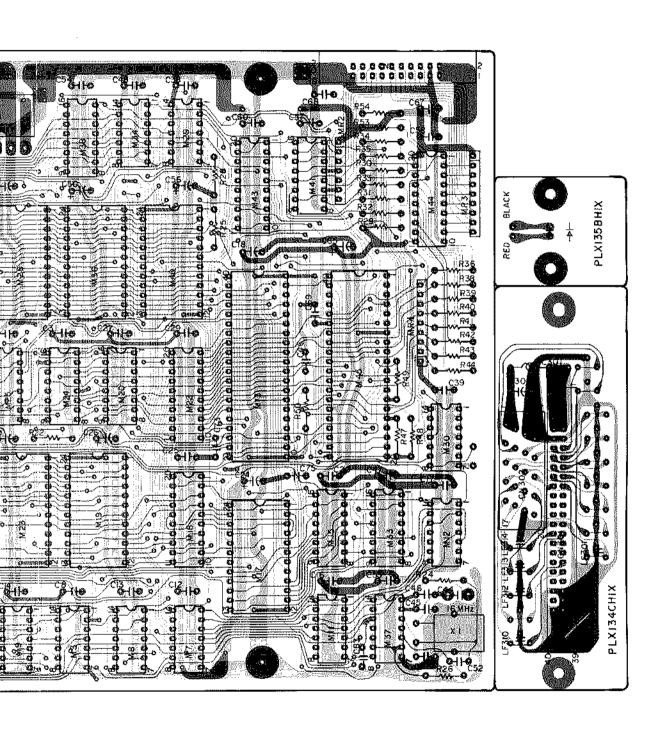


Figure 7-2. Main F



in P.C. Board (Bottom View)

NOTE: Following two drawings are applicable for UK, Belgium and Australia Ver

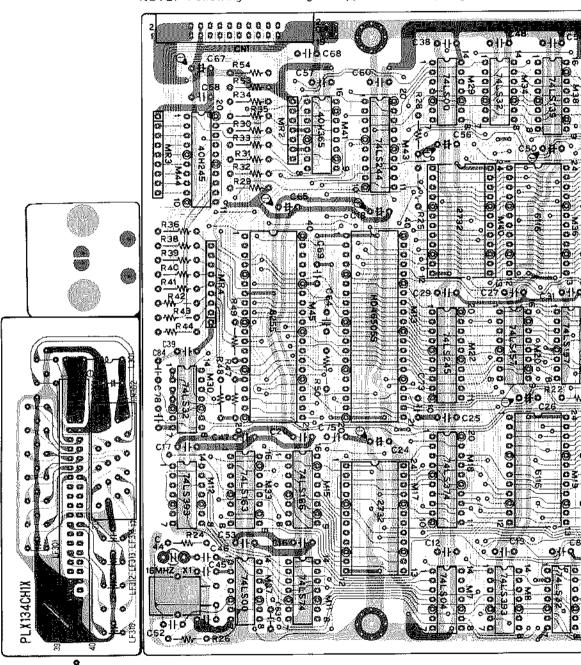
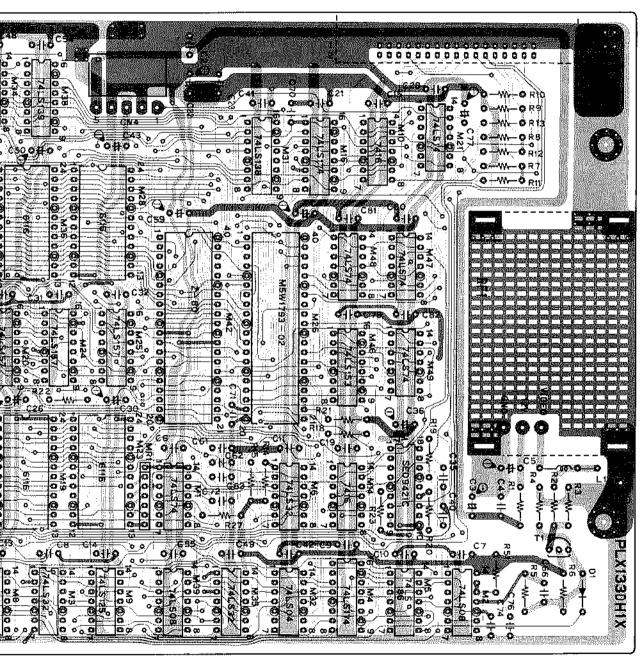


Figure 7-3. Main P.C. Board -

Australia Version.



C. Board Revised (Top View)

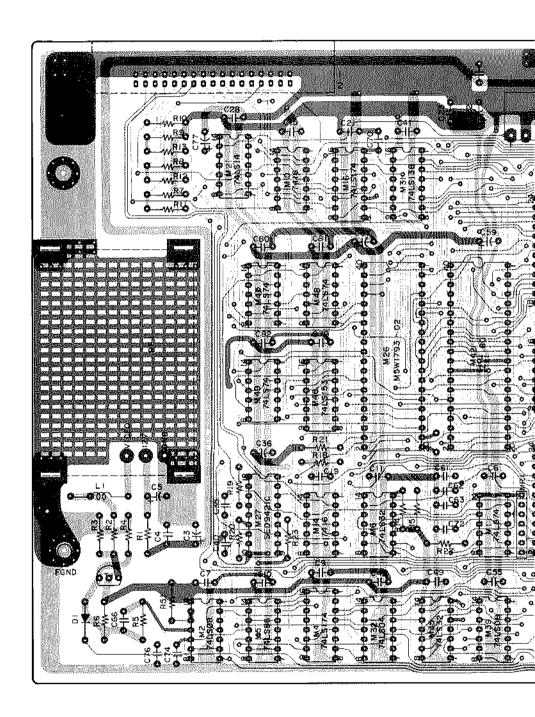
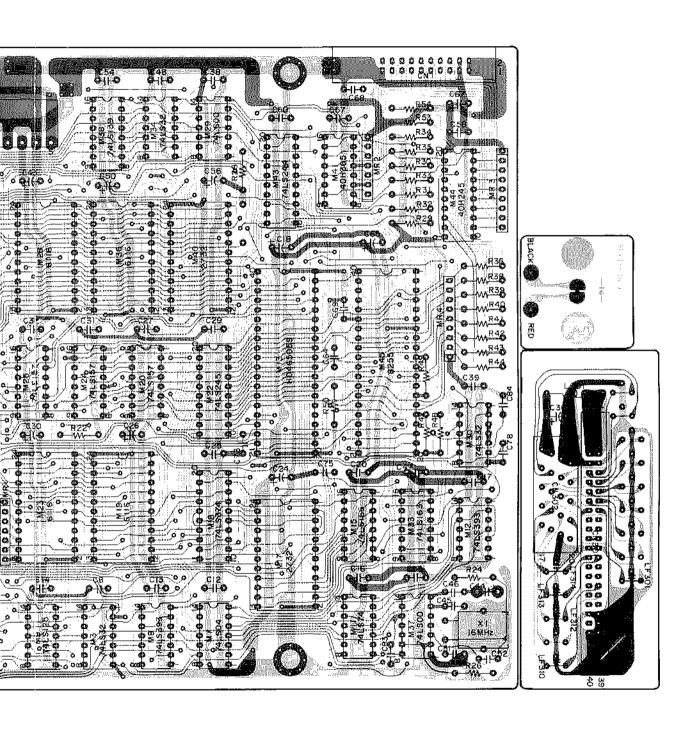


Figure 7-4 Mai



Main P.C. Board — Revised (Bottom View)

Power Supply P.C. Board

Top View Top Vi

Figure 7-5. Power Supply P.C. Board (Top View)

Botton View

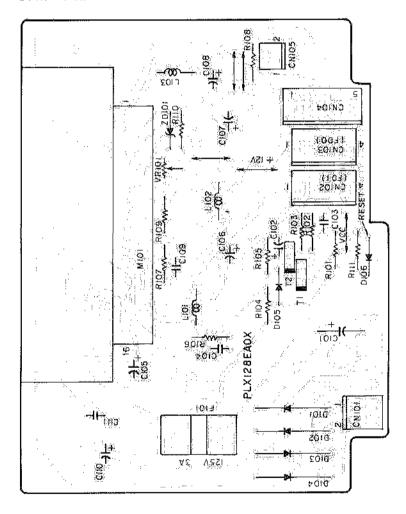
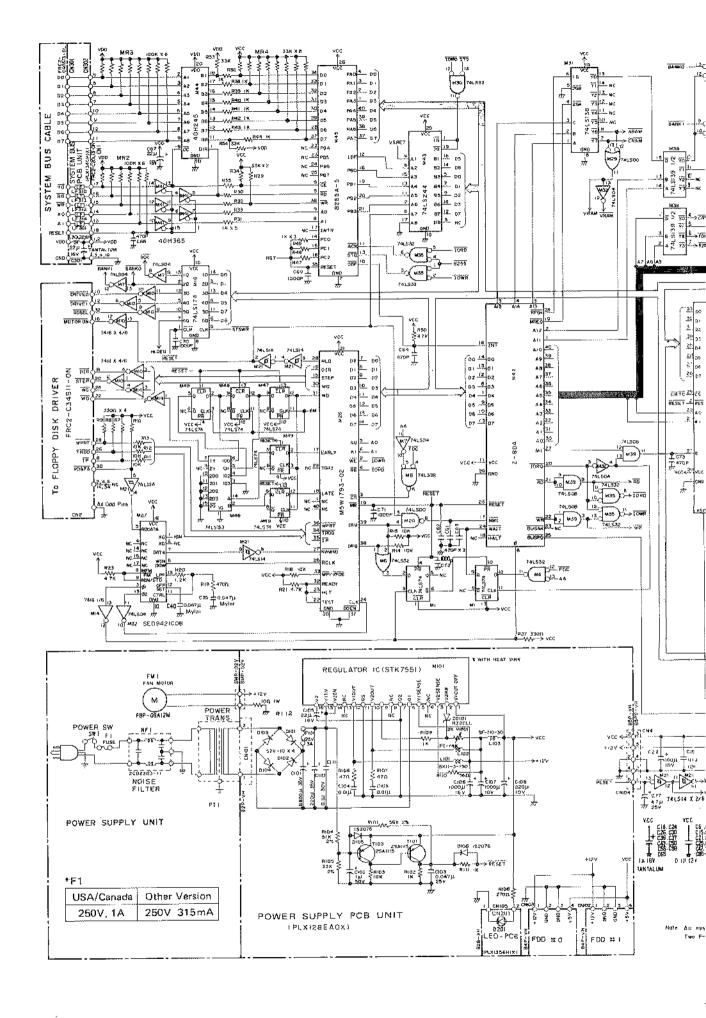
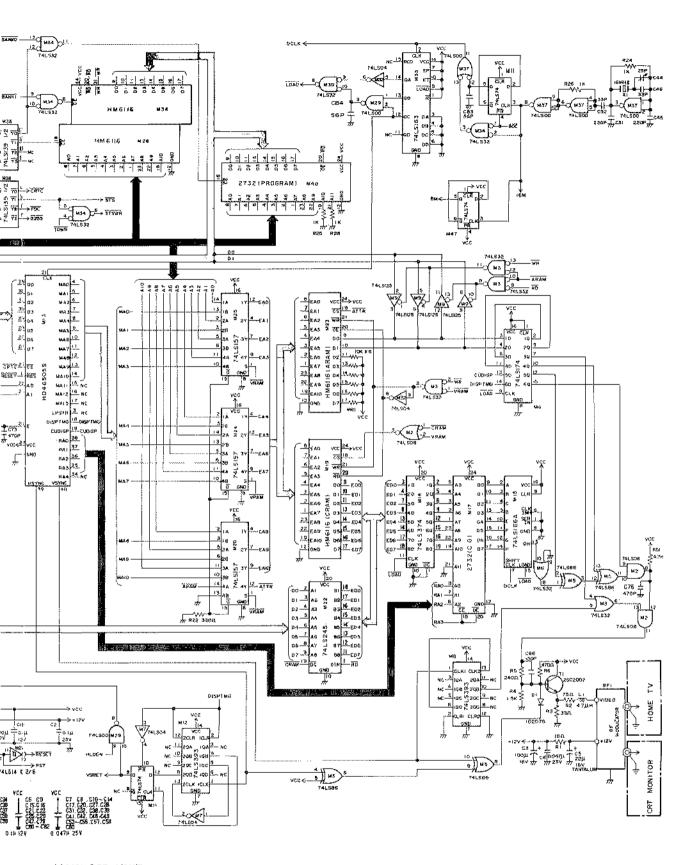


Figure 7-6. Power Supply P.C. Board (Bottom View)





MAIN PCB UNIT

off Air existers denoted one 7/4W 55% aarbon resister Two P-90MS (27324 are with 50 socket

Appendix A/Installation of Additional Disk Drive Unit

Before installing an optional disk drive, check the following two points for that disk drive.

- 1. Is a resistor array disconnected? If not, remove it from the 14-pin IC socket on the printed circuit board.
- 2. Is a terminating socket which determines a drive number inserted into the plug marked "DS1"? If not, remove the socket from the plug and reinsert it correctly.

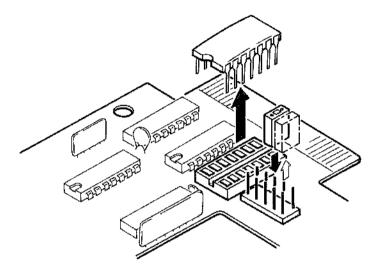


Figure A-1. Preparation on P.C.B. of FDD

Installation of the additional disk drive is as follows.

- 1. Remove the optional drive cover from the front panel with a thin blade knife.
- 2. Remove five screws (A) securing the ivory back cover and lift it away from the unit.
- 3. Fully insert the additional disk drive into the opening on the front panel and secure it with four $3\phi \times 6$ mm screws (B) from the bottom of the unit.

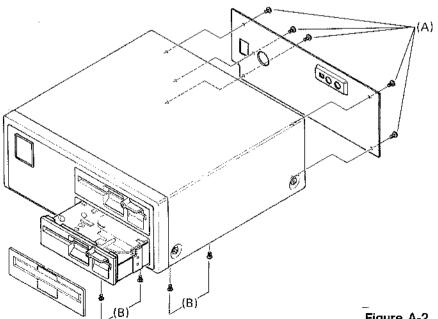


Figure A-2. Installation of FDD

4. Connect the power supply cables (ACN-5) to the connector on the disk drive and connect the FD signal cables (FD-1). These cables are already prepared inside the unit.

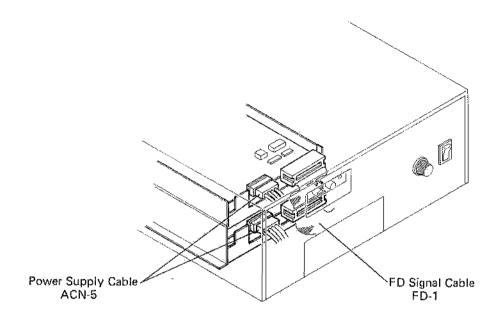


Figure A-3. Cable Connections

Appendix B/Connector Pin Assignments

System Bus Connector Pin Assignments

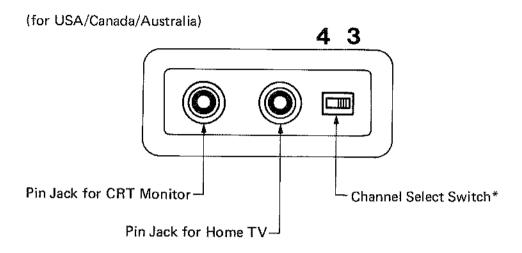
Pin No. Symbol		Description		
1	VDD	+5V Power supply from TRS-80 Model 100		
2	VDD	+5V Power supply from TRS-80 Model 100		
3	GND	Logic ground		
4	GND	Logic ground		
5	AD1	Address data signal bit 1		
6	ADφ	Address data signal bit ϕ		
7	AD3	Address data signal bit 3		
8	AD2	Address data signal bit 2		
9	AD5	Address data signal bit 5		
10	AD4	Address data signal bit 4		
11	AD7	Address data signal bit 7		
12	AD6	Address data signal bit 6		
13	A9	Address signal bit 9		
14	A8	Address signal bit 8		
15	A11	Address signal bit 11		
16	A10	Address signal bit 10		
17	A13	Address signal bit 13		
18	A12	Address signal bit 12		
19	A15	Address signal bit 15		
20	A14	Address sígnal bit 14		
21	GND	Lagic ground		
22	GND	Logic ground		
23	WR*	Write enable signal		
24	RD*	Read enable signal		
25	Sφ	Status ϕ signal		
26	10/M*	I/O or Memory signal		
27	S1	Status 1 signal		
28	ALE*	Address latch enable signal		
29	$\overline{Y\phi}$	1/O Controller enable signal		
30	CLK	2.54MHz Clock signal		
31	RESET*	TRS-80 Model 100 reset signal		
32	(A)*	Memory or I/O access enable signal		
3 3	INTA	Interrupt acknowledge signal		
34	INTR	Interrupt request signal		
35	GND	Logic ground		
36	GND	Logic ground		
37	NC	No connection		
38	RAM RST	TRS-80 Model 100 RAM reset signal		
39	NC	No connection		
40	NC	No connection		

Table B-1. System Bus Connector Pin Assignments



Figure B-1. System BUS Connector

RF Modulator



* Channel 2 and 1 for Australia version.

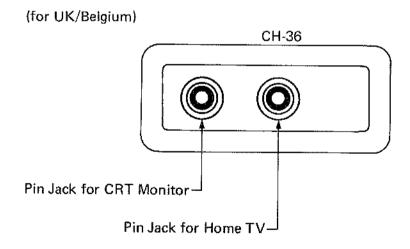


Figure B-2. RF Modulator

Appendix C/Servicing the Expansion FDD Unit

Part 1 Mechanical Section

1-1 Installation and Removal of Components

1-1-1 P.C. Board

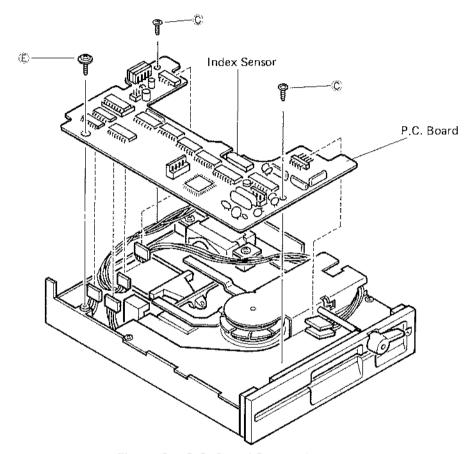


Figure C-1. P.C. Board Removal

To remove P.C. Board:

- (1) Remove the three set screws (© and ©) retaining the P.C. board to the base.
- (2) Detach all the connector cables (Head, Step Motor, DD Motor, Zero Track Sensor).

To install the P.C. Board:

- Attach the connector cables to the P.C. Board.
 Make sure that the connector cables are properly routed.
- (2) Tighten the three set screws of the P.C. board.
- (3) The write protector and index sensor are directly mounted on the P.C. board. The write protector requires no adjustment while it is necessary to adjust the index sensor whenever it is mounted on the P.C. board. The index sensor should be adjusted by referring to page C-7.

1-1-2 Clamp Base BK and Clamp Arm K

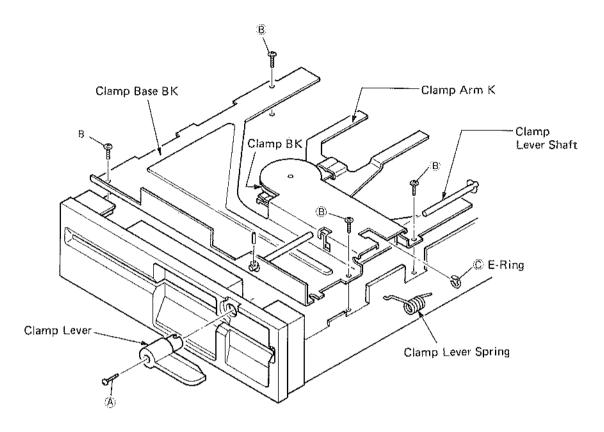


Figure C-2. Clamp Base BK and Clamp Arm K Removals

- (1) Remove the P.C. board by referring to section 1-1-1 (page C-1).
- (2) Remove the set screw (a) retaining the clamp lever, and pull out the clamp lever from the shaft.
- (3) Remove the four set screws (B) retaining clamp base BK.
- (4) Pull out the clamp lever shaft by removing the E-ring @ and clamp lever spring.
- (5) In the above procedure, clamp arm K is separated clamp from base BK.
- (6) Clamp BK can be removed by separating clamp base BK from the base and pushing down the clamp arm.
- (7) Follow the above procedure in reverse for re-assembly.

1-1-3 Carrier BK

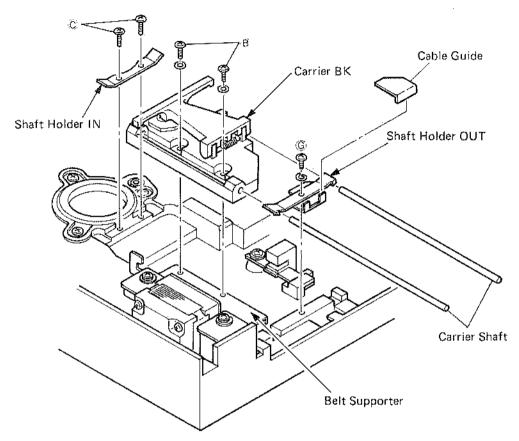


Figure C-3. Carrier BK Removal

- (1) Remove the P.C. board by referring to section 1-1-1 (page C-1).
- (2) Remove clamp base BK by referring to section 1-1-2 (page C-2).
- (3) Remove the two screws (3) connecting the belt supporter to carrier.
- (4) Remove the head cable.
- (5) Remove the set screws (© and ©) of shaft holders OUT and IN, and remove the shaft holders OUT and IN.
- (6) Remove both carrier shafts.
- (7) When re-mounting the carrier, the adjustment required (see page C-11) must be performed.
- (8) Follow the above procedure in reverse for re-assembly.

1-1-4 Pulse Motor BK

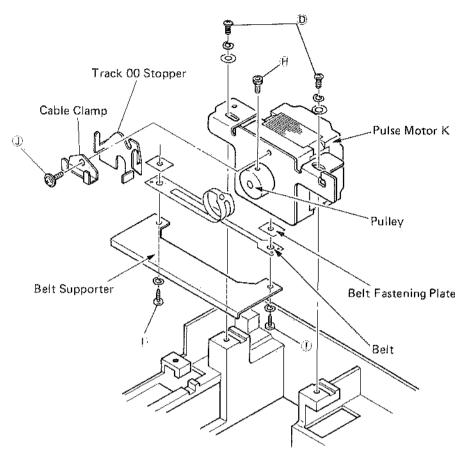


Figure C-4. Pulse Motor BK Removal

- (1) Remove carrier BK from the base by referring to section 1-1-3 (page C-3).
- (2) Remove the screws (b) positioning and retaining pulse motor K.
- (3) Remove the set screws ① of the belt supporter.
- (4) Remove the pulley set screw (1) of the pulley, which is retaining the belt.
- (5) Follow the above procedure in reverse for re-assembly, after adjusting the steel belt tension. (see page C-8)

1-1-5 Spindle Motor K

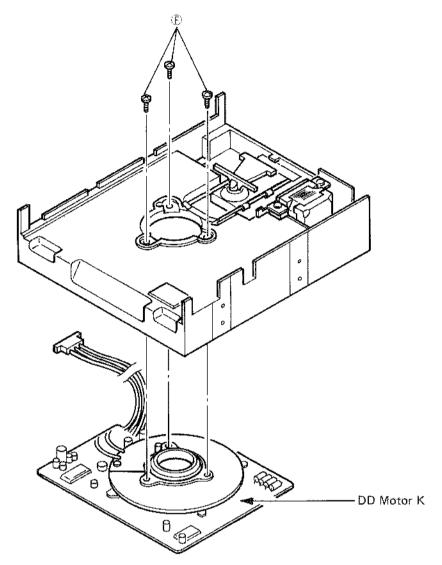


Figure C-5. Spindle Motor K Removal

- (1) Remove the P.C. board by referring to section 1-1-1 (page C-1).
- (2) Remove clamp base BK by referring to section 1-1-2 (page C-2).
- (3) Remove the three set screws (a) holding the spindle.
- (4) Follow the above procedure in reverse for re-assembly.

1-1-6 Track Sensor

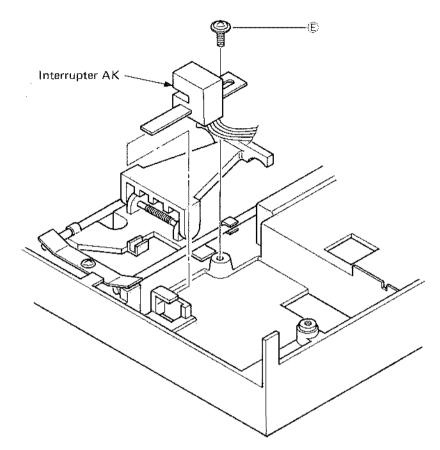


Figure C-6. Track Sensor Removal

- (1) Remove the P.C. board by referring to section 1-1-1 (page C-1).
- (2) Remove the positioning set screw @ of interrupter AK.
- (3) Remove the interrupter,
- (4) Temporarily tighten the positioning sat screw when mounting the interrupter.
- (5) Perform the Track 00 adjustment in Page C-13

1-2 Adjustment

1-2-1 Index Sensor Adjustment

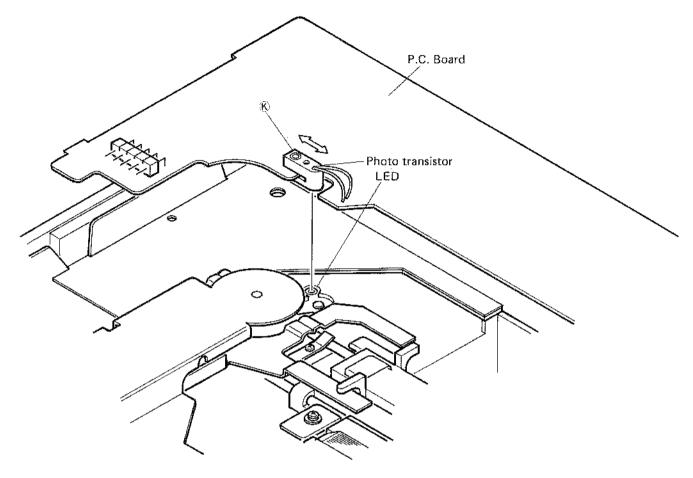


Figure C-7. Index Sensor Adjustment

- (1) The index sensor optically detects the index hole of the disk.
- (2) Adjust the index sensor in the following manner.
 - a. The LED of the index sensor is built in the DD motor K, thus, it cannot be adjusted in position.
 - b. The photo transistor is adjusted by loosening the socket screw 🚯 ,
 - Use an alignment diskette. The alignment diskette usually stores the index burst signal on two tracks, the outer track and inner track.
 - d. Connect the CH1 probe of the oscilloscope to pin 4 of TP-2, and the CH2 probe to pin 3 or 4 of TP-1. Connect the GND to pin 2 of TP-1 or pin 5 of TP-2.

(CH level: 40 mV/div. d.c., time base: 50 µs/div.)

e. The index burst signal appears as follows:

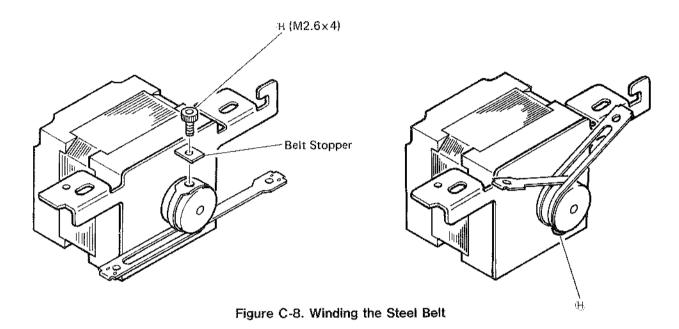
Outer Track: Within 200 μ s \pm 100 μ s Inner Track: Within above \pm 50 μ s

f. Move and adjust the transistor in position to meet the above values.

1-2-2 Tensioning and Adjustment of Steel Belt

- (1) Leave the pulse motor K only by referring to the section on pulse motor BK removal (page C-4).
- (2) Wind the steel belt on the pulley as shown in the left figure below, and temporarily fix it with the belt stopper and mounting screw (#). Manually turn the pulley until the mounting screw (#) faces downward as shown in the right figure below.

Caution: Be sure to wear gloves when touching the steel belt.



(3) Put the right and left ends of the steel belt between the belt supporter and belt holder plate as shown in the figure below, and temporarily fix them with the mounting screws ① (2 pcs).

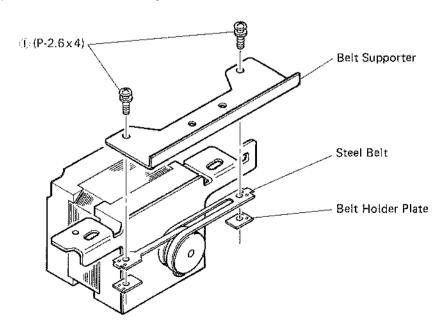
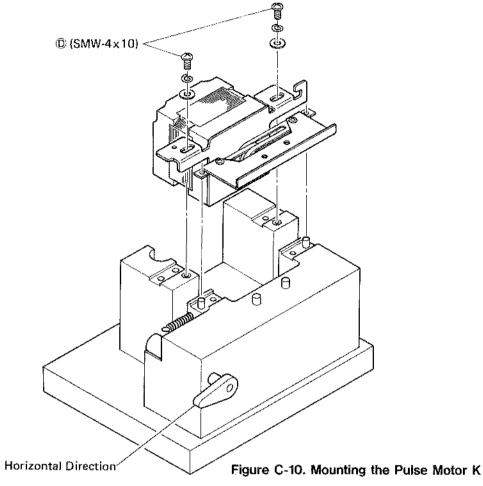


Figure C-9. Mounting the Belt Supporter

(4) Turn the lever of the jig until it is set horizontal as shown in the figure below. Then place the pulse motor K on the jig, allow the jig pins to be inserted into the right and left holes in the steel belt, and mount the pulse motor K on the jig with the mounting screws (1) (2 pcs).



(5) Turn the lever of the jig until it is set vertical to tension the belt, and tighten the mounting screws () (2 pcs).

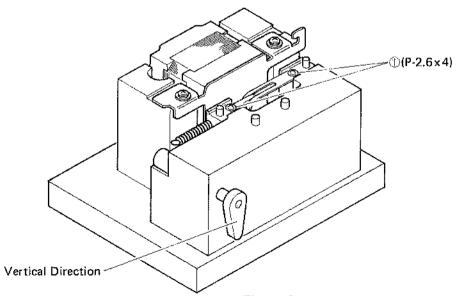


Figure C-11. Tensioning the Belt

- (6) Turn the lever of the jig until it is set horizontal again. Then remove the mounting screws (5) (2 pcs), and remove the pulse motor K from the jig.
- (7) Tighten the mounting screw (f). Check that the steel belt gaps (f) and (f) are uniform when the belt supporter is slided horizontally to the right or left.

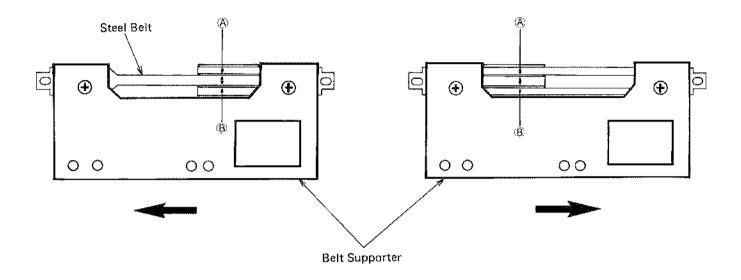


Figure C-12. Confirmation of the Belt Gaps

(8) Manually turn the pulley until the mounting screw \oplus faces upward. Temporarily fix the track 00 stopper with the mounting screw \oplus .

Finally, tighten the nut and spring washer in the original state.

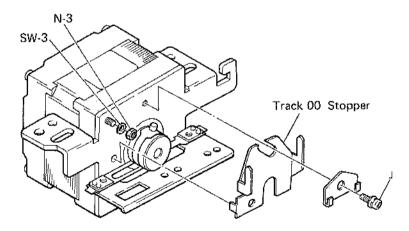


Figure C-13. Fixing the Track 00 Stopper

1-2-3 Head/Radial Adjustment (CE Adjustment)

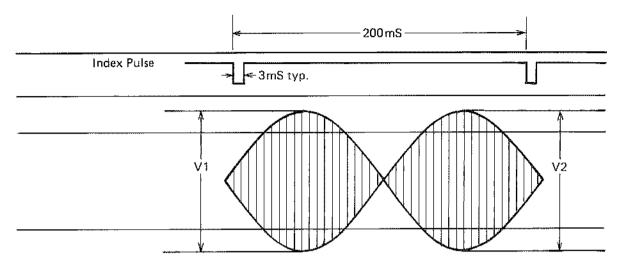


Figure C-14. Waveform of Index Pulse

(1) Measure and adjust the reproduced signal waveform of track 16 of an alignment disk.

Set the switches on oscilloscope as follows:

CH Level: 50 mV/div. DC Time Base: 20 mS/div.

At this time, observe the waveform by moving the carrier from outer side and inner side.

- (2) Obtain the waveform shown above.
- (3) Externally trigger the fall of the index signal of pin 4 of TP-2.

The waveform should be stationary.

- (4) Connect CH1 to pin 3 of TP-1, and CH2 to pin 4 of TP-1, and GND to pin 2 of TP-1 or pin 5 of TP-2.
- (5) A temperature and humidity correction table is provided for the alignment disk in each manufacturer. Adjust the measured value according to the table.

Measurement Reference

 $100\% \ge (V1/V2 \text{ or } V2/V1) \times 100\% \ge 85\%$

Adjust to obtain the result of either of the above expressions.

Adjustment Points

Make adjustments by moving the pulse motor to the right or left.

1-2-4 Head Output Check

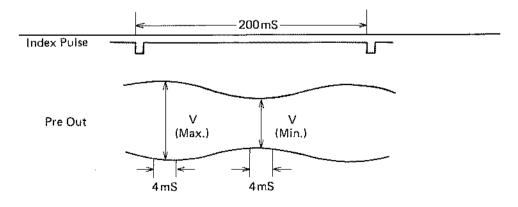


Figure C-15. Waveform of Head Output

Follow the procedure below to adjust the head output,

- (1) Use a disk which is normal and erased enough to detect any fault in the head.
- (2) Start the motor.
- (3) Write 2F signals on track 00 and track 39, and reproduce them. Read the reproduced signal waveforms with the synchroscope.
- (4) Obtain the waveform shown above.Use a synchroscope with two channels and an external trigger function,
- (5) Connect the external trigger to pin 4 of TP-2 (5V/div., d.c.), and synchronize on the fall of the signal. Connect other channels 1 and 2 to pin 3 of TP-1 and pin 4 of TP-1 as the ground for each probe.
 Set to ADD mode, set either pin 3 or 4 of TP-1 to INVERT, and set the time base at 20 ms/vis. Measure the average value of an area of at least 4 milliseconds as shown in Figure C-15.
- (6) The adjustment criteria is 650/420 mVp-p with the 2F signal on track 39.
- (7) Modulation: M $M \le 10\% \qquad M = \left(\frac{Vmax. Vmin.}{Vmax. + Vmin.}\right) \times 100\%$

1-2-5 Motor Speed Check

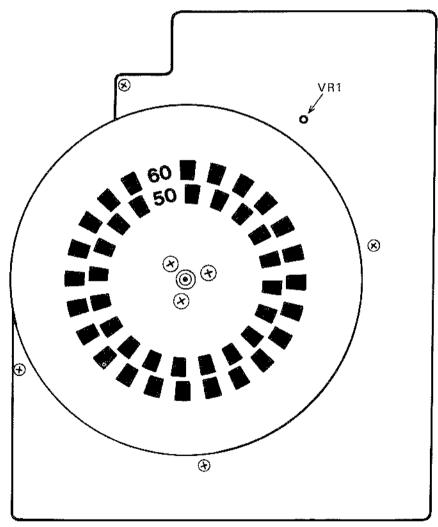


Figure C-16. Motor Speed Adjustment

- (1) Insert the media after the motor ON signal is input.
- (2) Adjust VR1 on the DD motor control PC board so that the black stripe of the stroboscope of the DD motor looks stationary under a 50-Hz or 60-Hz-fluorescent lamp.

 The DD motor used is shown in Figure C-16.

1-2-6 Track 00 Adjustment

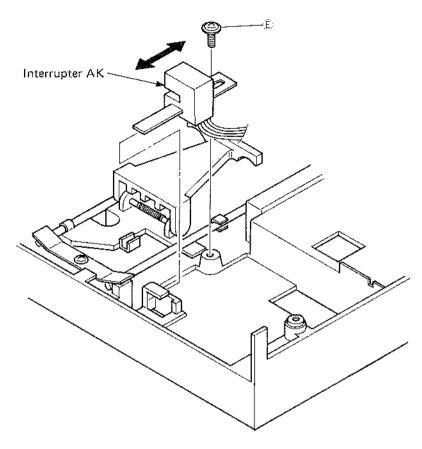


Figure C-17. Track 00 Adjustment

- (1) Make this adjustment after the CE is adjusted.
- (2) Point to which Probes are connected:

Connect CH-2 to pin 1 of TP-2, and CH-1 to pin 2 of TP-2.

Pin 4 of TP-1 is connected to GND. The rise of the STEP signal emitted from pin 1 of TP-2 is synchronized.

(3) Set the oscilloscope as following condition:

Mode set to chop

Volts set to 2V/div.

Time set to 1 mS/div.

(4) Connect an exerciser to the FDD unit.

Set the exerciser to generate STEP pulses at 6 mS rate to allow the carrier to continuously move between track 0 and track 2. (The timer for ST motor reverse should be 21 mS minimum.)

(5) Loosen the Interrupter AK fixing Screw (E), and position the interrupter until the below waveforms are obtained. After adjustment, tighten the fixing screw (E).

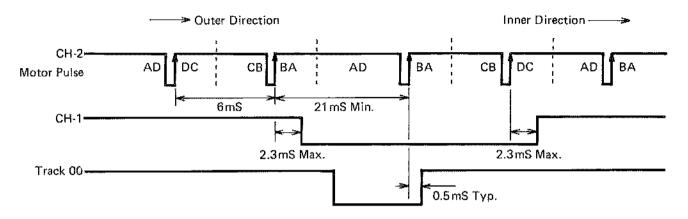


Figure C-18. Interrupter Timing Chart

1-3 Special Maintenance Tools

The following special tools are used for maintenance.

Name

Oscilloscope

30 MHz

Simulator

(Example: BRIKON)

DC power supply

+12V, +5V

Alignment Diskette

Flat-blade Screwdriver

Exerciser

1-4 Maintenance

1-4-1 Procedure for Cleaning the Read/Write Head

Only the floppy disk head cannot be replaced, since it is completely bonded to the carrier.

The had should be cleaned when dust and dirt particles are found.

Note that any other cleaning method than the one described below may cause damage to the head.

- (1) Slightly dampen and cotton swab with isopropyl alcohol.
- (2) Part the load arm from the head without touching the load button.
- (3) Softly wipe the head with the dampened part of the cotton swab.
- (4) After the alcohol has fully evaporated, softly polish the head with a clean cotton swab.
- (5) Place the load arm on the head. At this time, extreme caution should be exercised to avoid shocks to the head.

1-4-2 Caution on Handling Disks

- (1) Avoid directly touching the Mylar*.
- (2) Avoid storing disks in locations with high temperature or high humidity.
- (3) Always ensure that the disk is inserted properly.
- (4) Avoid magnetic fields (i.e., AC motors, magnetics, etc.)
- (5) Do not bend the disk.

^{*} Mylar is a registered trademark of E.I. Du Pont de Nemours and Company.

Part 2 Electrical Section

2-1 General Description

This circuit uses two independent LSIs: the LSI that controls the signals from the pulse motor, DD motor, and the sensors: and the LSI for the read circuit — thus, realizing an increase in packaging density, compaction of the unit, powersaving and improved reliability.

2-2 Block Diagram

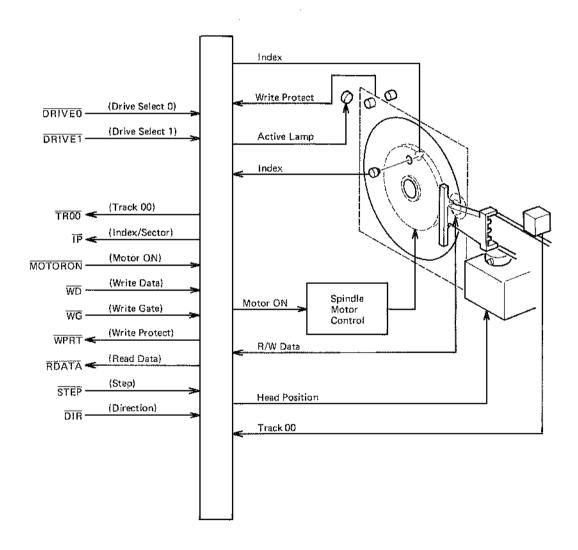


Figure C-19. Block Diagram

2-3 Electrical Diagram

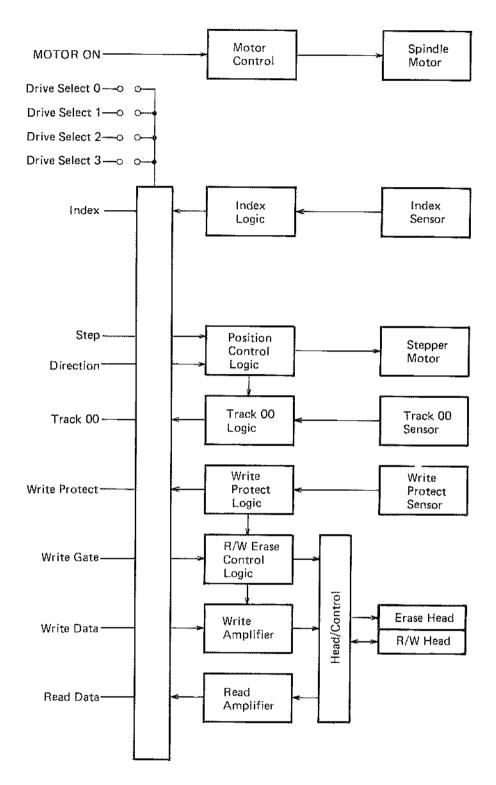


Figure C-20. Electrical Diagram

2-4 Independent LSI Configuration

2-4-1 Control LSI and Pin Names

Provided with the same functions as a custom one-chip LSI, this independent LSI is designed considering the hard timing required by the flexible disk drive (hereinafter referred to as FDD).

The package is compact and operated from a single +5V supply. All the pins are TTL-compatible. This LSI mainly controls the logic system.

Pin Configuration

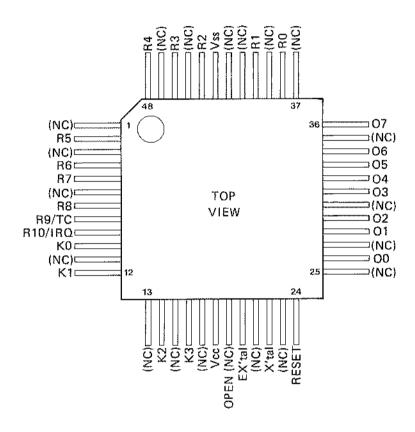


Figure C-21. Pin Configration of Control LSI

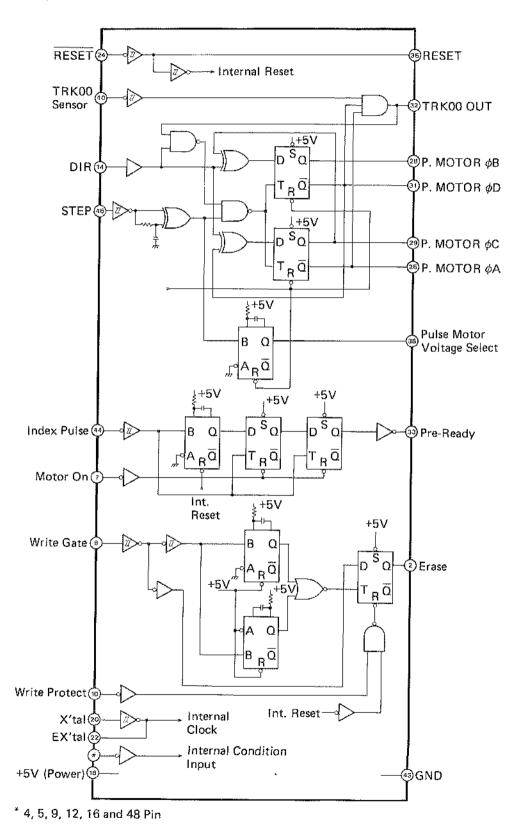


Figure C-22. Block Diagram of Control LSI

Pin Names

Pin Number	Pin Name	Pin Function
2	R5	Erase Gate
5	R7	Write Gate Signal Start and End Judgement
7	R8	External Motor Rotation
8	R9	Write Gate
9	R10	Write Gate Edge
10	К0	Write Protect
14	K2	Direction
16	К3	Side One Select
18	vcc	+5V
20	EX'tal	Terminals for External Crystal
22	X'tal	
24	RESET	Reset
26	00	Pulse Motor Phase A
28	01	Pulse Motor Phase B
29	02	Pulse Motor Phase C
31	03	Pulse Motor Phase D
32	04	Track 00 External Output
33	05	Ready
36	07	Soft Reset
38	RO	Pulse Motor Voltage Select
40	R1	Track 00 Position
43	VSS	GND
44	R2	Index
46	R3	Step

Table C-1. Pin Assignments of Control LSI

2-4-2 Read LSI Configuration and Pin Names

This LSI is a monolithic read amplifier that outputs signals recorded on the floppy disk in the form of digital signals. The LSI amplifies signals from the magnetic head and passes them through the filter. Then, it passes them through the differentiator, zero volt comparator and waveform shaper to obtain pulse outputs.

Floppy Disk read processing is performed by one IC. The output can be directly connected to a TTL device.

Pin Configuration

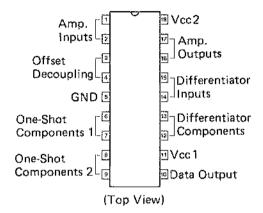


Figure C-23. Pin Configuration of Read LSI

Block Diagram

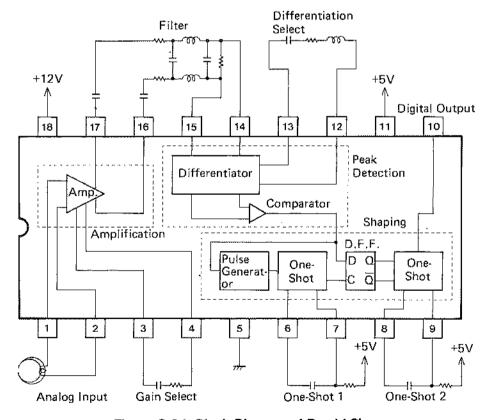


Figure C-24. Block Diagram of Read LSI

2-5 Input Signal Lines (CPU to FDD)

2-5-1 Drive Select Circuit and Indicator LED on Circuit

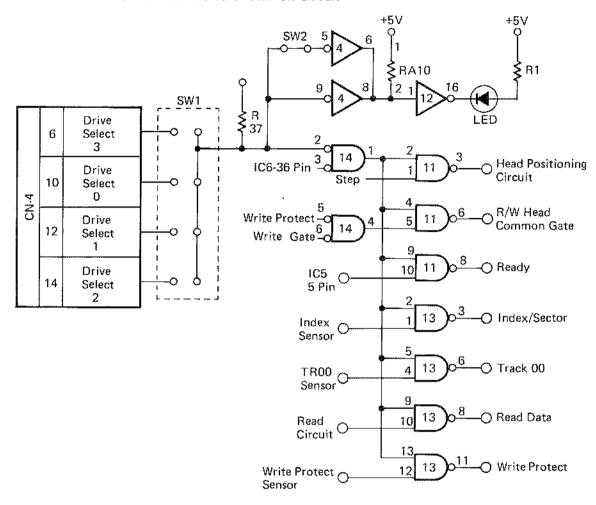


Figure C-25. Block Diagram of Drive Select Circuit

The drive select circuit and indicator LED on circuit are configured as shown above.

When one of these four signal lines, drive selects 0 to 3, is at "low" level, the drive corresponding to the low signal line responds to other input lines and the gates of the output signal lines of the drive open. Which one of the drive selects, 0 to 3, the drive corresponds to is selected by inserting a shorting pin of SW1. Up to four drives are controllable. When the drive select signal is low, the LED will turn on.

2-5-2 Side Select Circuit

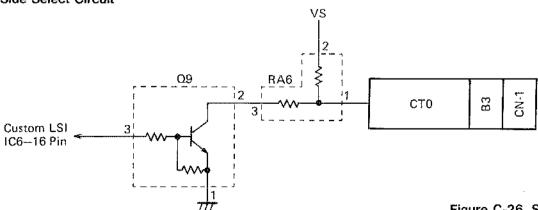


Figure C-26. Side Select Circuit

This circuit is used to select the head, but actually not used on 26-3806/3807 since the unit uses single side head and side 0 is automatically selected.

2-5-3 Head Positioning Circuit

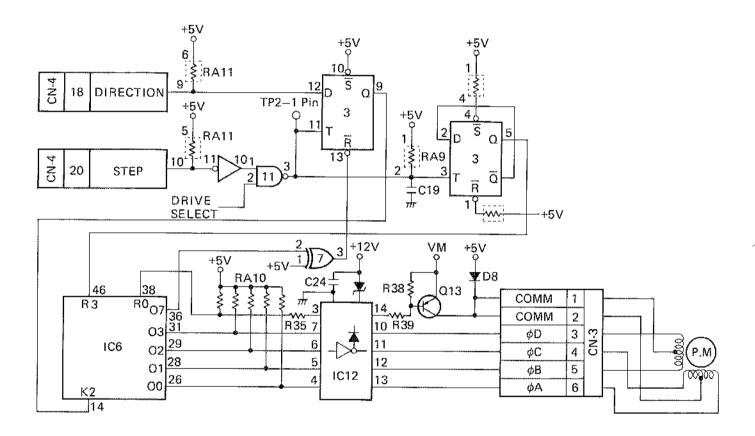


Figure C-27. Head Positioning Circuit

The head positioning circuit is configured as shown above. This circuit is used to move the head using step pulses, after the head stepping direction (inner or outer direction) is determined by the Direction signal. When the Direction signal from the host computer goes low and a step pulse signal is input, the head steps one track in the inner direction. When the Direction signal goes high, the head steps in the outer direction.

R38, R39 and Q13 in the circuit are used to drop the power when the stepping motor is on standby. To drive the stepping motor, Q13 is turned on by turning pin 38 of IC6 to "high" level and a voltage of 12V is applied to the stepping motor. To leave the motor on standby, Q13 is turned off and about 5V is applied to the stepping motor through D8 to hold the motor.

The timing chart for the Direction signal and Step signal is shown below.

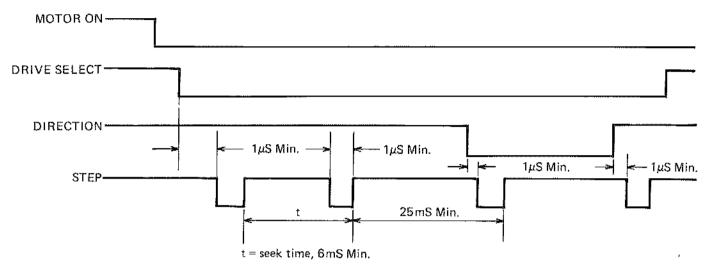


Figure C-28. Timing Chart for the Direction and Step Signal

In writing or reading data, it is necessary to wait for seek + settling time after the final step signal to stabilize the head.

2-5-4 WRITE GATE Signal

When the WRITE GATE input signal line of this circuit is low, the write circuit is made operable. However, writing will not occur, when the WRITE PROTECT output signal line is low (in a write disable state) or the corresponding FDD is not selected by the DRIVE SELECT signal line. When this input signal line is high, the FDD is in the read mode.

2-5-5 WRITE DATA Signal

This input signal line is used to transfer data to be written on the disk. When the FM- or MFM-modulated signal turns from "high" to "low" level, reverse current flows through the head to generate magnetic flux changes in it to write data on the disk. This input signal line is valid only when the WRITE GATE and DRIVE SELECT input signal lines are low and the WRITE PROTECT output signal line is high.

2-5-6 Write Circuit and Erase Circuit

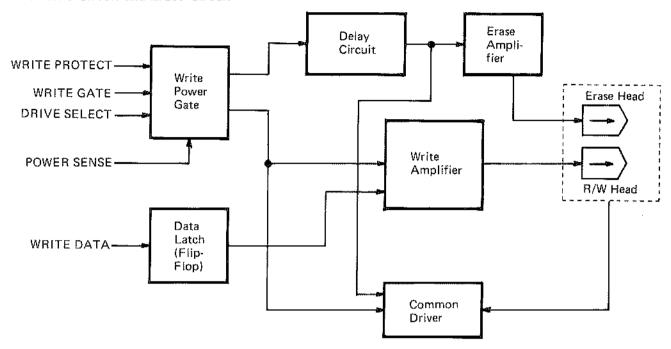


Figure C-29. Write Circuit and Erase Circuit

The block diagram for the write circuit and erase circuit is shown above.

1. Write Circuit

The write data modulated in the FM or MFM system is divided by the data latch (flip-flop) to become a WRITE DATA pulse. The write amplifier output signal becomes a rectangular signal that is inverted by this WRITE DATA pulse.

In other words, the write amplifier inverts the polarity of the head current through this signal to cause the magnetic flux synchronized with the WRITE DATA pulse to be generated in the gap of the read/write head and the media is saturation-magnetized and recorded.

The write power gate opens only when the WRITE PROTECT output signal line is high and the WRITE GATE and DRIVE SELECT input signal lines are low, enabling writing and erasing.

The timing chart for the write circuit is shown below.

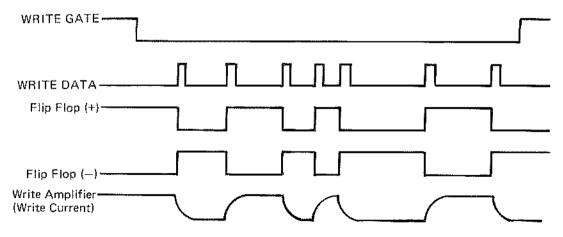


Figure C-30. Timing Chart for Write Circuit

2. Erase Circuit

The timing chart for the erase circuit is shown below.

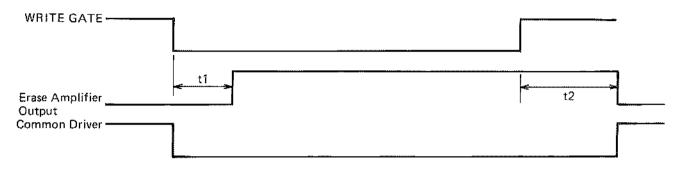


Figure C-31. Timing Chart for Erase Circuit

The tunnel erase system is adopted for this FDD. It consists of a broad-width read/write head followed by a tunnel erase head designed to allow the inner dimension to have the recording information track width. The information once recorded through the read/write head is trimmed at both edges by the tunnel erase head to be shaped to the desired track width. By doing this, even if track divergence occurs, it will not interfere with the adjacent track because the signals for the information track width are efficiently secured by the broad-width read/write head, thus securing the S/N ratio and improving the track density.

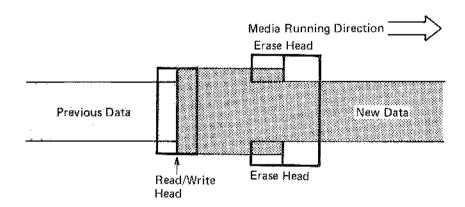


Figure C-32. Data Recording Procedure

For this reason, the erase amplifier output signal rises t1 milliseconds (minimum time required for the location written on the disk by the read/write head to reach the erase head) after the WRITE gate signal turns from "high" to "low" level, causing current to flow through the erase head to perform DC erasing. Then, the erase amplifier output signal falls t2 seconds (maximum value of time difference of above t1) after the completion of writing on the media (when the WRITE GATE signal rises), thereby completing the DC erasing. t1 and t2 seconds are previously-determined by the delay circuit.

2-5-7 MOTOR ON Signal

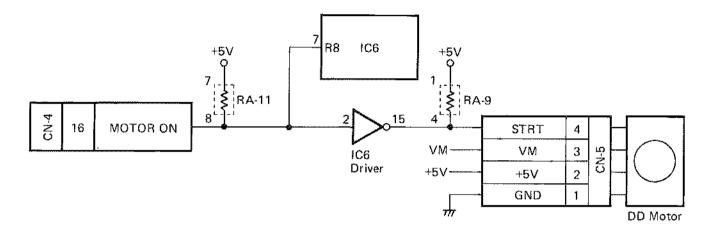


Figure C-33. Motor ON Circuit

A spindle motor drive signal appears on this input signal line.

When the input signal is low, the spindle motor turns. Conversely, when the signal is high, the motor stops.

This signal line responds regardless of the DRIVE SELECT signal. The start-up time for the spindle motor requires 0.5 seconds.

2-6 Output Signal Lines (FDD to CPU)

2-6-1 Index Circuit

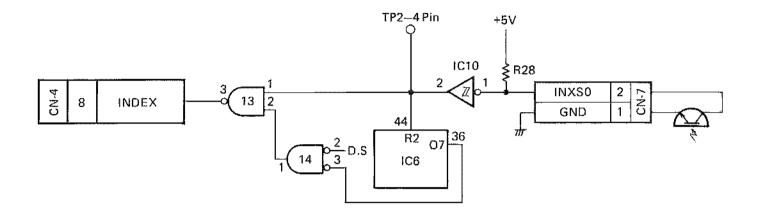


Figure C-34. Index Circuit

The index circuit is configured as shown above.

When the index sensor detects the index hole in the disk, this output signal line goes low indicating the beginning of a track. The waveform of TP2-4 pin, while the media is turning, is shown below.

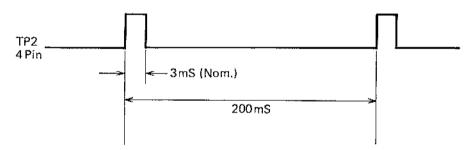


Figure C-35. Waveform of TP2-4Pin

2-6-2 Track 00 Detection Circuit

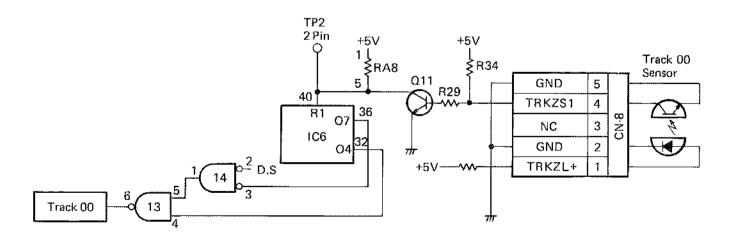


Figure C-36. Track 00 Detection Circuit

The track 00 detection circuit is configured as shown in Figure C-36.

This circuit detects track 00, the outermost track of the disk, through the track 00 sensor, and sends a Track 00 signal to the host computer.

With the stepping motor turning to move the head toward Track 00 (outer side of the disk), the light of the track 00 sensor LED is cut off when the head comes near Track 00, causing the photo-transistor to turn off and pin 40 of IC6 to go low. When the stepping motor reaches phase AD within the range of Track 00, IC6 outputs a "low" level on pin 32 and the external output pin goes low.

07 of IC6 is a Soft Reset pin, and is independent of this circuit. The soft Reset line goes low upon initially resetting the IC6 after power is turned on.

The waveform on test pin TP2-2 pin is shown below.

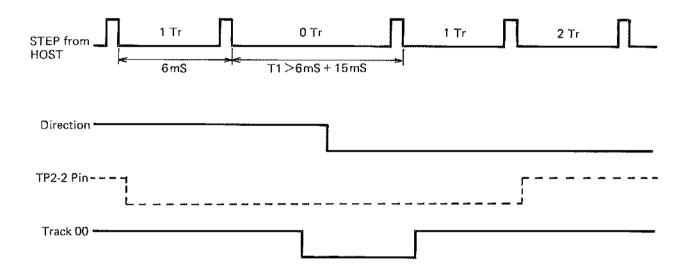


Figure C-37. Waveform on TP2-2 Pin

2-6-3 Write Protect Circuit

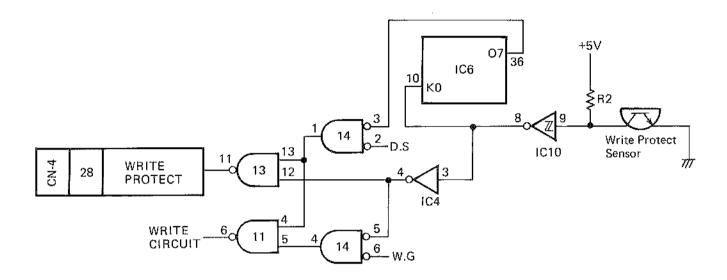


Figure C-38. Write Protect Circuit

This circuit is provided to prevent erroneous erasing of protected data recorded on the disk. The "low" level signal is output when the write enable notch of the disk, inserted into the FDD, is covered with a label, thus disabling writing to the disk. Conversely, when the "high" signal is output, the write enable state is assumed.

2-6-4 Read Amplifier Circuit

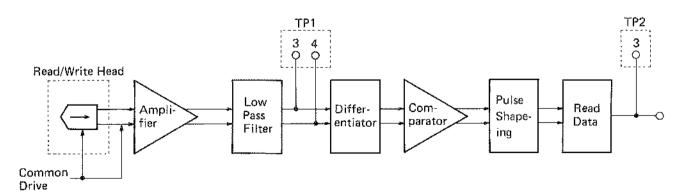


Figure C-39. Read Amplifier Circuit

The block diagram for the read amplifier is shown above.

This circuit picks up data recorded on the media through the magnetic head, and outputs read data close to the recorded signals by amplifying, although it slightly deviates time-wise, identifying, and pulse-shaping the data.

The timing chart for the read amplifier circuit is shown in Figure C-39.

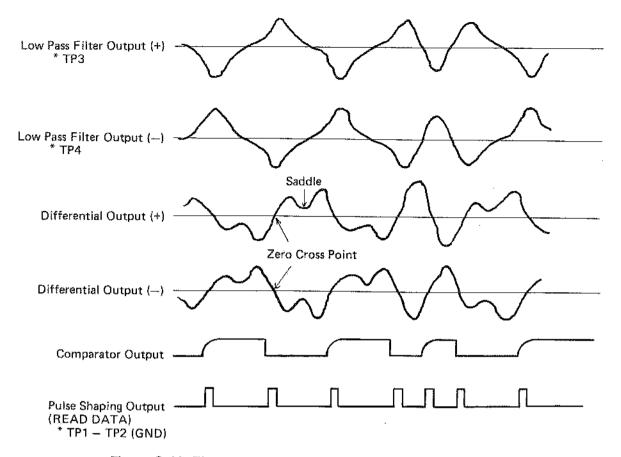
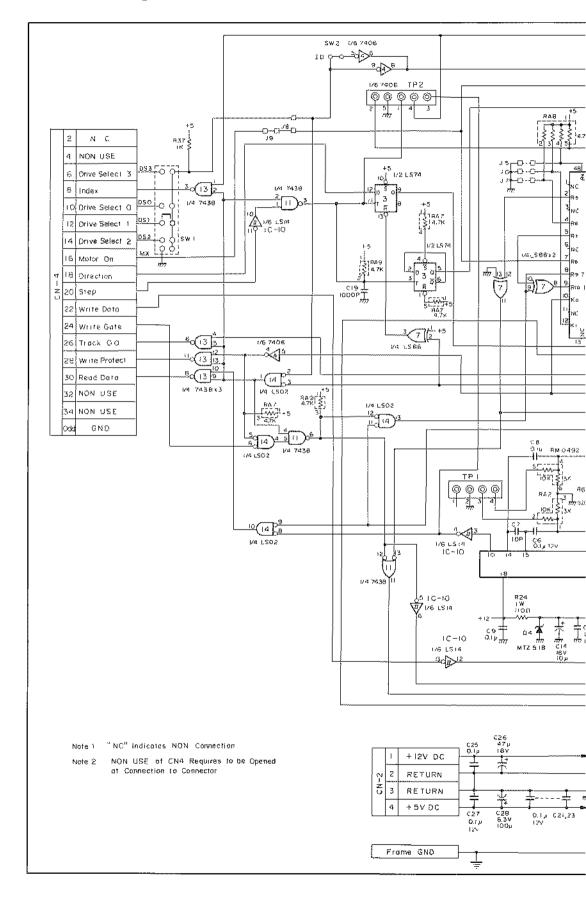
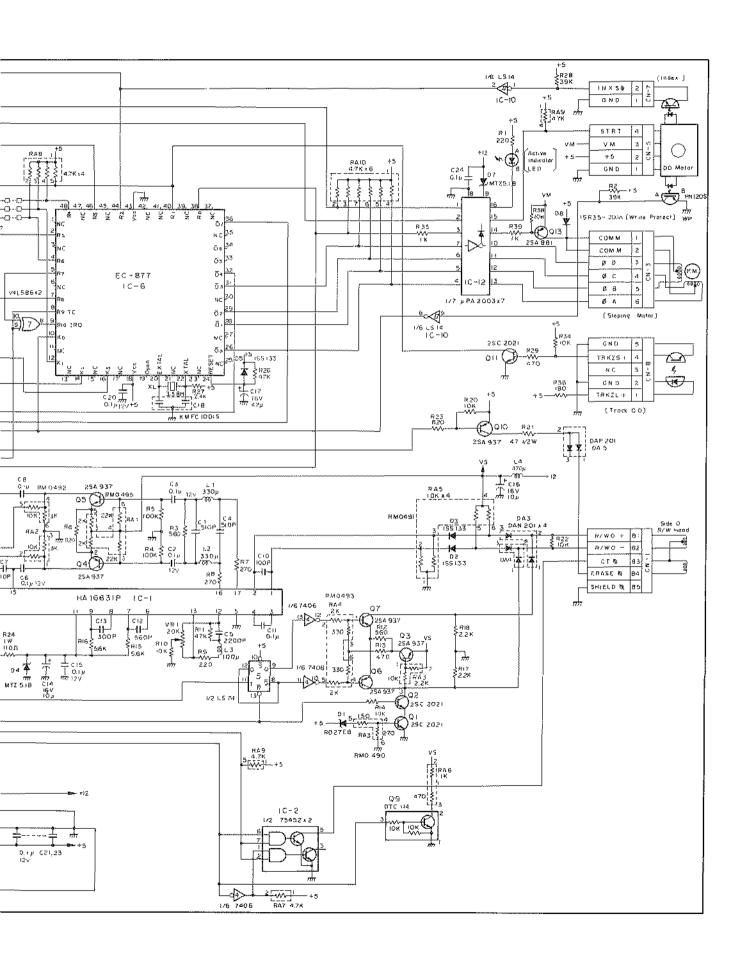


Figure C-40. Timing Chart for Read Amplifier Circuit

Part 3 Circuit Drawing





Part 4 Troubleshooting

4-1 Processing Softerrors

4-1-1 General

The following soft errors are often mistaken for errors caused by troubles or misadjustments of the disk drive.

- Errors caused by improper operational procedure, incorrect programming or damaged disk.
- Software error caused by dust in the air, random electric interference or other external cause.

Unless a defective assembly point or damage point is clearly found in visual inspection, check to see whether the error repeats with the current diskette and also whether the same error is caused with other diskettes,

4-1-2 Detection and Correction and Read Error

Read errors are usually caused by the following conditions:

- (1) Dust between the read/write head and disk; usually dirt resulting from dust is eliminated by the self-cleaning wiper in the diskette.
- (2) Fine track divergence which is not detected during writing.
- (3) Wear of damaged load pad or wear of disk caused by the head.
- (4) Improper grounding of the power supply of the disk drive in the host computer.
- (5) Improper motor speed.

To correct soft errors (1) to (5) above, follow the steps below.

- (1) Re-read the error-occurred track about 10 times.
- (2) If the data is not restored in step 1, allow the head to move to track 00 and make sure that the head is at track 00.
- (3) Move the head to the error-occurred track.
- (4) Repeat step (1).
- (5) Errors which cannot be corrected by repeating the above steps are unrecoverable errors.

4-1-3 Write Error

An error which has occurred during writing is detected during a subsequent reading of the data written.

- (1) To eliminate the error, write and read again.
- (2) If the error still occurs after the above procedure is repeated a few times, perform reading using another track to determine whether the disk or drive is malfunctioning.
- (3) If the error persists, change the disk and perform the above procedure. If the error still persists, the drive is defective.

4-1-4 Seek Error

Possible Cause.

- (1) The pulse motor or pulse motor drive circuit is defective.
- (2) The carriage is defective.

There are two procedures to correct seek errors.

- (1) Readjust the belt tension Refer to page C-8.
- (2) Readjust track 00 Refer to page C-13.

4-1-5 Interchange Error

Sometimes data written by a disk drive cannot be read by another drive. This phenomenon is called "interchange error". The points to be checked are:

- (1) Head alignment is defective Refer to Head/Radial Adjustment on page C-11.
- (2) Head output is not enough Refer to Head Output Adjustment on page C-11.
- (3) The motor speed is incorrect Refer to Motor Speed Adjustment on page C-12.
- (4) Check the center hole of the disk,

If the center hole of the disk is damaged, check the clamp mechanism.

4-2 Floppy Disk Drive for Repair

4-2-1 Have the user send you the defective floppy disk drive together with the diskette which was used when the user found it defective.

Without this diskette, you may fail to locate the trouble.

- 4-2-2 Be sure to get information from the user about the operating conditions at the time the user found the floppy disk drive defective. This will help in troubleshooting later.
- (1) If the Active lamp will not light and the unit does not operate at all, check the DC Power Supply.
- (2) If the Active lamp lights but an operating sound is not heard inside the unit, proceed to Media Rotation check.
- (3) If stepper motor turns without causing carriage movement, proceed to Tracking Mechanism.
- (4) If the drive executes continuously but fails to read and write, proceed Write Circuit Check and Read Circuit matfunction.

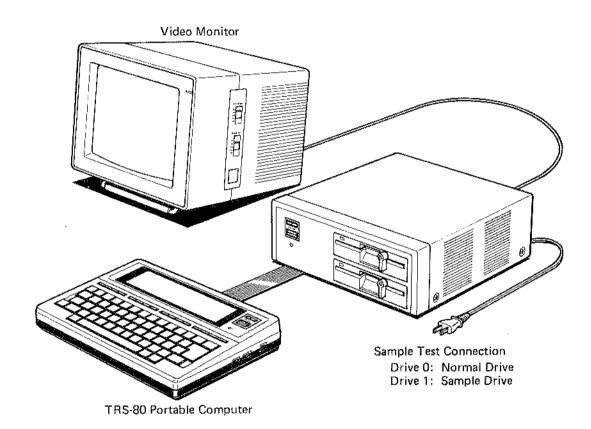
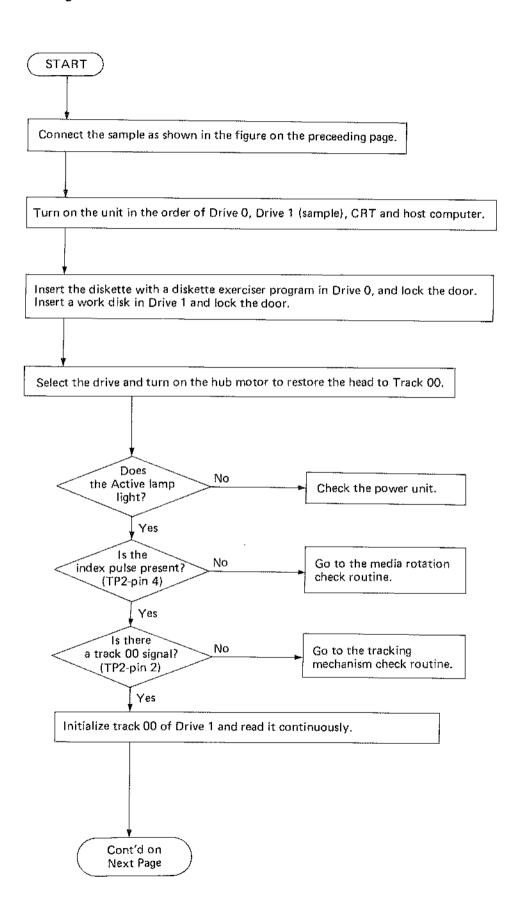
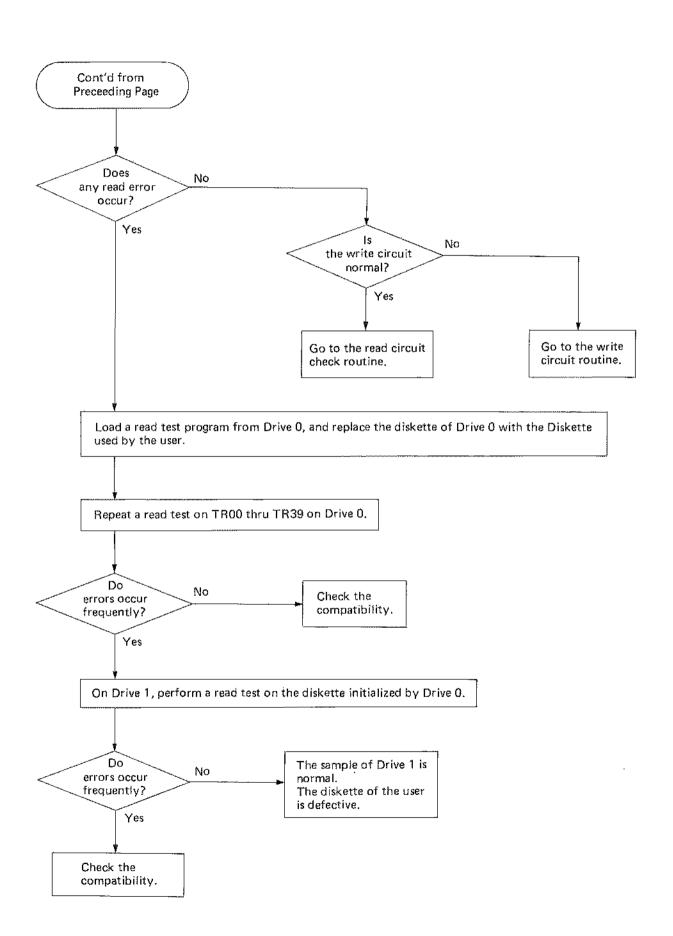


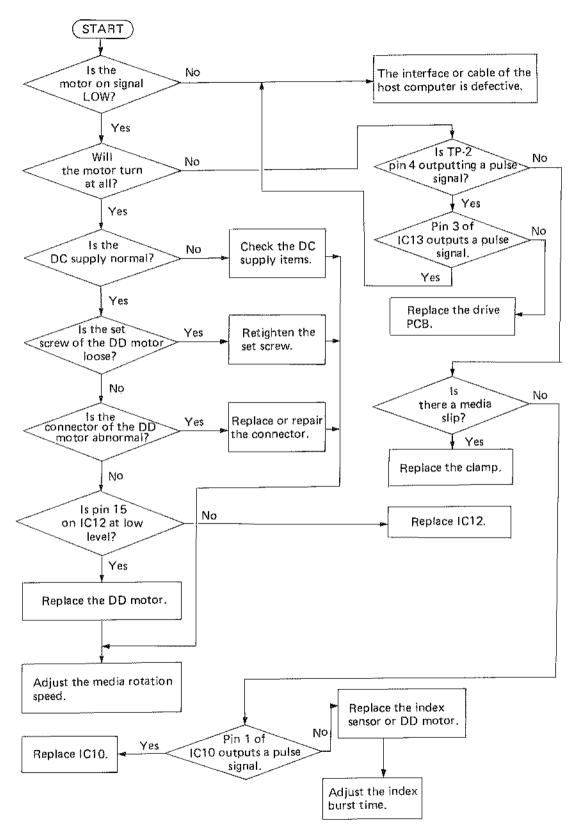
Figure C-42, Test System Hook-up

4-3 Troubleshooting Procedures

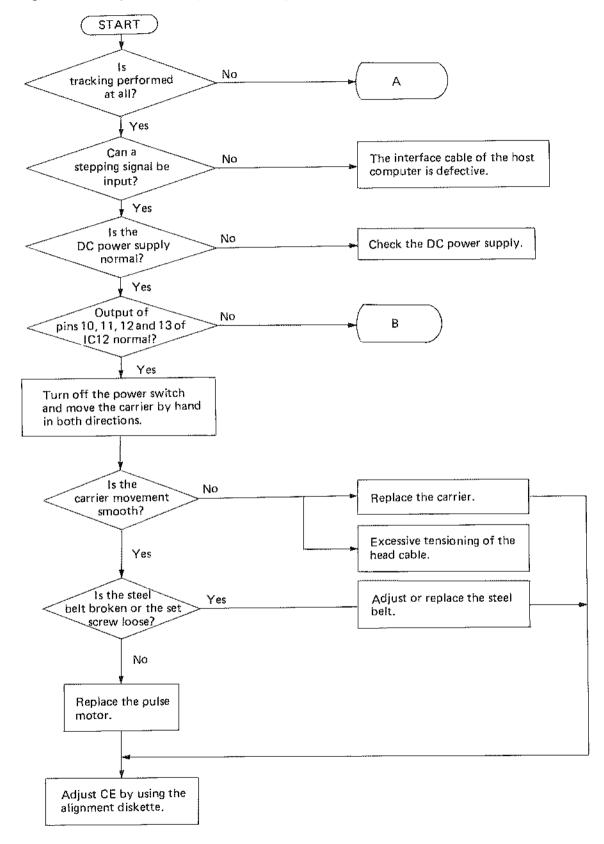


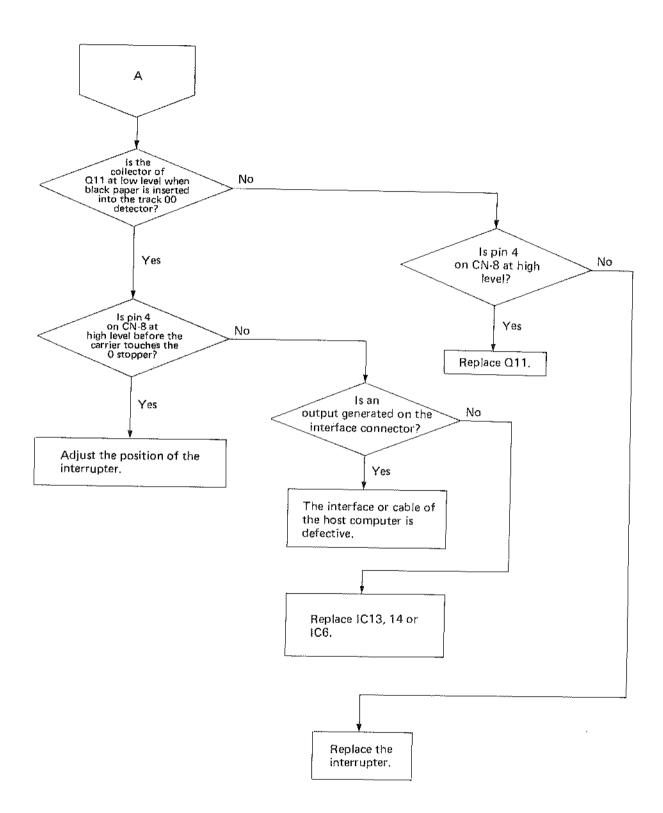


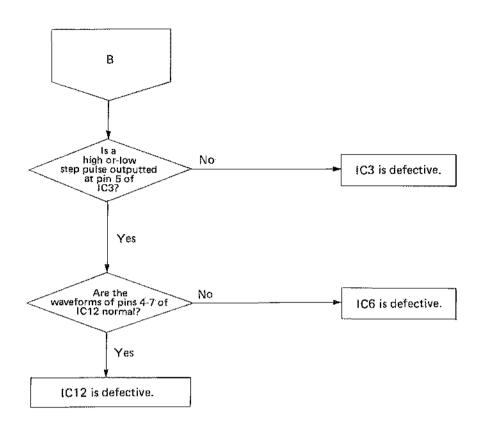
4-3-1 Media Rotation Check



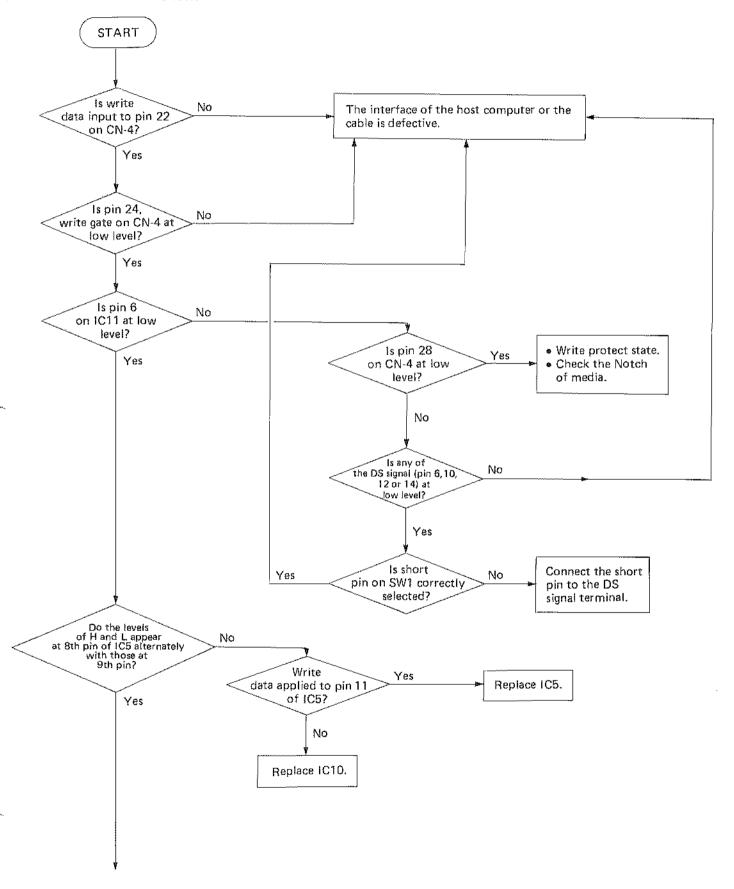
4-3-2 Tracking Mechanism (Track 00 signal won't be generated)

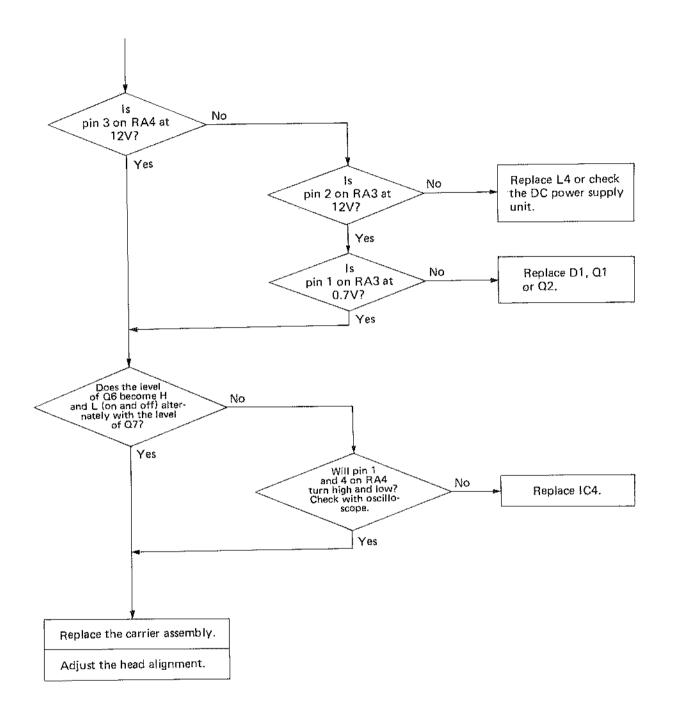




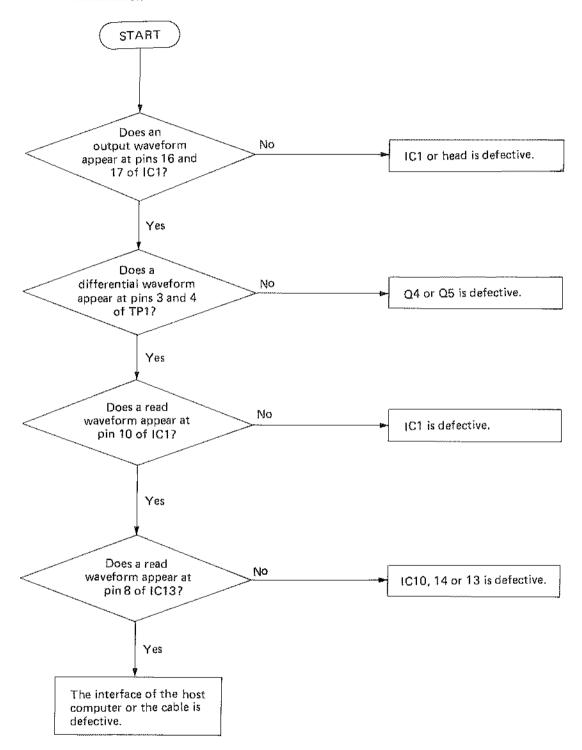


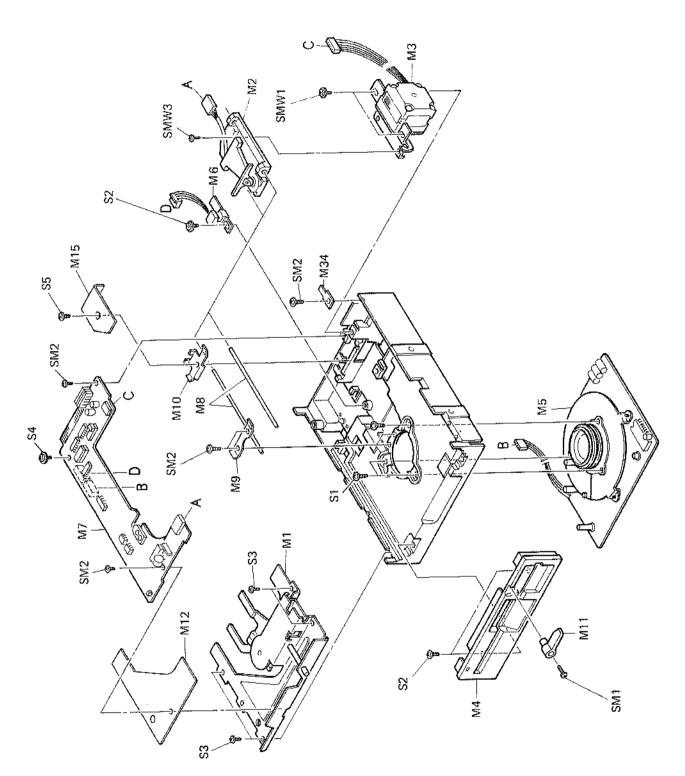
4-3-3 Write Circuit Check

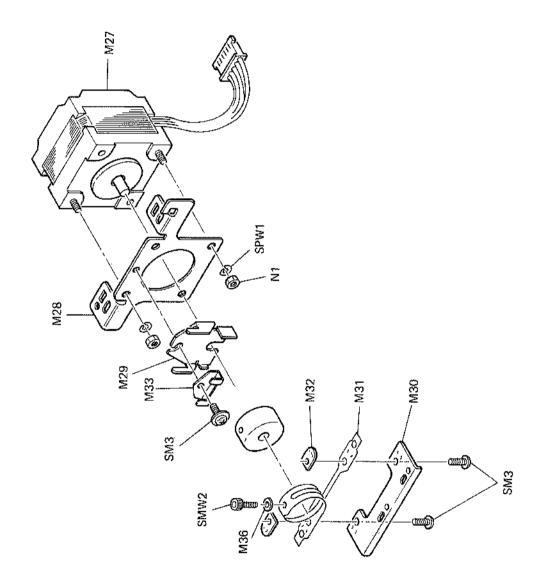




4-3-4 Read Circuit Malfunction







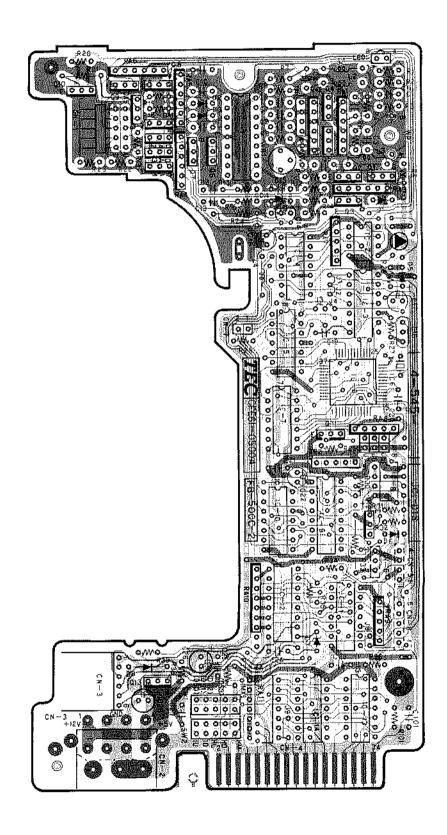


Figure C-46, P.C. Board

P.C.B. ASSEMBLY

Ref. No.	Description		RS Part No.	Mfr's Part No.	
CAPACITORS					
C1	Capacitor, Ceramic	510pF/50V/±5%		EBJT0-11400	
C2	Capacitor, Ceramic	0.1μF/12V/±5%		EBJT0-05200	
C3	Capacitor, Ceramic	0.1μF/12V/±5%		EBJT0-05200	
C4	Capacitor, Ceramic	510pF/50V/±5%		EBJT0-11400	
C5	Capacitor, Ceramic	2200pF/50V/±10%		EBJT0-07200	
C6	Capacitor, Ceramic	0,1μF/12V/±5%		EBJT0-05200	
C7	Not used				
C8	Capacitor, Ceramic	0.1μF/12V/±5%		EBJT0-05200	
C9	Capacitor, Ceramic	0.1μF/50V/+8020%		EBITO-00900	
C10	Capacitor, Ceramic	100pF/50V/±5%		EBJT0-07500	
C11	Capacitor, Ceramic	0.1μF/50V/+80 -20%		EBITO-00900	
	Capacitor, Ceramic	560pF/50V/±5%		EBJT0-11500	
C13	Capacitor, Ceramic	300pF/50V/±5%		EBJT0-13900	
C14	Capacitor, Electrolytic	10μF/16V/+75 -10%		E8B00-53800	
C15	Capacitor, Ceramic	0.1μF/12V/±5%		EBJT0-05200	
C16	Capacitor, Electrolytic	10μF/16V/+75 –10%		EBB00-53800	
C17	Capacitor, Electrolytic	47μF/16V/+75 –10%		EBB00-34800	
C18, XL	Cerarock & Capacitor	KMFC1001S		EKH00-04600	
C19	Capacitor, Ceramic	1000pF/50V/±10%		EBJT0-07100	
C20	Capacitor, Ceramic	0.1μF/12V/±5%		EBJT0-05200	
C21	Capacitor, Ceramic	0.1μF/12V/±5%		EBJT0-05200	
C22	Not used	σ. εμι ετ 2 ν 7=370		ED310-00200	
C23	Capacitor, Ceramic	0.1μF/12V/±5%		EBJT0-05200	
C24	Capacitor, Ceramic	$0.1\mu F/50V/+80 -20\%$		EBITO-00900	
C25	Capacitor, Ceramic	$0.1\mu\text{F}/50\text{V}/+80 = 20\%$		EBITO-00900	
C26	Capacitor, Electrolytic	47μF/16V/+75 —10%		EB800-34800	
C27	Capacitor, Ceramic	0.1μF/12V/±5%		EBJT0-05200	
C28	Capacitor, Electrolytic	100μF/6.3V/+75 –10%		EBB00-34900	
C101	Not Used	1000,70.007.10		20000 34300	
CONNECT	DRS			To compare the second s	
CN1B	Jack, Junction to R/W Head			EEB00-54500	
CN2	Jack, Junction to Power S	upply		EEB00-61100	
CN3	Jack, Junction to Pulse Motor			EEB00-52000	
CN4	Jack, Junction to Interface				
CN5	Jack, Junction to Drive Motor			EEB00-50500	
CN6	Not used				
CN7	Sensor, Index			CFA45-60301	
CN8	Jack, Junction to Drive Mo	otor		EEB00-51900	

Ref. No.	Descri	ption	RS Part No.	Mfr's Part No.
DIODES				*
D2	Diode, Silicon	1SS133		EACT0-09400
D3	Diode, Silicon	1SS133		EACTO-09400
D5	Diode, Silicon	1SS133		EACTO-09400
D6	Not used	100100		EAC 10-09400
D8	Diode, Silicon	1SR35-200A		E A OTO DOODO
	Brode, officer	101133-200A		EACT0-09200
ZENER DI	ODES			
D.4	D' D'' D			
D1	Diode, Silicon, Zener	RD2.7EB		EADT0-08900
D4	Diode, Silicon, Zener	MTZ5.1B		EADT0-19900
D 7	Diode, Silicon, Zener	MTZ5.1B		EADT0-19900
DIODE AR	RAYS			MA 194000.
	Not used	***************************************	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	
DA2	Not used		-	
DA3	Diode Array	DAN201		EAC00-09300
DA4	Diode Array	DAN201		EAC00-09300
DA5	Diode Array	DAP201		EAC00-09300
	·			2. (500 5500
INTEGRAT	ED CIRCUITS			***************************************
IC1	I.C., Disk Read Amplifier	HA16631P		EAS00-12700
IC2	I.C., TTL, NAND Gate	SN75452 or		EAQ00-05000
		HD75452		EAQ00-05000
IC3	I.C., TTL, Flip-Flop	SN74LS74A or		EAQ00-12700
		HD74LS74A		EAQ00-12700
1C4	I.C., TTL, Inverter	SN7406 or		EAQ00-07500
· .	and the second second	HD7406		
IC5	I.C., TTL, Flip-Flop	SN74LS74A or		EAQ00-07500
. 30	.,o,, i.e, tap-i-op	HD74LS74A		EAQ00-12700
IC6	I.C., FDC	EC-877		EAQ00-12700 EA006-40700
IC7	I.C., TTL, EX-OR Gate	SN74LS86 or HD74LS86) 	EAQ00-15900 EAQ00-15900
1C8	Not used	_ · · <u> </u>		27400 10000
.00 IC9	Not used			
IC10	I.C., TTL, Schmitte-Trigger	SN74LS14 or		EA 000 47000
, , , ,	, e e L, Schimete-Trigger			EAQ00-17200
1011	IC TIL NAMED COM	HD74LS14		EAQ00-17200
C11	I.C., TTL, NAND Gate	SN7438 or		EAQ00-10000
010	10 T	HD7438		EAQ00-10000
C12	I.C., Transistor Array	μPA2003	\$ 	EAS00-03000
				[

IC13 IC14 COILS L1 L2 L3 L4 LEDS	I.C., TTL, NAND Gate I.C., TTL, NOR Gate Coil, Choke Coil, Choke Coil, Choke Coil, Choke	SN7438 or HD7438 SN74LS02 or HD74LS02 330μH/500mA 330μH/500mA		EAQ00-10000 EAQ00-10000 EAQ00-15800 EAQ00-15800
COILS L1 L2 L3 L4	Coil, Choke Coil, Choke Coil, Choke	HD7438 SN74LS02 or HD74LS02 330µH/500mA		EAQ00-10000 EAQ00-15800
L1 L2 L3 L4	Coil, Choke Coil, Choke Goil, Choke	SN74LS02 or HD74LS02 330μH/500mA		
L1 L2 L3 L4	Coil, Choke Coil, Choke Goil, Choke	330μH/500mA		EAQ00-15800
L1 L2 L3 L4	Coil, Choke Coil, Choke	•		
L2 L3 L4	Coil, Choke Coil, Choke	•		
L3 L4	Coil, Choke	330μH/500mA		EDDT0-06800
L4	-			EDDT0-06800
	Coil, Choke	100μH/500mA		EDDT0-06900
LEDS		470μH/500mA 		EDDT0-06700
			······································	
LED A	Photo Diode			EAH00-06200
LED B	Photo Diode		:	EAH00-06200
RESISTORS				
R1	Resistor, Carbon	220 ohm/1/4W ±5%		ECC1GT221JE
R2	Resistor, Carbon	39K ohm/1/4W ±5%		ECC1GT393JE
R3	Resistor, Carbon	560 ohm/1/4W ±5%		ECC1GT561JB
R4	Resistor, Carbon	100K ohm/1/4W ±5%		ECC1GT104JE
R5	Resistor, Carbon	100K ohm/1/4W ±5%		ECC1GT104JE
R6	Resistor, Carbon	820 ohm/1/4W ±5%		ECC1GT821JE
R7	Resistor, Carbon	270 ohm/1/4W ±5%		ECC1GT271JE
R8	Resistor, Carbon	270 ohm/1/4W ±5%	!	ECC1GT271JE
R9	Resistor, Carbon	220 ohm/1/4W ±5%		ECC1GT221JE
R10	Resistor, Carbon	10K ohm/1/4W ±5%		ECC1GT103JE
R11	Resistor, Carbon	47K ohm/1/4W ±5%		ECC1GT473JE
R12	Resistor, Carbon	560 ohm/1/4W ±5%		ECC1GT561JE
R13	Resistor, Carbon	470 ohm/1/4W ±5%		ECC1GT471JE
R14	Resistor, Carbon	10K ohm/1/4W ±5%		ECC1GT103JE
R15	Resistor, Carbon	5.6K ohm/1/4W ±5%	1	ECC1GT562JE
R16	Resistor, Carbon	5.6K ohm/1/4W ±5%	1	ECC1GT562JE
R17	Resistor, Carbon	2.2K ohm/1/4W ±5%		ECC1GT222JE
R18	Resistor, Carbon	2.2K ohm/1/4W ±5%		ECC1GT222JE
R19	Not used			
R20	Resistor, Carbon	10K ohm/1/4W ±5%		ECC1GT103JE
R21	Resistor, Metal Oxide Film	47 ohm/1/2W ±5%		CFE61-05501
R22	Resistor, Carbon	10K ohm/1/4W ±5%		ECC1GT103JE
R23	Resistor, Carbon	820 ohm/1/4W ±5%		ECC1GT821JE
R24	Resistor, Metal Oxide Film	110 ohm/1W ±5%		CFE61-05301
R25	Not used			
R26	Resistor, Carbon	47K ohm/1/4W ±5%		ECC1GT473JE
R27	Resistor, Carbon	2.4K ohm/1/4W ±5%		ECC1GT242JE
R28	Resistor, Carbon	39K ohm/1/4W ±5%		ECC1GT393JE
R29	Resistor Carbon	470 ohm/1/4W ±5%		ECC1GT471JE
R30	Not used			
R31	Not used			
R32	Not used			
R33	Not used			

	De	escription	RS Part No.	Mfr's Part No.
R34	Resistor, Carbon	10K ohm/1/4W ±5%	·	ECC1G⊤103J
R35	Resistor, Carbon	1K ohm/1/4W ±5%		ECC1GT103J
R36	Resistor, Carbon	180 ohm/1/4W ±5%		ECC1GT1023
R37	Resistor, Carbon	1K ohm/1/4W ±5%		ECC1GT1813
R38	Resistor, Carbon	10K ohm/1/4W ±5%		
R39	Resistor, Carbon	1K ohm/1/4W ±5%		ECC1GT103J
R101	Not Used	17. OHIEF 1/4W ±5%		ECC1GT102J
RESISTOF	ARRAYS			
		1		
RA1	Resistor Array	2K x 2, 22K x 2 1/8W ±5%		ECM00-18300
RA2	Resistor Array	3K × 2, 10K × 2 1/8W ±5%		ECM00-18100
RA3	Resistor Array	2.2K, 10K, 150, 270 1/8W ±5%		ECM00-17900
RA4	Resistor Array	330 × 2, 2K × 2 1/8W ±5%		ECM00-18200
RA5	Resistor Array	10K x 4 1/8W ±5%		ECM00-18000
RA6	Resistor Array	470 x 2, 1K x 2 1/8W ±5%		ECM00-18400
RA7	Resistor Array	4.7K × 4 1/8W ±5%		ECM00-00300
RA8				1.000000
RA9	<u></u>			
RA10	Resistor Array	4.7K x 6 1/8W ±5%		ECM00-09800

	ORS			
<u> </u>	Transistor, NPN, 2SC20			ì
⊇1 ⊇2	Transistor, NPN, 2SC20 Transistor, NPN, 2SC20	21, Silicon, NO-Rank		EAA00-18900
7 RANSIST 	Transistor, NPN, 2SC20	21, Silicon, NO-Rank		EAA00-18900 EAA00-18900 EAB00-10300
21 22 23 24	Transistor, NPN, 2SC20 Transistor, NPN, 2SC20	21, Silicon, NO-Rank		EAA00-18900
21 22 23 24 25	Transistor, NPN, 2SC20 Transistor, NPN, 2SC20	21, Silicon, NO-Rank		EAA00-18900
21 22 23 24 25 26	Transistor, NPN, 2SC20 Transistor, NPN, 2SC20 Transistor, PNP, 2SA93	121, Silicon, NO-Rank 17, Silicon, NO-Rank		EAA00-18900 EAB00-10300
21 22 23 24 25 26 27	Transistor, NPN, 2SC20 Transistor, NPN, 2SC20 Transistor, PNP, 2SA93 Transistor, PNP, 2SA93	121, Silicon, NO-Rank 17, Silicon, NO-Rank		EAA00-18900 EAB00-10300
21 22 23 24 25 26 27	Transistor, NPN, 2SC20 Transistor, NPN, 2SC20 Transistor, PNP, 2SA93 Transistor, PNP, 2SA93 Not used	121, Silicon, NO-Rank 17, Silicon, NO-Rank 17, Silicon, NO-Rank		EAA00-18900 EAB00-10300 EAB00-10300
21 22 23 24 25 26 27 28	Transistor, NPN, 2SC20 Transistor, NPN, 2SC20 Transistor, PNP, 2SA93 Transistor, PNP, 2SA93 Not used Transistor, NPN, DTC1	121, Silicon, NO-Rank 17, Silicon, NO-Rank 17, Silicon, NO-Rank 14, Silicon, NO-Rank		EAA00-18900 EAB00-10300 EAB00-10300
21 22 23 24 25 26 27 28 29	Transistor, NPN, 2SC20 Transistor, NPN, 2SC20 Transistor, PNP, 2SA93 Transistor, PNP, 2SA93 Not used Transistor, NPN, DTC1 Transistor, PNP, 2SA93	121, Silicon, NO-Rank 17, Silicon, NO-Rank 17, Silicon, NO-Rank 14, Silicon, NO-Rank 17, Silicon, NO-Rank		EAA00-18900 EAB00-10300 EAB00-10300
21 22 23 24 25 26 27 28 29 210	Transistor, NPN, 2SC20 Transistor, NPN, 2SC20 Transistor, PNP, 2SA93 Transistor, PNP, 2SA93 Not used Transistor, NPN, DTC1 Transistor, PNP, 2SA93 Transistor, NPN, 2SC20	121, Silicon, NO-Rank 17, Silicon, NO-Rank 17, Silicon, NO-Rank 14, Silicon, NO-Rank 17, Silicon, NO-Rank 17, Silicon, NO-Rank		EAA00-18900 EAB00-10300 EAB00-10300 EAA00-18800 EAB00-10300
21 22 23 24 25 26 27 28 29 210 211	Transistor, NPN, 2SC20 Transistor, NPN, 2SC20 Transistor, PNP, 2SA93 Transistor, PNP, 2SA93 Not used Transistor, NPN, DTC1 Transistor, PNP, 2SA93 Transistor, NPN, 2SC20 Not used	121, Silicon, NO-Rank 17, Silicon, NO-Rank 17, Silicon, NO-Rank 14, Silicon, NO-Rank 17, Silicon, NO-Rank 121, Silicon, NO-Rank		EAA00-18900 EAB00-10300 EAB00-10300 EAA00-18800 EAB00-10300
21 22 23 24 25 26 27 28 29 210 211 212 213	Transistor, NPN, 2SC20 Transistor, NPN, 2SC20 Transistor, PNP, 2SA93 Not used Transistor, NPN, DTC1 Transistor, NPN, 2SA93 Transistor, NPN, 2SC20 Not used Transistor, PNP, 2SA88	121, Silicon, NO-Rank 17, Silicon, NO-Rank 17, Silicon, NO-Rank 14, Silicon, NO-Rank 17, Silicon, NO-Rank 121, Silicon, NO-Rank		EAA00-18900 EAB00-10300 EAA00-18800 EAB00-10300 EAA00-18900
21 22 23 24 25 26 27 28 29 210 211 212 213	Transistor, NPN, 2SC20 Transistor, NPN, 2SC20 Transistor, PNP, 2SA93 Not used Transistor, NPN, DTC1 Transistor, NPN, 2SA93 Transistor, NPN, 2SC20 Not used Transistor, PNP, 2SA88	121, Silicon, NO-Rank 17, Silicon, NO-Rank 17, Silicon, NO-Rank 14, Silicon, NO-Rank 17, Silicon, NO-Rank 121, Silicon, NO-Rank		EAA00-18900 EAB00-10300 EAA00-18800 EAB00-10300 EAA00-18900
21 22 23 24 25 26 27 28 29 210 211 212 213	Transistor, NPN, 2SC20 Transistor, NPN, 2SC20 Transistor, PNP, 2SA93 Not used Transistor, NPN, DTC1 Transistor, NPN, 2SA93 Transistor, NPN, 2SC20 Not used Transistor, PNP, 2SA88	121, Silicon, NO-Rank 17, Silicon, NO-Rank 17, Silicon, NO-Rank 14, Silicon, NO-Rank 17, Silicon, NO-Rank 121, Silicon, NO-Rank		EAA00-18900 EAB00-10300 EAA00-18800 EAA00-18900 EAA00-10700
21 22 23 24 25 26 27 28 29 210 211 212 213 POTENTIO	Transistor, NPN, 2SC20 Transistor, NPN, 2SC20 Transistor, PNP, 2SA93 Not used Transistor, NPN, DTC1 Transistor, NPN, 2SA93 Transistor, NPN, 2SC20 Not used Transistor, PNP, 2SA88 METER Variable Registor	121, Silicon, NO-Rank 17, Silicon, NO-Rank 17, Silicon, NO-Rank 14, Silicon, NO-Rank 17, Silicon, NO-Rank 121, Silicon, NO-Rank		EAA00-18900 EAB00-10300 EAA00-18800 EAB00-10300 EAA00-18900
21 22 23 24 25 26 27 28	Transistor, NPN, 2SC20 Transistor, NPN, 2SC20 Transistor, PNP, 2SA93 Not used Transistor, NPN, DTC1 Transistor, NPN, 2SA93 Transistor, NPN, 2SC20 Not used Transistor, PNP, 2SA88 METER Variable Registor	121, Silicon, NO-Rank 17, Silicon, NO-Rank 17, Silicon, NO-Rank 14, Silicon, NO-Rank 17, Silicon, NO-Rank 121, Silicon, NO-Rank		EAA00-18900 EAB00-10300 EAA00-18800 EAB00-10300 EAA00-18900 EAB00-10700
21 22 23 24 25 26 27 28 29 210 211 212 213 POTENTIC	Transistor, NPN, 2SC20 Transistor, NPN, 2SC20 Transistor, PNP, 2SA93 Not used Transistor, NPN, DTC1 Transistor, NPN, 2SC20 Not used Transistor, NPN, 2SC20 Not used Transistor, PNP, 2SA88 PMETER Variable Registor ANEOUS	121, Silicon, NO-Rank 17, Silicon, NO-Rank 17, Silicon, NO-Rank 14, Silicon, NO-Rank 17, Silicon, NO-Rank 121, Silicon, NO-Rank 11, Silicon, NO-Rank		EAA00-18900 EAB00-10300 EAA00-18800 EAB00-10300 EAA00-18900 EAB00-10700
21 22 23 24 25 26 27 28 29 210 211 212 213 POTENTIC VR1 MISCELLA	Transistor, NPN, 2SC20 Transistor, NPN, 2SC20 Transistor, PNP, 2SA93 Not used Transistor, NPN, DTC1 Transistor, NPN, DTC1 Transistor, NPN, 2SC20 Not used Transistor, NPN, 2SC20 Not used Transistor, PNP, 2SA88 METER Variable Registor ANEOUS Short Pin, Female	DIC-S252 DILP14P-8J		EAA00-18900 EAB00-10300 EAA00-18800 EAB00-10300 EAA00-18900 EAA00-14200 ECA00-14200 EEF00-20900 EED00-05600
21 22 23 24 25 26 27 28 29 210 211 212 213 POTENTIC VR1 MISCELLA 281 281 281 281	Transistor, NPN, 2SC20 Transistor, NPN, 2SC20 Transistor, PNP, 2SA93 Not used Transistor, PNP, 2SA93 Not used Transistor, NPN, DTC1 Transistor, NPN, 2SC20 Not used Transistor, NPN, 2SC20 Not used Transistor, PNP, 2SA88 METER Variable Registor ANEOUS Short Pin, Female Socket, IC	121, Silicon, NO-Rank 17, Silicon, NO-Rank 17, Silicon, NO-Rank 14, Silicon, NO-Rank 17, Silicon, NO-Rank 121, Silicon, NO-Rank 11, Silicon, NO-Rank 11, Silicon, NO-Rank		EAA00-18900 EAB00-10300 EAA00-18800 EAA00-18900 EAA00-10700 EACO0-14200
21 22 23 24 25 26 27 28 29 210 211 212 213 POTENTIC VR1 MISCELLA 28 28 28 29 210 211 212 213 2013 2013 2013 2014 2015 2015 2016 2017 2017 2018 2018 2018 2018 2018 2018 2018 2018	Transistor, NPN, 2SC20 Transistor, NPN, 2SC20 Transistor, PNP, 2SA93 Not used Transistor, NPN, DTC1 Transistor, NPN, DTC1 Transistor, NPN, 2SC20 Not used Transistor, NPN, 2SC20 Not used Transistor, PNP, 2SA88 METER Variable Registor ANEOUS Short Pin, Female Socket, IC Short Pin Plug Not Used	DIC-S252 DILP14P-8J FFC-(10) BMEP2		EAA00-18900 EAB00-10300 EAA00-18800 EAB00-10300 EAA00-18900 EAA00-14200 ECA00-14200 EEF00-20900 EEF00-20800
21 22 23 24 25 26 27 28 29 210 211 212 213 POTENTIC	Transistor, NPN, 2SC20 Transistor, NPN, 2SC20 Transistor, PNP, 2SA93 Not used Transistor, NPN, DTC1 Transistor, NPN, DTC1 Transistor, NPN, 2SC20 Not used Transistor, NPN, 2SC20 Not used Transistor, PNP, 2SA88 METER Variable Registor ANEOUS Short Pin, Female Socket, IC Short Pin Plug	DIC-S252 DILP14P-8J		EAA00-18900 EAB00-10300 EAA00-18800 EAB00-10300 EAA00-18900 EAA00-10700 ECA00-14200 EEF00-20900 EED00-05600

MECHANICAL AND ASSEMBLY PARTS

Ref. No.	Description	RS Part No.	Mfr's Part No.
M1	Clamp Base BK Assembly		CFABK-60101
M16	Clamp, BK		CFABK-60601
M17	Base, Clamp K		CFAAK-60101
M18	Arm, Clamp K	İ	CFAAK-60201
M19	Shaft, Clamp Lever		CFA10-60301
M20	Spring, Clamp Lever	ļ	CFA30-60301
M21	Cam, Clamp		CFA35-60501
E1	E-Ring M3		SRE030000E0
 M2	Carrier A Assembly		CFABK-60205
M22	Carrier A-K		CFAAK-60405
M23	Pad K		CFAAK-02101
M24	Shaft, Load Arm		CFA10-00201
M25	Spring, Load Arm		CFA30-00201
M26	Arm III, Load		CFA35-02801
M3	Pulse Motor BK Assembly		CFABK-60403
M27	Motor K, Pulse		CFAAK-60703
M28	Frame 2, Motor		CFA20-62901
M29	Stopper, TR00		CFA20-63601
M30	Supporter, Belt		CFA20-61001
M31	Belt, Steel		CFA45-60701
M32	Plate, Belt Fastening		CFA20-60501
SMW2	Bolt, M2.6 × 4		CFA45-61001
M36	Stopper, Belt		CFA20-63301
M33	Clamp, Cable		CFA20-63401
SM3	Screw, Pan Head, Sems M2.6 x 4		CFA45-62301
N1	Nut, Hexagonal M3		SNC030018A2
SPW1	Washer 2.8 x 5 x 0.5		SWA028050A
M4	Cover, Front, Black		CFAAK-6080
M5	DD Motor K Assembly		CFAAK-60301
M6	Interrupter AK Assembly		CFAAK-61201
M7	P.C.B. Assembly		CFEAK-06110
M8	Shaft, Carrier		CFA10-61201
M9	Support, Shaft, Inside		CFA20-60601
M10	Support, Shaft, Outside		CFA20-60701
M11	Lever, Clamp		CFA35-60601
M12	Insulator		CFA45-60901
S1	Screw, Bind Head, Machine, M3 x 6		CFA45-61401
S2	Screw with Washer M3 x 6		SST230060A2
S3	Screw, Bind Head, Machine, M3 x 8		CFA45-61402
\$4	Screw with Washer M3 x 8		SST230080A2
S5	Screw, Dish Head M3 x 8		SSS230080A2
SM1	Screw, Pan Head, Sems M2.6 x 6	İ	SSW226060A2
SM2	Screw, Pan Head, Sems M2.6 x 8		SSW226080A2
SMW1	Screw, Pan Head, Double Sems M4 x 10		SSX240100A2
M15	Guide, Cable K		CFA35-61401
M34	Terminal		EEH00-05600

Part 6 Special Maintenance Tools

1. Belt Tensioning Jig

(CFABK-60801)

• Refer to Mechanical Explanation on Page C-8.

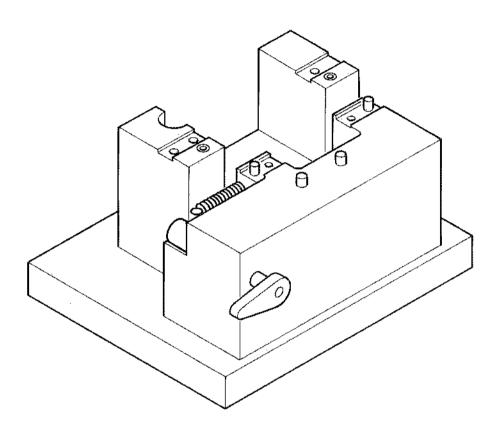


Figure C-47. Special Maintenance Tool

RADIO SHACK, A DIVISION OF TANDY CORPORATION

U.S.A.: FORT WORTH, TEXAS 76102 CANADA: BARRIE, ONTARIO L4M 4W5

TANDY CORPORATION

AUSTRALIA
91 KURRAJONG AVENUE

BELGIUM

U.K.

MOUNT DRUITT, N.S.W. 2770

PARC INDUSTRIEL DE NANINNE 5140 NANINNE BILSTON ROAD WEDNESBURY WEST MIDLANDS WS10 7JN